



# Service Manual U8100



lodel : U810

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# 1. INTRODUCTION

## 1.1 Purpose

This manual provides the information necessary to repair, calibration, description and download the features of this model.

# 1.2 Regulatory Information

## A. Security

Toll fraud, the unauthorized use of telecommunications system by an unauthorized part (for example, persons other than your company's employees, agents, subcontractors, or person working on your company's behalf) can result in substantial additional charges for your telecommunications services. System users are responsible for the security of own system. There are may be risks of toll fraud associated with your telecommunications system. System users are responsible for programming and configuring the equipment to prevent unauthorized use. The manufacturer does not warrant that this product is immune from the above case but will prevent unauthorized use of common-carrier telecommunication service of facilities accessed through or connected to it. The manufacturer will not be responsible for any charges that result from such unauthorized use.

#### B. Incidence of Harm

If a telephone company determines that the equipment provided to customer is faulty and possibly causing harm or interruption in service to the telephone network, it should disconnect telephone service until repair can be done. A telephone company may temporarily disconnect service as long as repair is not done.

## C. Changes in Service

A local telephone company may make changes in its communications facilities or procedure. If these changes could reasonably be expected to affect the use of the phones or compatibility with the network, the telephone company is required to give advanced written notice to the user, allowing the user to take appropriate steps to maintain telephone service.

#### D. Maintenance Limitations

Maintenance limitations on the phones must be performed only by the manufacturer or its authorized agent. The user may not make any changes and/or repairs expect as specifically noted in this manual. Therefore, note that unauthorized alternations or repair may affect the regulatory status of the system and may void any remaining warranty.

## E. Notice of Radiated Emissions

This model complies with rules regarding radiation and radio frequency emission as defined by local regulatory agencies. In accordance with these agencies, you may be required to provide information such as the following to the end user.

#### F. Pictures

The pictures in this manual are for illustrative purposes only; your actual hardware may look slightly different.

#### G. Interference and Attenuation

A phone may interfere with sensitive laboratory equipment, medical equipment, etc. Interference from unsuppressed engines or electric motors may cause problems.

#### H. Electrostatic Sensitive Devices

#### **ATTENTION**

Boards, which contain Electrostatic Sensitive Device (ESD), are indicated by the sign. Following information is ESD handling:



- Service personnel should ground themselves by using a wrist strap when exchange system boards.
- · When repairs are made to a system board, they should spread the floor with anti-static mat which is also grounded.
- Use a suitable, grounded soldering iron.
- Keep sensitive parts in these protective packages until these are used.
- · When returning system boards or parts like EEPROM to the factory, use the protective package as described.

# 1. INTRODUCTION

# 1.3 Abbreviations

For the purposes of this manual, following abbreviations apply:

| APC    | Automatic Power Control                           |  |
|--------|---|--|
| BB     | Baseband  |  |
|        |   |  |
| BER    | Bit Error Ratio                                   |  |
| CC-CV  | Constant Current – Constant Voltage               |  |
| CLA    | Cigar Lighter Adapter                             |  |
| DAC    | Digital to Analog Converter                       |  |
| DCS    | Digital Communication System                      |  |
| dBm    | dB relative to 1 milliwatt                        |  |
| DSP    | Digital Signal Processing                         |  |
| DTC    | DeskTop Charger                                   |  |
| EEPROM | Electrical Erasable Programmable Read-Only Memory |  |
| EL     | Electroluminescence                               |  |
| ESD    | Electrostatic Discharge                           |  |
| FPCB   | Flexible Printed Circuit Board                    |  |
| GMSK   | Gaussian Minimum Shift Keying                     |  |
| GPIB   | General Purpose Interface Bus                     |  |
| GPRS   | General Packet Radio Service                      |  |
| GSM    | Global System for Mobile Communications           |  |
| IPUI   | International Portable User Identity              |  |
| IF     | Intermediate Frequency                            |  |
| LCD    | Liquid Crystal Display                            |  |
| LDO    | Low Drop Output                                   |  |
| LED    | Light Emitting Diode                              |  |
| OPLL   | Offset Phase Locked Loop                          |  |
| PAM    | Power Amplifier Module                            |  |
| PCB    | Printed Circuit Board                             |  |
| PGA    | Programmable Gain Amplifier                       |  |
| PLL    | Phase Locked Loop                                 |  |

# 1. INTRODUCTION

| PSTN | Public Switched Telephone Network |  |
|------|-----------------------------------|--|
| RF   | Radio Frequency                   |  |
| RLR  | Receiving Loudness Rating         |  |
| RMS  | Root Mean Square                  |  |
| RTC  | Real Time Clock                   |  |
| SAW  | Surface Acoustic Wave             |  |
| SIM  | Subscriber Identity Module        |  |
| SLR  | Sending Loudness Rating           |  |
| SRAM | Static Random Access Memory       |  |
| UMTS | Universal Mobile Telephony System |  |

# 2. PERFORMANCE

# 2.1 System Overview

| Item          | Specification                                  |  |
|---------------|--|--|
| Shape         | GSM900/1 800 & WCDMA Folder- Dual Mode Handset |  |
| Size          | 49.5 x 95.7 x 22.5 mm                          |  |
| Weight        | 120g (with Battery)                            |  |
| Power         | 4.0V > 1200mAh Li-lon                          |  |
| Talk Time     | Over 140 Min (WCDMA, Tx=12 dBm, Voice)         |  |
| Taik Time     | Over 180 Min (GSM, Tx=Max, Voice)              |  |
| Standby Time  | Over 120 hrs (WCDMA, DRX=1.28)                 |  |
| Starioby Time | Over 1 50 hrs (GSM, Paging period=9)           |  |
| Antenna       | Fixed Type (Fixed Screw)                       |  |
| LCD           | 176 x 220 Pixel                                |  |
| Main LCD BL   | White LED Back Light                           |  |
| Sub LCD BL    | 7-color LED                                    |  |
| Vibrator      | Yes (Coin Type)                                |  |
| LED Indicator | 7-color(Sub LCD BL)                            |  |
| C-MIC         | Yes  |  |
| Receiver      | Yes  |  |
| Earphone Jack | Yes  |  |
| SIM Socket    | Yes (3.0V/1.8V)                                |  |
| Volume Key    | Push Type(+,-)                                 |  |
| Voice Key     | Push Type (Memo)                               |  |
| I/O Connect   | 24 Pin   |  |

# 2.2 Usable environment

# 1) Environment

| Item     | Spec.                                  | Unit |
|----------|--|------|
| Voltage  | 4.0 (Typ), 3.4 (Min), (Shut Down: 3.2) |      |
| Size     | -20 ~ + 60                             | °C   |
| Storage  | -30 ~ + 85                             | °C   |
| Humidity | max. 85                                | %    |

# 2) Environment(Accessory)

| Item  | Spec.           | Min | Тур. | Max | Unit |
|-------|-----------------|-----|------|-----|------|
| Power | Available power | 100 | 220  | 240 | Vac  |

<sup>\*</sup> CLA: 12~24V(DC)

# 2.3 Radio Performance

# 1) Transmitter -GSM Mode

| No | Item      |              | GSM               |          | DCS               |        |
|----|-----------|--------------|-------------------|----------|-------------------|--------|
|    |           |              | 100k ~ 1GHz       | -39dBm   | 9k ~ 1GHz         | -39dBm |
|    |           | MS allocated | 100k ~ 1GH2       |          | 1G ~ 1710MHz      | -33dBm |
|    |           | Channel      | 1G ~ 12.75GHz     | -33dBm   | 1710M ~ 1785MHz   | -39dBm |
|    | Conducted |              | 1G ~ 12.75GHZ     | -3300111 | 1785M ~ 12.75GHz  | -33dBm |
| 1  | Spurious  |              | 100k ~ 880MHz     | -60dBm   | 100k ~ 880MHz     | -60dBm |
|    | Emission  |              | 880M ~ 915MHz     | -62dBm   | 880M ~ 915MHz     | -62dBm |
|    |           | Idle Mode    | 915M ~ 1000Mz     | -60dBm   | 915M ~ 1000MHz    | -60dBm |
|    |           | idle Mode    | 1G ~ 1.71GHz      | -50dBm   | 1G ~ 1.71GHz      | -50dBm |
|    |           |              | 1.71G ~ 1.785GHz  | -56dBm   | 1.71G ~ 1.785GHz  | -56dBm |
|    |           |              | 1.785G ~ 12.75GHz | -50dBm   | 1.785G ~ 12.75GHz | -50dBm |

# 2. PERFORMANCE

| No | Ite                        | em GSM        |                     | DCS         |                                 |        |
|----|----------------------------|---------------|---------------------|-------------|---------------------------------|--------|
|    | 20M 1CH= 26dPa             |               | 00-ID               | 30M ~ 1GHz  | -36dBm                          |        |
|    | Radiated                   | MS allocated  | 30M ~ 1GHz          | -36dBm      | 1G ~ 1710MHz                    | -30dBm |
|    |                            | Channel       | 10 1011-            | 00 -ID      | 1710M ~ 1785MHz                 | -36dBm |
|    |                            |               | 1G ~ 4GHz           | -30dBm      | 1785M ~ 4GHz                    | -30dBm |
| 1  | Spurious                   |               | 30M ~ 880MHz        | -57dBm      | 30M ~ 880MHz                    | -57dBm |
|    | Emission                   |               | 880M ~ 915MHz       | -59dBm      | 880M ~ 915MHz                   | -59dBm |
|    |                            | Idlo Modo     | 915M ~ 1000Mz       | -57dBm      | 915M ~ 1000MHz                  | -57dBm |
|    |                            | Idle Mode     | 1G ~ 1.71GHz        | -47dBm      | 1G ~ 1.71GHz                    | -47dBm |
|    |                            |               | 1.71G ~ 1.785GHz    | -53dBm      | 1.71G ~ 1.785GHz                | -53dBm |
|    |                            |               | 1.785G ~ 4GHz       | -47dBm      | 1.785G ~ 4GHz                   | -47dBm |
| 2  | Frequen                    | icy Error     | ±0.1ppm             |             | ±0.1ppm                         |        |
| 3  | Phase                      | e Error       | ±5(RMS)             |             | ±5(RMS)                         |        |
| 3  | Filase                     | EIIOI         | ±20(PEAK)           |             | ±20(PEAK)                       |        |
|    |                            |               | 3dB below reference | sensitivity | 3dB below reference sensitivity |        |
|    | Frequency Error Under      |               | RA250: ±200Hz       |             | RA250: ±250Hz                   |        |
| 4  | Multipath and Interference |               | HT100: ±100Hz       |             | HT100: ±250Hz                   |        |
|    | Condition                  |               | TU50: ±100Hz        |             | TU50: ±150Hz                    |        |
|    |                            |               | TU3: ±150Hz         |             | TU1.5: ±200Hz                   |        |
|    |                            |               | 0 ~ 100kHz          | +0.5dB      | 0 ~ 100kHz                      | +0.5dB |
|    |                            |               | 200kHz              | -30dB       | 200kHz                          | -30dB  |
|    |                            |               | 250kHz              | -33dB       | 250kHz                          | -31dB  |
|    |                            | Due to        | 400kHz              | -60dB       | 400kHz                          | -33dB  |
|    | Output RF                  | modulation    | 600 ~ 1800kHz       | -66dB       | 600 ~ 1800kHz                   | -60dB  |
| 5  | Spectrum                   |               | 1800 ~ 3000kHz      | -69dB       | 1800 ~ 6000kHz                  | -60dB  |
|    | Spectrum                   |               | 3000 ~ 6000kHz      | -71dB       | ≥6000kHz                        | -73dB  |
|    |                            |               | ≥6000kHz            | -77dB       |                                 |        |
|    |                            | Due to        | 400kHz              | -19dB       | 400kHz                          | -22dB  |
|    |                            | Switching     | 600kHz              | -21dB       | 600kHz                          | -24dB  |
|    |                            | transient     | 1200kHz             | -21dB       | 1200kHz                         | -24dB  |
|    |                            | u ai isiei it | 1800kHz             | -24dB       | 1800kHz                         | -27dB  |

| No | Item                        | GSM           |       | DCS       |               |           |             |
|----|-----------------------------|---------------|-------|-----------|---------------|-----------|-------------|
|    | Intermodulation attenuation |               |       |           | Frequency of  | offset    | 800kHz      |
| 7  |                             |               |       |           | Intermodula   | tion prod | luct should |
| ′  |                             |               | _     |           | be Less than  | n 55dB b  | elow the    |
|    |                             |               |       |           | level of Wan  | ited sign | al          |
|    |                             | Power control | Power | Tolerance | Power control | Power     | Tolerance   |
|    |                             | Level         | (dBm) | (dB)      | Level         | (dBm)     | (dB)        |
|    |                             | 5             | 33    | ±3        | 0             | 30        | ±3          |
|    |                             | 6             | 31    | ±3        | 1             | 28        | ±3          |
|    |                             | 7             | 29    | ±3        | 2             | 26        | ±3          |
|    |                             | 8             | 27    | ±3        | 3             | 24        | ±3          |
|    | Transmitter Output Power    | 9             | 25    | ±3        | 4             | 22        | ±3          |
|    |                             | 10            | 23    | ±3        | 5             | 20        | ±3          |
| 8  |                             | 11            | 21    | ±3        | 6             | 18        | ±3          |
|    |                             | 12            | 19    | ±3        | 7             | 16        | ±3          |
|    |                             | 13            | 17    | ±3        | 8             | 14        | ±3          |
|    |                             | 14            | 15    | ±3        | 9             | 12        | ±4          |
|    |                             | 15            | 13    | ±3        | 10            | 10        | ±4          |
|    |                             | 16            | 11    | ±5        | 11            | 8         | ±4          |
|    |                             | 17            | 9     | ±5        | 12            | 6         | ±4          |
|    |                             | 18            | 7     | ±5        | 13            | 4         | ±4          |
|    |                             | 19            | 5     | ±5        | 14            | 2         | ±5          |
|    |                             |               |       |           | 15            | 0         | ±5          |
| 9  | Burst timing                | Mask IN       |       |           | Mask IN       |           |             |

# 2. PERFORMANCE

# 2) Transmitter-WCDMA Mode

| No | Item  | Specification                           |  |  |  |
|----|---|---|--|--|--|
|    | Maximum Outrast Davies                          | Class3: +24dBm(+1/-3dB)                 |  |  |  |
| 1  | Maximum Output Power                            | Class4: +21dBm(±2dB)                    |  |  |  |
| 2  | Frequency Error                                 | ±0.1ppm                                 |  |  |  |
| 3  | Open Loop Power control in uplink               | ±9dB@normal, ±12dB@extreme              |  |  |  |
|    |   | Adjust output(TPC command)              |  |  |  |
|    |   | cmd 1dB 2dB 3dB                         |  |  |  |
|    |   | +1 +0.5/1.5 +1/3 +1.5/4.5               |  |  |  |
| 4  | Inner Loop Power control in uplink              | 0 -0.5/+0.5 -0.5/+0.5 -0.5/+0.5         |  |  |  |
|    |   | -1 -0.5/-1.5 -1/-3 -1.5/-4.5            |  |  |  |
|    |   | group(10equal command group)            |  |  |  |
|    |   | +1 +8/+12 +16/+24                       |  |  |  |
| 5  | Minimum Output Power                            | -50dBm(3.84MHz)                         |  |  |  |
|    | Out-of-synchronization handling of output power | Qin/Qout:DPCCH quality levels           |  |  |  |
| 6  |   | Toff@DPCCH/lor:-22->-28dB               |  |  |  |
|    |   | Ton@DPCCH/lor:-24->-18dB                |  |  |  |
| 7  | Transmit OFF Power                              | -56dBm(3.84M)                           |  |  |  |
| 8  | Transmit ON/OFF Time Mask                       | ±25us                                   |  |  |  |
|    | Transmit OW/OFF Time wask                       | PRACH, CPCH, uplink compressed mode     |  |  |  |
|    |   | ±25us                                   |  |  |  |
| 9  | Change of TEC                                   | power varies according to the data rate |  |  |  |
|    | Change of TFC                                   | DTX: DPCH off                           |  |  |  |
|    |   | (minimize interference between UE)      |  |  |  |
| 10 | Power setting in uplink compressed              | ±3dB(after 14slots transmission gap)    |  |  |  |
| 11 | Occupied Bandwidth(OBW)                         | 5MHz(99%)                               |  |  |  |
|    |   | -35-15*(Δf-2.5)dBc@Δf=2.5~3.5MHz, 30k   |  |  |  |
| 12 | Spectrum emission Mask                          | -35-1*(Δf-3.5)dBc@Δf=3.5~7.5MHz, 1M     |  |  |  |
| 12 | Spectrum emission Mask                          | -39-10*(Δf-7.5)dBc@Δf=7.5~8.5MHz, 1M    |  |  |  |
|    |   | -49 dBc@Δf=8.5~12.5MHz, 1M              |  |  |  |

| No | Item                                 | Specification                   |
|----|--------------------------------------|---------------------------------|
| 13 | Adjacent Channel Leakage Ratio(ACLR) | 33dB@5MHz, ACP>-50dBm           |
| 13 | Adjacent Chaimer Leakage Hallo(ACLH) | 43dB@10MHz, ACP>-50dBm          |
|    |                                      | -36dBm@f=9~150KHz, 1k BW        |
|    |                                      | -36dBm@f=150KHz~30MHz, 10k      |
|    |                                      | -36dBm@f=30~1000MHz, 100k       |
| 14 | Spurious Emissions                   | -30dBm@f=1~12.75GHz, 1M         |
| 14 | *: additional requirement            | -41dBm*@1893.5~1919.6MHz, 300k  |
|    |                                      | -67dBm*@925~935MHz, 100k        |
|    |                                      | -79dBm*@935~960MHz, 100k        |
|    |                                      | -71dBm*@1805~1880MHz, 100k      |
| 15 | Transmit Intermodulation             | -31dBc@5MHz, Interferer -40dBc  |
| 15 | Transmit intermodulation             | -41dBc@10MHz, Interferer -40dBc |
| 16 | Error Voctor Magnitudo(EVM)          | 17.5% (>-20dBm)                 |
| 10 | Error Vector Magnitude(EVM)          | (@12.2k, 1DPDCH+1DPCCH)         |
| 17 | Transmit OFF Power                   | -15dB@SF=4, 768kbps, multi-code |
| 17 | Hansilit OFF FOWei                   | transmission                    |

# 3)Receiver - GSM Mode

| No | Item                    |                  | Item GSM                         |                                  |  |
|----|-------------------------|------------------|----------------------------------|----------------------------------|--|
| 1  | Sensitivity (TC         | H/FS Class II)   | -105dBm                          | -105dBm                          |  |
| 2  | Co-Channe               | el Rejection     | C/Ic=7dB                         | C/Ic=7dB                         |  |
| -  | (TCH/FS Class II, I     | RBER, TUhigh/FH) | C/IC=7dB                         |                                  |  |
| 3  | Adjacent Channel        | 200kHz           | C/la1=-12dB                      | C/la1=-12dB                      |  |
|    | Rejection 400kHz        |                  | C/la2=-44dB                      | C/la2=-44dB                      |  |
|    |                         |                  | Wanted Signal: -98dBm            | Wanted Signal: -96dBm            |  |
| 4  | Intermodulati           | ion Rejection    | 1'st interferer: -44dBm          | 1'st interferer: -44dBm          |  |
|    |                         |                  | 2'st interferer: -45dBm          | 2'st interferer: -44dBm          |  |
| 5  | Blocking I              | Response         | Wanted Signal: -101dBm           | Wanted Signal: -101dBm           |  |
|    | (TCH/FS Class II, RBER) |                  | Unwanted Signal: Depend on freq. | Unwanted Signal: Depend on freq. |  |

# 2. PERFORMANCE

# 4) Receiver - WCDMA Mode

| No | Item                                 | Specification                  |
|----|--------------------------------------|--------------------------------|
| 18 | Reference Sensivitivity Level        | -106.7dBm(3.84M)               |
|    |                                      | -25dBm(3.84MHz)                |
| 19 | Maximum Input Level                  | -44dBm/3.84MHz(DPCH_Ec)        |
|    |                                      | UE@+20dBm output power(class3) |
| 20 | Adiacont Channal Calactivity (ACC)   | 33dB                           |
| 20 | 20 Adjacent Channel Selectivity(ACS) | UE@+20dBm output power(class3) |
|    |                                      | -56dBm/3.84MHz@10MHz           |
| 21 | 21 In-band Blocking                  | UE@+20dBm output power(class3) |
|    |                                      | -44dBm/3.84MHz@15MHz           |
|    |                                      | UE@+20dBm output power(class3) |
|    |                                      | -44dBm/3.84MHz@f=2050~2095 &   |
|    | Out-band Blocking                    | 2185~2230MHz, band a)          |
|    |                                      | UE@+20dBm output power(class3) |
|    |                                      | -30dBm/3.84MHz@f=2025~2050 &   |
| 22 |                                      | 2230~2255MHz, band a)          |
|    |                                      | UE@+20dBm output power(class3) |
|    |                                      | -15dBm/3.84MHz@f=1~2025 &      |
|    |                                      | 2255~12500MHz, band a)         |
|    |                                      | UE@+20dBm output power(class3) |
| 23 | Spurious Response                    | -44dBm CW                      |
| 20 | Spullous Hespolise                   | UE@+20dBm output power(class3) |
|    |                                      | -46dBm CW@10MHz &              |
| 24 | Intermodulation Characteristic       | -46dBm/3.84MHz@20MHz           |
|    |                                      | UE@+20dBm output power(class3) |
|    |                                      | -57dBm@f=9KHz~1GHz, 100k BW    |
| 25 | Spurious Emissions                   | -47dBm@f=1~12.75GHz, 1M        |
|    |                                      | -60dBm@f=1920~1980MHz, 3.84MHz |
|    |                                      | -60dBm@f=2110~2170MHz, 3.84MHz |

# 2.4 Current Consumption

(VT test : Speaker off, LCD backlight On)

|                  | Stand by         | Voice Call   | VT           |  |
|------------------|------------------|--------------|--------------|--|
| WCDMA            | 120Hours=10mA    | 140Min=514mA | 100Min=720mA |  |
|                  | (DRX=1.28)       | (Tx=12dBm)   | (Tx=12dBm)   |  |
| GSM 150Hours=8mA |                  | 180Min=400mA |              |  |
|                  | (paging=9period) | (Tx=Max)     |              |  |

# **2.5 RSSI**

TBD

|           | GSM        | WCDMA(TBD) |
|-----------|------------|------------|
| BAR 4 → 3 | -91 ±2dBm  |            |
| BAR 3 → 2 | -96 ±2dBm  |            |
| BAR 2 → 1 | -101 ±2dBm |            |
| BAR 1 → 0 | -106 ±2dBm |            |

# 2.6 Battery Bar

| Indication                   | Voltage                                  |
|------------------------------|--|
| BAR 4 → 3 (68%)              | 3.87 ±0.03V                              |
| BAR 3 → 2 (47%)              | 3.77 ±0.03V                              |
| BAR 2 → 1 (26%)              | 3.72 ±0.03V                              |
| BAR 1 → Icon Blinking (5%)   | 3.50 ±0.03V                              |
| Low voltage, werning message | 3.50 ±0.03V(Talk: 1min. interval) -5%    |
| Low voltage, warning message | 3.46 ±0.03V(Standby: 3min. Inverval) -3% |
| Power OFF                    | 3.10 ±0.03V ↓ (WCDMA Talk)               |
| Fowel OFF                    | 3.20 ±0.03V ↓ (else)                     |

# 2.7 Sound Pressure Level

|   | No                             | Test Item                          |            |      |            |                     | Specification     |  |  |
|---|--------------------------------|------------------------------------|------------|------|------------|---------------------|-------------------|--|--|
|   | 1                              | Sending Loudness I                 | Rating (S  | LR)  |            | NOM<br>MAX          | 8±3dB             |  |  |
|   |                                |                                    |            |      | -          | NOM                 | -1±3dB            |  |  |
|   | 2                              | Receiving Loudness Rating (RLR)    |            |      |            | MAX                 | -13±1dB           |  |  |
|   | _                              |                                    |            |      | -          | NOM                 |                   |  |  |
|   | 3                              | Side Tone Masking F                | Rating (ST | TMR) |            | MAX                 | 17dB over         |  |  |
|   | 4                              | Echo Loss                          | (EL)       |      | MS         | NOM                 | 40dB over         |  |  |
|   | _                              | Sending Distort                    | · ,        |      | _          | MAX                 | fer to TABLE 30.3 |  |  |
|   | 5                              | <u> </u>                           | . ,        |      | -          |                     |                   |  |  |
|   | 6                              | Receiving Distor                   | tion (RD)  |      | _          |                     | fer to TABLE 30.4 |  |  |
|   | 7                              | Idle Noise-Send                    | ing (INS)  |      |            | NOM<br>MAX          | -64dBm0p under    |  |  |
|   |                                |                                    |            |      | NOM        | -47dBPA under       |                   |  |  |
|   | 8                              | Idle Noise-Receiving (INR)         |            |      |            | MAX                 | -36dBPA under     |  |  |
| Α | 9                              | Conding Loudness Deting (CLD)      |            |      |            | NOM                 | 8±3dB             |  |  |
| С | 9                              | Sending Loudness Rating (SLR)      |            |      |            | MAX                 | 0±3UD             |  |  |
| 0 | 10                             | 10 Receiving Loudness Rating (RLR) |            |      |            | NOM                 | -1±3dB            |  |  |
| U | neceiving Loudness hailing (hi |                                    | (11211)    |      | MAX<br>NOM | -12±3dB             |                   |  |  |
| S | 11                             | Side Tone Masking Rating (S        |            |      | TMR)       |                     | 25dB over         |  |  |
| Т |                                | Cide Tone Wasking I                |            |      |            | MAX                 | 2000 0001         |  |  |
|   | 12                             | Echo Loss                          | EL) HEAD   |      | NOM        | 40dB over           |                   |  |  |
| С | 10                             |                                    | <u> </u>   |      | SET        | MAX                 |                   |  |  |
|   | 13                             | Sending Distort                    | . ,        |      | _          | refer to TABLE 30.3 |                   |  |  |
|   | 14                             | Receiving Distor                   | tion (RD)  |      |            | refer to TABLE 30.4 |                   |  |  |
|   | 15                             | Idle Noise-Sending (INS)           |            |      | NOM        | -55dBm0p under      |                   |  |  |
|   |                                | idio (voide deriding (iive)        |            |      |            | MAX                 | •                 |  |  |
|   | 16                             | Idle Noise-Recei                   | vina (INR  | )    |            | NOM                 | -45dBPA under     |  |  |
|   |                                |                                    | 9 (        | ,    |            | MAX                 | -40dBPA under     |  |  |
|   |                                | TDMA NOISE                         |            | GSM  | SEND       |                     |                   |  |  |
|   |                                | GSM: Power Level: 5                | MS         |      | REV.       |                     |                   |  |  |
|   |                                | DCS: Power Level: 0                |            | DCS  | SEND       | -62dBm under        |                   |  |  |
|   | 17                             | (Cell Power: -90 ~ -105dBm)        |            |      | REV.       |                     |                   |  |  |
|   |                                | Acoustic(Max Vol.)                 |            | GSM  | SEND       |                     |                   |  |  |
|   |                                | MS/HEADSET SLR: 8±3dB              | Headset    |      | REV.       |                     |                   |  |  |
|   |                                | MS/HEADSET RLR: -13±1dB/-15dB      | . 1000001  | DCS  | SEND       |                     |                   |  |  |
|   |                                | (SLR/RLR: mid-Value Setting)       |            |      | REV.       |                     |                   |  |  |

# 2.8 Charging

• Normal mode: Complete Voltage: 4.2V

Charging Current: 600mA

· Await mode: In case of During a Call, should be kept 3.9V

(GSM: It should be kept 3.9V in all power level

WCDMA: It will not be kept 3.9V in some power level)

Extend await mode: At Charging prohibited temperature(-20C under or 60C over)

(GSM: It should be kept 3.7V in all power level

WCDMA: It will not be kept 3.7V in some power level)

# 3. Technical Brief

# 3.1 Digital Baseband(DBB) & Multimedia Processor

## 3.1.1 General Description

#### A. Features

- CPU ARM946 running at 104 MHz
- 32 kB Instruction Cache, 16 kB Data Cache, 128 kB Instruction TCM and 128 kB Data TCM
- 8 channel DMAC
- DSP C55x (LEAD3) Megastar (MGS3\_2.0B) running at 170 MHz
- 144 kWord ROM, 32 kWord DARAM, 32 kWord SARAM
- 7 channel DMAC
- Dedicated API channel to DSP memory (not locked up to other DMA channels)
- UMTS Access
- Support for WCDMA/GSM Dual Mode
- GSM/GPRS network signaling (from Layer 1 to 3)
- WCDMA Ciphering and Integrity
- High Speed Serial Link (HSSL) to the WCDMA Modem (at Layer 1)
- GSM AMR
- Multislot Class 8
- HSCSD 14.4 kb/s
- · MMI
- Keypad Interface
- Tone Generator Interface
- Camera Data and Programmable Display Interfaces
- Enhanced graphics support for QCIF display
- · Operation and Services
- I<sup>2</sup>C™ Interface
- SIM Interfaces
- General Purpose I/O (GPIO) Interface
- External Memory Interface that supports FLASH, SRAM and PSRAM
- JTAG
- RTC
- ETM (in Prototype Package)
- Data Communication
- IrDA ® (SIR)
- UARTs (ACB, EDB (RS232))
- Slave USB
- Package
- 12 by 12 mm 289 pin FPBGA Production Package

## 3.1.2 Hardware Architecture

The hardware structure is delivered as five separate hardware macros to the top-level design, also depicted in Figure.

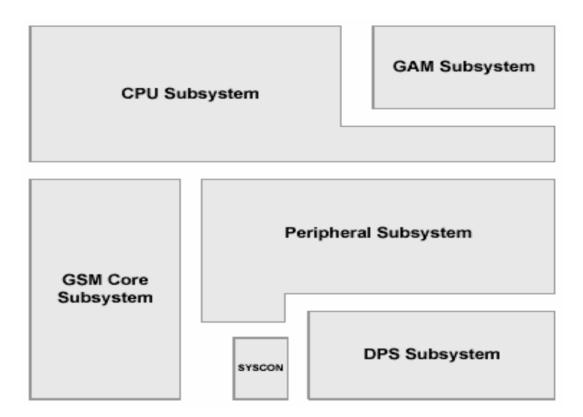


Figure. Simplified Block Diagram

## A. Block Diagram

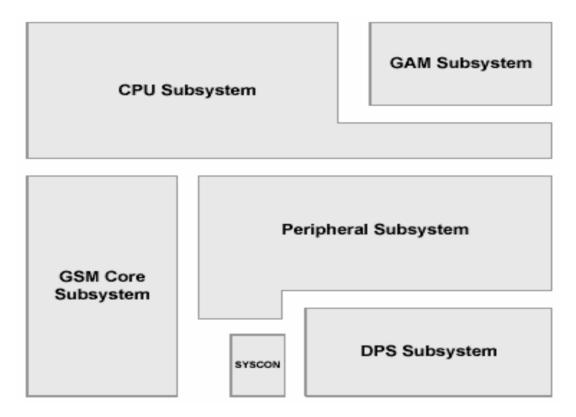


Figure. Simplified Block Diagram

## **B. CPU Hardware Subsystem**

The CPU subsystem incorporates:

- · CPU Sub chip
- Backplane
- JTAG
- DMA Controller
- System Buffer RAM
- Boot ROM
- External Memory Interface (EMIF) for connection to external SRAM and Flash memories.

The bus architecture is built on the ARM AMBA standard with multi-layer AHB (Advanced High-speed Bus) and APB (Advanced Peripheral Bus) for the peripheral buses.

There are two AHB busses, the CPU AHB and the DMA AHB.

Clocks to the CPU subsystem are distributed from the system control (SYSCON) backplane clocking. The reset lines are all asynchronously asserted low and synchronously negated high.

The CPU subsystem has separate clocking and reset for the ARM946, AHB system, EMIF and DMAC.

## C. Peripheral Hardware Subsystem

There are 29 peripherals within the peripheral hardware subsystem. With the exception of the USB, all hardware peripheral blocks are APB slave peripherals. From an architecture-hierarchy perspective, the SYSCON block is an APB slave on the slow APB bridge, but resides at the top level of the ASIC. The APB provides a simple interface to support low-performance peripherals.

Within the peripheral subsystem, there are four separate APB busses with AHB to APB (AHB2APB) bridges to the multi-layer AHB.

## D. DSP Hardware Subsystem

The DSP subsystem provides support for processor intensive activity, such as voice coding and multimedia application support. The DSP subsystem includes the standard C55xTM Core (LEAD3) from Texas Instruments with associated memory system and peripherals.

## E. GAM Hardware Subsystem

The Graphics Accelerator Module (GAM) subsystem provides hardware support in the creation of visual imagery and the transfer of this data to the display. GAM also provides support for the camera module. The visual data could be graphics, still images or video.

The GAM subsystem consists of five modules:

- · GRAM graphics memory (160 kB).
- · GAMCON . GAM controller.
- · GRAPHCON . graphics controller.
- PDI/SSI programmable display interface for parallel/serial displays.
- · CDI camera data interface.

## F. GSM Hardware Subsystem

The GSM subsystem is a stand-alone sub-chip incorporating GSM modem and interface to GSM radio together with memory control (MEMSYS) and internal RAM (IRAM).

The hardware peripheral blocks are RXIF, FCHDET, CRYPTO, EQU, NODI, 4 x CHD, GPRS CRYPTO, GPRS CRC24, CHE, DIRMOD, CLKCON, SERCON, TIMGEN, MEMSYS and IRAM.

The peripherals are accessible to the AHB (CPU-only) by an asynchronous I/O bridge.

The dual port IRAM is accessible to the AHB (CPU and DMA) by a synchronous AHB slave interface.

## G. System Control Subsystem

The system controller subsystem (SYSCON) is primarily responsible for generating clock signals and distributing the clock and reset signals within the ASIC and certain external devices. The GSM core, GAM and DSP subsystems include their own system controllers that are sourced from SYSCON. SYSCON consists of analog and digital PLL clocks and a clock squarer. The block is a slave peripheral on the slow APB bus under control of the CPU.

The programming of SYSCON controls the fundamental modes of operation within the ASIC.

Individual blocks can also be reset and their clocks held inactive by accessing the appropriate control registers. SYSCON also controls the requesting protocol through which different sub-blocks in Ericsson DB 20000 can request clocks derived from the system clock.

The system controller also stores the chip-ID number in a read only register.

## 3.1.3 External memory interface

There are four independent chip selects (CS0, CS1, CS2, CS3) provided for external memories and each has an address range of 256 Mb.

RF calibration data, Audio parameters and battery calibration data etc are stored in flash memory area.

## A. U8100 & U8100

- 384Mb flash memory + 64Mb PSRAM
- 4-CS(Chip Select) are used

| Interface Spec. |                  |       |                  |       |                     |                |  |
|-----------------|------------------|-------|------------------|-------|---------------------|----------------|--|
| Dovice          | Part Name        | Maker | Read Access Time |       |                     | Write          |  |
| Device          |                  | waker | Async            | Page  | Burst               | Access<br>Time |  |
| MCP             | S71WS256HC0BAW00 | AMD   | 56 ns            | _     | 13.5 ns<br>at 54MHz | 56 ns          |  |
| FLASH           | Am29BDS128HD9VKI | AMD   | 56 ns            | _     | 13.5 ns<br>at 54MHz | 70 ns          |  |
| PSRAM           | S71WS256HC0BAW00 | AMD   | 70 ns            | 20 ns | _                   | 70 ns          |  |

## Table External memory interface for U8100 & U8100

## **B. U8100**

- 512Mb flash memory + 64Mb PSRAM
- · 3-CS(Chip Select) are used

| Interface Spec. |                    |       |                  |       |                   |                |  |
|-----------------|--------------------|-------|------------------|-------|-------------------|----------------|--|
| Device          | Deat News          | Maker | Read Access Time |       |                   | Write          |  |
| Device          | evice Part Name Ma |       | Async            | Page  | Burst             | Access<br>Time |  |
| MCP             | RD38F4050L0YTQ0    | Intel | 85 ns            | 25 ns | 14 ns<br>at 54MHz | 85 ns          |  |
| FLASH           | NZ48F4000L0YBQ0    | Intel | 85 ns            | 25 ns | 14 ns<br>at 54MHz | 85 ns          |  |
| PSRAM           | RD38F4050L0YTQ0    | Intel | 85 ns            | 25 ns | 10 ns<br>at 66MHz | 85 ns          |  |

Table External memory interface for U8100

## 3.1.4 RF Interface

#### A. MARITA Interface

Marita controls GSM RF part using these signals through GSM RF chip-Ingela.

• RFCLK, RFDAT, RFSTR: Control signals for Ingela

• TXON, RXON : Control signals for TX and RX part of Ingela

• PCTL : Control signal for GSM TX PAM

BANDSEL0 : Band selection signal for GSM or DCSANTSW[0:3] : Control signals for antenna switch

• DCLK, IDATA, QDATA : GSM/DCS RX Data • DIRMOD[A:D] : GSM/DCS TX Data

#### RF I/F

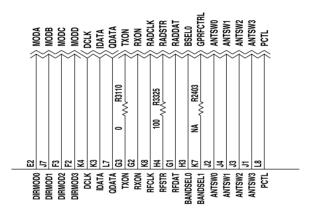


Figure. Schematic of MARITA RF Interface

#### **B. WANDA Interface**

Wanda controls WCDMA RF part using these signals through W-CDMA RF chip-Wopy & Wivi.

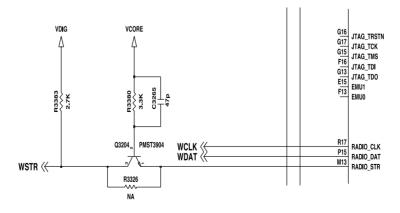


Figure. Schematic of WANDA RF Interface

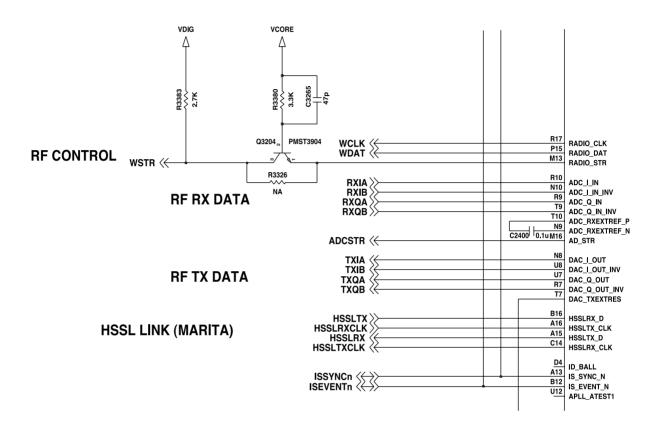


Figure. Schematic of WANDA RF Interface

• RADIO\_CLK, RADIO\_DAT, RADIO\_STR: Control signals for Wivi & Wopy

• RXIA, RXIB, RXQA, RXQB : WCDMA RX Data • TXIA, TXIB, TXQA, TXQB : WCDMA TX Data

HSSLRX\_D, HSSLRX\_CLK
 HSSLTX\_D, HSSLTX\_CLK
 Marita & Wanda Communication Signal
 Marita & Wanda Communication Signal

## 3.1.5 SIM Interface

SIMDATO, SIMCLKO, SIMRSTO ports are used to communicate DBB(MARITA) with ABB(VINCENNE) and filter.

| SIM (Interface between DBB and ABB) |                                  |  |  |  |  |  |
|-------------------------------------|----------------------------------|--|--|--|--|--|
| SIMDAT0                             | SIM card bidirectional data line |  |  |  |  |  |
| SIMCLK0                             | SIM card reference clock         |  |  |  |  |  |
| SIMRST0                             | SIM card async/sync reset        |  |  |  |  |  |

**Table. SIM Interface** 

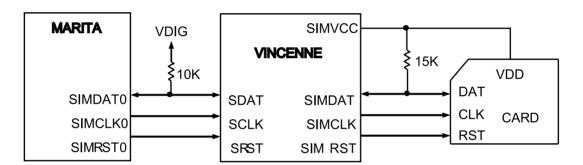


Figure. SIM Interface

## 3.1.6 UART Interface

UART signals are connected to MARITA GPIO through IO connector

|          | UART0    |                       |  |  |  |  |
|----------|----------|-----------------------|--|--|--|--|
| Resource | Name     | Note                  |  |  |  |  |
| GPIO10   | UARTRX0  | Transmit Data         |  |  |  |  |
| GPIO11   | UARTTX0  | Receive Data          |  |  |  |  |
|          | UART1    |                       |  |  |  |  |
| GPIO14   | UARTRX1  | Transmit Data (UART1) |  |  |  |  |
| GPIO15   | UARTTX1  | Receive Data (UART1)  |  |  |  |  |
| GPIO16   | UARTRTS1 | Request To Send       |  |  |  |  |
| GPIO17   | UARTCTS1 | Clear To Send         |  |  |  |  |

Table. UART Interface

# 3.1.7 GPIO (General Purpose Input/Output) map

In total 40 allowable resources. This model is using 25 resources.

GPIO Map, describing application, I/O state, and enable level are shown in below table.

| IO#    | Application          | Ю | Resource | Inactive State | Active State |
|--------|----------------------|---|----------|----------------|--------------|
| GPIO00 | Not used             | _ | _        | _              | _            |
| GPIO01 | BL_PWL               | 0 | GPIO     | Low            | High         |
| GPIO02 | 7C_LED_VDD_EN        | 0 | GPIO     | Low            | High         |
| GPIO03 | PULSESKIP (Not used) | 1 | GPIO     | _              | _            |
| GPIO04 | CAMERA_DET           | 1 | GPIO     | High           | Low          |
| GPIO05 | GPIO05 (Not used)    | 0 | _        | _              | _            |
| GPIO06 | AMPCTR               | 0 | GPIO     | Low            | High         |
| GPIO07 | TGBUZZ (Not used)    | 0 | GPIO     | Low            | High         |
| GPIO10 | UARTRX0              | ı | UART0    | High           | Low          |
| GPIO11 | UARTTX0              | 0 | UART0    | High           | Low          |
| GPIO12 | Not used             | - | -        | _              | _            |
| GPIO13 | Not used             | _ | _        | _              | _            |
| GPIO14 | UARTRX1              | I | UART1    | High           | Low          |
| GPIO15 | UARTTX1              | 0 | UART1    | High           | Low          |
| GPIO16 | UARTRTS1             | ı | UART1    | High           | Low          |
| GPIO17 | UARTCTS1             | 0 | UART1    | _              | _            |
| GPIO20 | CAM_REG_EN           | 0 | GPIO     | Low            | High         |
| GPIO21 | CAM_FLASH_ON         | 0 | GPIO     | Low            | High         |
| GPIO22 | TP2125 (Not used)    | - | -        | _              | _            |
| GPIO23 | CAM_FLASH_SHOT       | 0 | GPIO     | Low            | High         |
| GPIO24 | Not used             | - | _        | _              | _            |
| GPIO25 | Not used             | _ | _        | _              | _            |
| GPIO26 | Not used             | _ | _        | _              | _            |
| GPIO27 | Not used             | _ | _        | _              | _            |
| GPIO30 | Not used             | _ | _        | _              | _            |
| GPIO31 | Not used             | - | _        | _              | _            |

# 3. TECHNICAL BRIEF

| IO#    | Application          | Ю | Resource | Inactive State  | Active State   |
|--------|----------------------|---|----------|-----------------|----------------|
| GPIO32 | KEY_LED_ONOFF        | 0 | GPIO     | Low             | High           |
| GPIO33 | Not used             | _ | _        | _               | _              |
| GPIO34 | Not used             | _ | _        | -               | _              |
| GPIO35 | LCDVSYNCI (Not used) | I | GPIO     | Low             | High           |
| GPIO36 | SPKMUTE              | 0 | GPIO     | LOW (Ear piece) | HIGH (Speaker) |
| GPIO37 | Not used             | _ | _        | -               | _              |
| GPIO40 | USBSENSE             | I | GPIO     | Low             | High           |
| GPIO41 | Not used             | _ | _        | -               | _              |
| GPIO42 | BL_EN                | 0 | GPIO     | Low             | High           |
| GPIO43 | FOLDER_DET           | I | GPIO     | High            | Low            |
| GPIO44 | EN_LED_R             | 0 | GPIO     | Low             | High           |
| GPIO45 | EN_LED_G             | 0 | GPIO     | Low             | High           |
| GPIO46 | EN_LED_B             | 0 | GPIO     | Low             | High           |
| GPIO47 | IRDA_REG_CTRL        | 0 | GPIO     | Low             | High           |

**Table. MARITA GPIO Map Table** 

#### 3.1.8 USB

The USB block supports the implementation of a "full-speed" device fully compliant to USB 2.0 standard. It provides an interface between the CPU (embedded local host) and the USB wire, and handles USB transactions with minimal CPU intervention.

The USB specification allows up to 15 pairs of endpoints. Data for each endpoint is buffered in RAM within the USB block and is read/written from the endpoint FIFO using DMA transfers or FIFO register access. High-speed (high throughput) endpoints can use DMA while slower endpoints can use FIFO register access.

The USB block can request up to six DMA channels, three for IN endpoints and three for OUT endpoints.

| USB Function      | Note                              |  |  |
|-------------------|-----------------------------------|--|--|
| USBDP             | USB differential (+) line         |  |  |
| USBDM             | USB differential (-) line         |  |  |
| USBSENSE (GPIO40) | USB detection (input)             |  |  |
| USBPUEN           | USB pull-up control               |  |  |
| VDDUSB            | Power supply for MARITA USB block |  |  |

**Table. USB Signal Interface of MARITA** 



Figure. Schematic of MARITA USB block

USB regulator input voltage is 5V and uses external USB device power through IO Connector. Output voltage is 3.3V and supply to MARITA USB block.

USB is detected by MARITA GPIO40(USBSENES).

• VUSB / (10K + 51K) = VUSBSENSE / 51K

#### **3.3V REG**

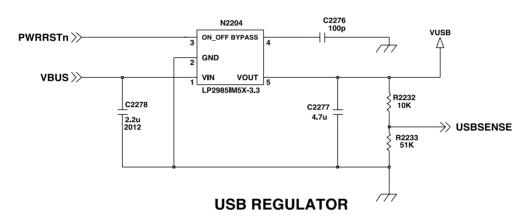


Figure. Schematic of USB Regulator

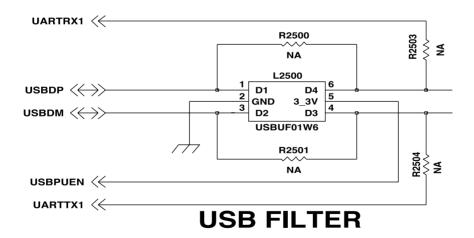


Figure. Schematic of USB filter

## 3.1.9 IrDA Interface

MARITA supports FIR, MIR and SIR mode.

In this model, the IrDA block supports SIR (Standard IrDA) mode.

SIR supports data rates up to 115,200 bps, including 9,600/19,200/38,400/57,600 bps.

In this mode, IrDA uses eight data bits per character and one stop bit.

IrDA supports a protocol defined by the IrDA Association.

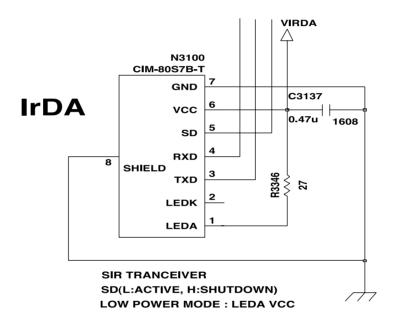


Figure. Schematic of MARITA IrDA Interface

# 3.1.10 Folder ON/OFF Operation

There is a magnet to detect the folder status, opened or closed.

If a magnet is close to the hall-effect switch (U1 on keypad), the voltage at pin2 of U1 goes to 0V. Otherwise, 2.8V.

This folder signal is delivered to MARITA GPIO43.

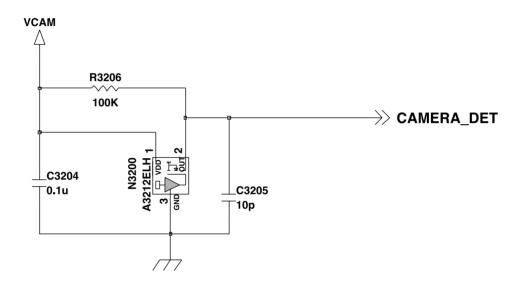


Figure. Schematic of MARITA IrDA Interface

## 3.1.11 Power On Sequence

- ① User press END key and ONSWAn signal is changed to Low.
- ② VINCENNE initiate the internal oscillator and power up the regulators.
- ③ VINCENNE generate a power for MARITA.
- 4 VINCENNE release the power reset signal(PWRRSTn) and generate an interrupt(IRQ0n) to MARITA.

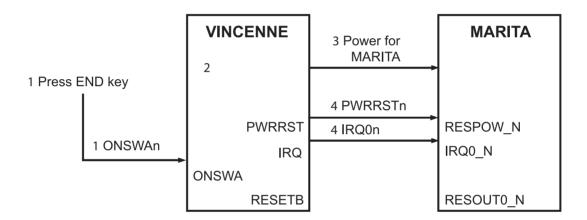


Figure. Power On Sequence

# 3.1.12 Key Pad

There are 26 buttons and 3 side keys in Figure 3-xx. Shows the Keypad circuit. 'END' Key is connected ONSWAn from Vincenne.

|         | KEYIN0 | KEYIN1  | KEYIN2 | KEYIN3 | KEYIN4 |
|---------|--------|---------|--------|--------|--------|
| KEYOUT0 |        | SIDE1   | SIDE2  | SIDE3  |        |
| KEYOUT1 | 1      | 4       | 7      | *      | UP     |
| KEYOUT2 | 2      | 5       | 8      | 0      | DOWN   |
| KEYOUT3 | 3      | 6       | 9      | #      | RIGHT  |
| KEYOUT4 | SEND   | CLEARER | BACK   | GAME   | LEFT   |
| KEYOUT5 | MENU   | SEARCH  | MULTI  | CAM    | OK     |

**Table Key Matrix Mapping Table** 

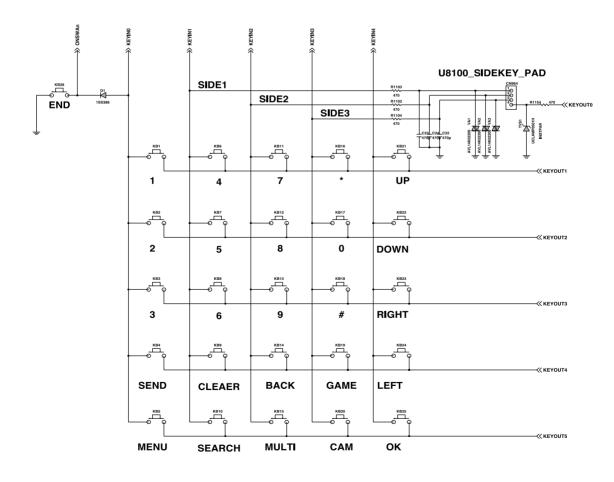


Figure. Power On Sequence

# 3.2 GAM Hardware Subsystem

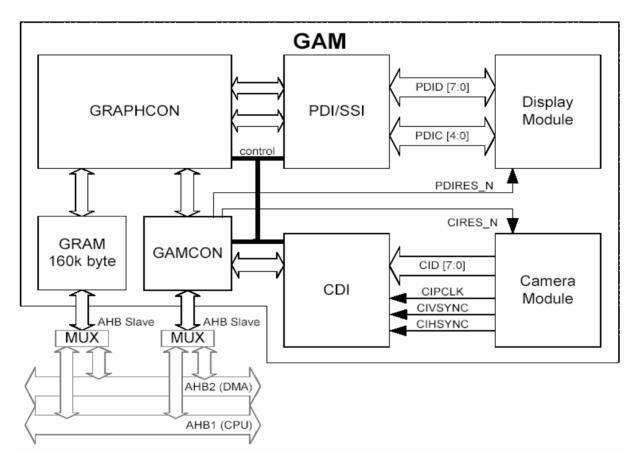


Figure. GAM Subsystem Functional Block Diagram

## 3.2.1 General Description

The Graphics Accelerator Module (GAM) subsystem provides hardware support in the creation of visual imagery and the transfer of this data to the display. GAM also provides support for the camera module. The visual data could be graphics, still images or video. The GAM subsystem consists of five modules:

- GRAM graphics memory (160 kB).
- · GAMCON . GAM controller.
- · GRAPHCON . graphics controller.
- PDI/SSI programmable display interface for parallel/serial displays.
- CDI camera data interface.

### 3.2.2 Block Description

#### **GAM Controller(GAMCON)**

The GAM Controller (GAMCON) is responsible for clock gating and distribution within the GAM module. GAMCON receives the HCLK from SYSCON and distributes to GRAPHCON, GRAM, PDI and CDI. GAMCON also distributes the GAM reset signal to GRAPHCON, GRAM, PDI and CDI. The reset signals CIRES\_N and PDIRES\_N are distributed from GAMCON to the camera and display module respectively, see Figure. The CIPCLK is used to clock the received data into the camera data interface. The CIPCLK can be in the range of 100 kHz to 16 MHz.

#### **Graphics RAM (GRAM) Block**

GAM includes 160 kB of graphics memory (GRAM) in order to support display screen sizes of QCIF + alfa display size and three frame buffers when decoding QCIF video.

The GRAM can be accessed in 8, 16 or 32-bit mode. Write access takes a single AHB clock cycle. Non-sequential read and the first access of a sequential read access takes two AHB clock cycles. Subsequent sequential read access take a single AHB clock cycle.

The GRAM contains both frame buffer and temporary data. There are three image areas with one used for normal MMI graphics and the other two areas used for still images, video frames or camera frames. The three image areas can be combined into one frame buffer.

GRAM is required to transfer a VGA (640 by 480 pixels) image from the camera data interface (CDI) over DMA at 100 MBit/s, within a 50 ms timeframe. The GRAM is used as a buffer, but the average transfer bandwidth required is approximately 3 Mword/s (32-bit word), that is 12 MByte/s.

#### **Graphics Controller (GRAPHCON) Block**

GRAPHCON is controlled by the application CPU and can perform operations on pixels and image areas. Images can be moved and merged with other images and text.

The GRAPHCON block receives graphical objects from GRAM and performers the appropriate graphical manipulation. The resulting data is transfers to the display interface (PDI). GRAPHCON can receive images from the camera data interface (CDI) and send them to the PDI automatically.

GRAPHCON performs conversion from YUV to RGB and can scale (zoom) still or video images.

#### **Programmable Display Interface (PDI) Block**

The programmable display interface (PDI) is designed to interface both parallel and serial display modules. The display data is transferred from the 32 word FIFO on GAMCON to the display module via the PDI block. The PDI block is built around a micro controller and executes 16-bit instruction words to individually control the I/O ports. It has a 128 byte program memory, programmable by the CPU, which can store up to 64 instructions.

The CPU transfers all set-up and control data to the display. Data is transferred to PDI as 32-bit words, which in turn writes 8-bit data to the display. The programmable PDI block is configured at the software build stage, to support either parallel interface such as PPI or serial interface such as SSI or I2C.

#### Camera Data Interface (CDI) Block

The camera data interface (CDI) block is designed to support a range of still image camera modules. An 8-bit parallel bus supports data transfer from the camera module to the CDI.

The pixel clock is an output clock from the camera module to the CDI and qualifies the data on the parallel bus. One byte of data is captured on each rising edge of the pixel clock. CDI allows the pixel clock to be in the range of 100 kHz to 16 MHz.

The horizontal synchronization line is an input from the camera module and defines one scan-line of image data. The horizontal synchronization line can be programmed to be active high or low. The vertical synchronization line is an input from the camera module and defines one image frame (image height) of data. The vertical synchronization line can be programmed to be active high or low.

The frame rate can be adjusted by skipping frames and various interrupts are used to inform the application CPU regarding the progress of incoming images and potential errors. The normal data format on the data bus is YUV 4:2:2 (raw binary image data) according to the CCIR-656 standard. A function within the CDI can be programmed to reorder the YUV parameters as they pass through the CDI. In addition, the CDI is able to detect the end of an image and perform some truncation as well as overflow conditions. There is nothing preventing the use of other data types such as JPEG or RGB (as long as the timing is followed), but only YUV data can be sent to the display.

Camera images can also be sent to a DMA channel to store the image in external memory. The I2C interface and GPIO are part of the interface to the camera module, but they are not part of the CDI block. The I2C is used to set-up and control the camera module.

The camera module I2C lines must go high impedance when the supply is removed from the camera. The I2C commands needed to control the camera, as well as the functional behavior of the module, are also different for each implementation.

The ON-signal (GPIO) is used to power-on the camera from Standby or Off mode (implementation dependent). This signal must be held low when the mobile equipment is powered down and during the mobile equipment reset period. The GPIO pin can also be an input or high impedance during mobile equipment reset and start. In this case, it must have pull-down to ground.

The camera module reset signal is an output to the camera module.

### 3.2.3 Camera & Camera FPC Interface

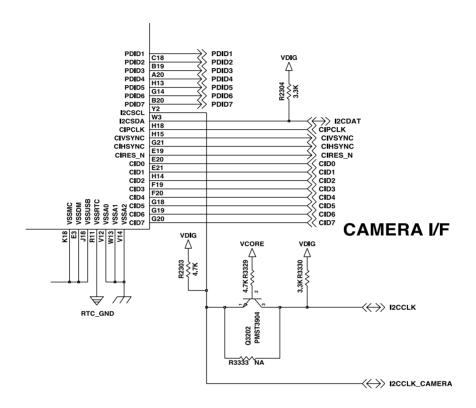


Figure. Camera Interface (in Marita)

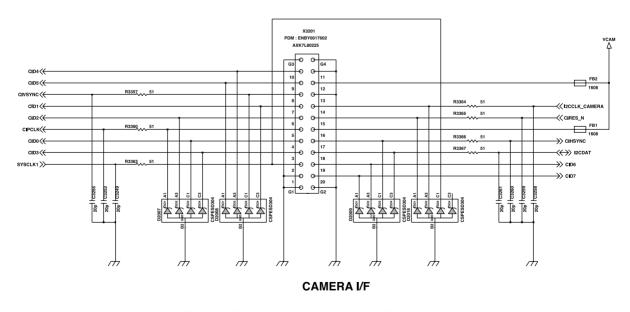


Figure. Camera Board to Board Connector

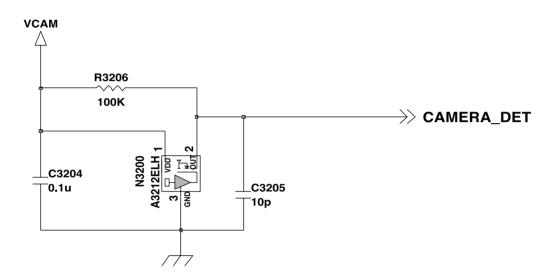
The Camera module is connected to main board with 20pin Board to Board connector (AXK7L80225). Its interface is dedicated camera interface port in Marita. The camera port supply 24MHz master clock to camera module and receive 12MHz pixel clock (30fps), vertical sync signal, horizontal sync signal, reset signal and 8bits YUV data from camera module. The camera module is controlled by I2C port.

| NO | Pin Name | Pin Type | Description                             |
|----|----------|----------|---|
| 1  | DOUT4    | DO       | Image data output                       |
| 2  | DOUT5    | DO       | Image data output                       |
| 3  | VD       | DO       | Vertical Synchronization Pulse Output   |
| 4  | DOUT1    | DO       | Image data output                       |
| 5  | DOUT2    | DO       | Image data output                       |
| 6  | DCLK     | DO       | Clock for Output Data                   |
| 7  | DOUT0    | DO       | Image data output                       |
| 8  | DOUT3    | DO       | Image data output                       |
| 9  | EXTCLK   | DI       | External Clock Input                    |
| 10 | GND      |          | Ground                                  |
| 11 | FSSTB    | DO       | Strobe Pulse for Flash                  |
| 12 | DVDD     |          | VDD for the Digital Circuit             |
| 13 | GND      |          | Ground                                  |
| 14 | SCL      |          | Clock for IIC bus Command               |
| 15 | RESET    | DI       | Reset Terminal                          |
| 16 | AVDD     |          | VDD for the Sensor and PLL              |
| 17 | HD       | DO       | Horizontal Synchronization Pulse Output |
| 18 | SDA      |          | Clock for IIC bus Command               |
| 19 | DOUT6    | DO       | Image data output                       |
| 20 | DOUT7    | DO       | Image data output                       |

Table. Interface between Camera Module and Main Board (in camera module)

### 3.2.4 Camera Position Detection

GPIO\_04 detects the Camera Position (front or back)



**Figure. Camera Position Detection** 

## 3.2.5 Camera Regulator

GPIO\_20 enables Camera Regulator Operation

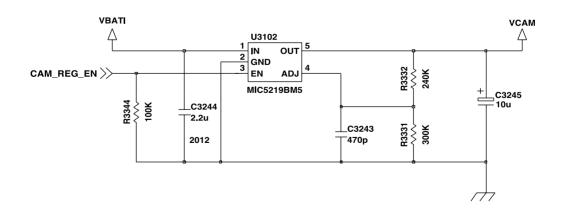


Figure. Camera Regulator

## 3.2.6 Display & LCD FPC Interface

LCD module include device in table 3-2

| Device             | Туре                              |  |
|--------------------|-----------------------------------|--|
| Main LCD           | 176 x RGB x 220 65K Color TFT LCD |  |
| Sub LCD            | 96 x 64 Mono FSTN LCD             |  |
| Main LCD Backlight | White LED                         |  |
| Sub LCD Backlight  | 7 color LED                       |  |

**Table. Devices in LCD Module** 

LCD module is connected to key board with 40-pin BtoB connector (CONN\_40\_AXK840145J) and Speaker, Receiver, Vibrator, Camera Flash is connected by soldering the leads to 9 pads in LCD module.

The Main LCD is controlled by 8-bit PDI(Parallel Data Interface) in Marita and Sub LCD is controlled by 8-bit PDI in Marita.

| PIN | SYMBOL                | SYMBOL FUNCTION    |   | REMARKS |  |  |
|-----|-----------------------|--------------------|---|---------|--|--|
|     | SPK TERMINAL          |                    |   |         |  |  |
| 1   | EARP                  | Ear Piece Plus     | 0 |         |  |  |
| 2   | EARM                  | Ear Piece Minus    | 0 |         |  |  |
| 3   | SPKP                  | Loud Speaker Plus  | 0 |         |  |  |
| 4   | SPKM                  | Loud Speaker Minus | 0 |         |  |  |
|     | MOTOR TERMINAL        |                    |   |         |  |  |
| 1   | MOTOR_BATT            | MOTOR Power        | 0 |         |  |  |
| 2   | MOTOR_GND             | MOTOR Ground       | 0 |         |  |  |
|     | CAMERA FLASH TERMINAL |                    |   |         |  |  |
| 1   | VOUT_F1               | FLASH Power        | 0 |         |  |  |
| 2   | VSIG_F2               | FLASH Signal       | 0 |         |  |  |
| 3   | F3                    | Dummy Ground       | 0 |         |  |  |

Table. Interface between LCD module and Speaker, Receiver, Vibrator, Flash

## 3. TECHNICAL BRIEF

| PIN | SYMBOL         | FUNCTION                                       | I/O | REMARKS |
|-----|----------------|--|-----|---------|
| 1   | GND            | Ground   |     |         |
| 2   | CAM_FLASH_SHOT | Turn ON the Camera Flash Shot                  |     |         |
| 3   | MOTOR_BATT     | MOTOR Power                                    |     |         |
| 4   | SPKP           | Loud Speaker Plus                              |     |         |
| 5   | SPKM           | Loud Speaker Minus                             |     |         |
| 6   | EN_LED_G       | Enable Signal for Sub LCD Backlight LED(Green) |     |         |
| 7   | 7C_LED_VDD     | Power Supply for Sub LCD Backlight             |     |         |
| 8   | BL_EN          | Enable Signal for Main LCD Backlight           |     |         |
| 9   | PDID0          | Parallel Data 0 bit for Main/Sub LCD           |     |         |
| 10  | PDID2          | Parallel Data 2 bit for Main/Sub LCD           |     |         |
| 11  | PDID4          | Parallel Data 4 bit for Main/Sub LCD           |     |         |
| 12  | PDID6          | Parallel Data 6 bit for Main/Sub LCD           |     |         |
| 13  | LCDRDX         | Read Signal for Main/Sub LCD status            |     |         |
| 14  | LCDRS          | Register Select Pin                            |     |         |
| 15  | LCDCSX_SUB     | Chip Select Signal for Sub LCD                 |     |         |
| 16  | LCDVSYNCI      | Main LCD Vertical Synch. Signal                |     |         |
| 17  | GND            | Ground   |     |         |
| 18  | GND            | Ground   |     |         |
| 19  | GND            | Ground   |     |         |
| 20  | GND            | Ground   |     |         |
| 21  | GND            | Ground   |     |         |
| 22  | GND            | Ground   |     |         |
| 23  | VDIO 0.0V      | Power Supply for system                        |     |         |
| 24  | VDIG_2.8V      | and I/O Logic(2.8V)                            |     |         |
| 25  | LCDERESX       | Reset Signal for Main/Sub LCD                  |     |         |
| 26  | LCDCSX_MAIN    | Chip Select Signal for Main LCD                |     |         |
| 27  | LCDWRX         | Write Signal for Main/Sub LCD                  |     |         |
| 28  | PDID7          | Parallel Data 7 bit for Main/Sub LCD           |     |         |
| 29  | PDID5          | Parallel Data 5 bit for Main/Sub LCD           |     |         |

| PIN | SYMBOL       | FUNCTION                                      | I/O | REMARKS |
|-----|--------------|---|-----|---------|
| 30  | PDID3        | Parallel Data 3 bit for Main/Sub LCD          |     |         |
| 31  | PDID1        | Parallel Data 1 bit for Main/Sub LCD          |     |         |
| 32  | BL_PWL       | Main LCD PWL signal                           |     |         |
| 33  | VBATI_4.2V   | Battery Power(4.2V)                           |     |         |
| 34  | EN_LED_B     | Enable Signal for Sub LCD Backlight LED(Blue) |     |         |
| 35  | EN_LED_R     | Enable Signal for Sub LCD Backlight LED(Red)  |     |         |
| 36  | EARP         | Ear Piece Plus                                |     |         |
| 37  | ERAM         | Ear Piece Minus                               |     |         |
| 38  | GND          | Ground  |     |         |
| 39  | CAM_FLASH_ON | Turn ON the Camera Flash<br>Continuous ON     |     |         |
| 40  | GND          | Ground  |     |         |

Table. Interface between LCD module and main board(in LCD Module)

## 3.2.7 Main LCD Backlight Illumination

There are 4 white LEDs in Main LCD Backlight circuit which are driven by 4.5V Regulated Output Charge Pump(SC604). GPIO\_01(BL\_PWL) is used for Backlightbrightness control.

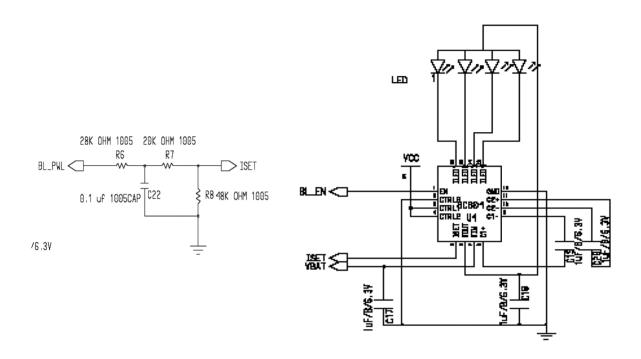


Figure. Charge Pump Circuit for Main LCD Backlight

\* LED: SSC-HWTS902(Seoul Semiconductor)

## 3.2.8 Sub LCD Backlight Illumination

GPIO\_02(7C\_LED\_VDD\_EN) in Marita enables 7 color LED. 7 color LED consists of Red LED, Green LED and Blue LED. GPIO\_44(EN\_LED\_R), GPIO\_45(EN\_LED\_G) and GPIO\_46(EN\_LED\_B) in Marita does ON or OFF its own LEDs.

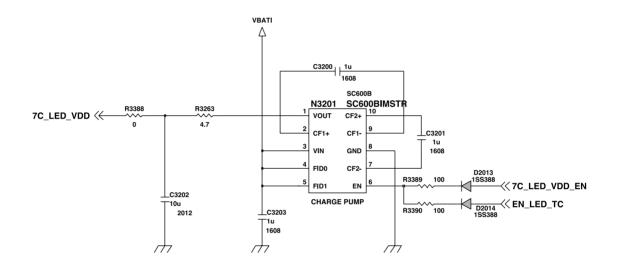


Figure. Sub LCD Backlight 4.5V

In case of power off mode, if TA is inserted, Red LED is turned-on.

## 3.2.9 Keypad Illumination

There are 19 blue LEDs in key board backlight circuit, which are driven by GPIO\_32 (KEY\_LED\_ONOFF) line form Marita.

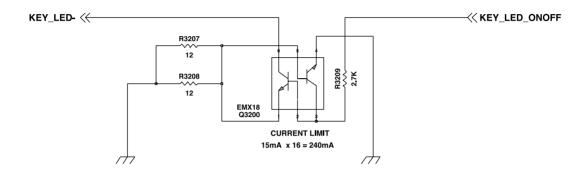


Figure. Keypad Backlight Blue LED Interface

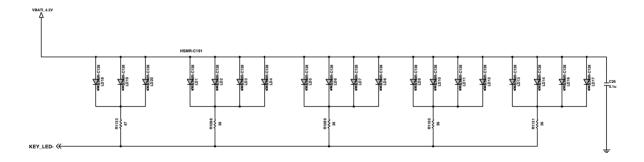


Figure. Keypad Backlight Circuit

#### 3.2.10 Camera Flash Illumination

Camera Flash illumination circuit make 3 modes using white LED. Mode 1. Is Continuous ON mode using GPIO\_21(CAM\_FLASH\_ON), Mode 2. Is Flash Shot using GPIO\_23(CAM\_FLASH\_SHOT) and Mode 3. combines Mode 1. and Mode 2.

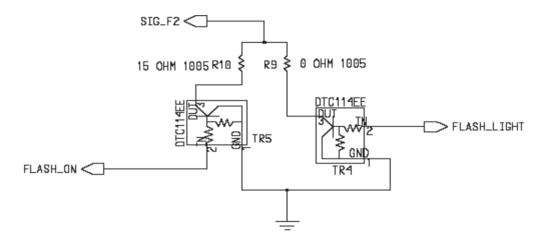


Figure. Camera Flash Circuit

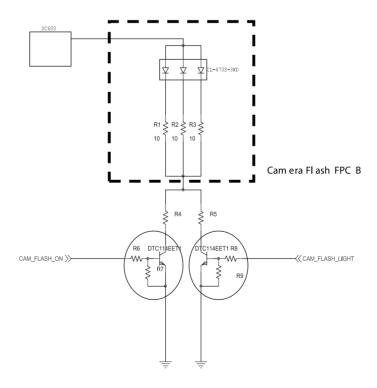


Figure. Camera Flash FPCB & Circuit

## 3.3 LCD Module

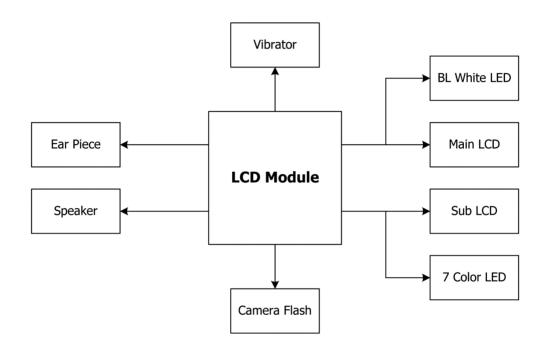


Figure. LCD Module Block Diagram

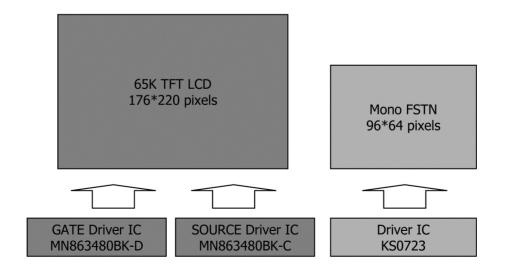


Figure. LCD Module(Main & Sub LCD)

# 3.4 Analog Baseband (ABB) Processor

## 3.4.1 Overview of Audio path

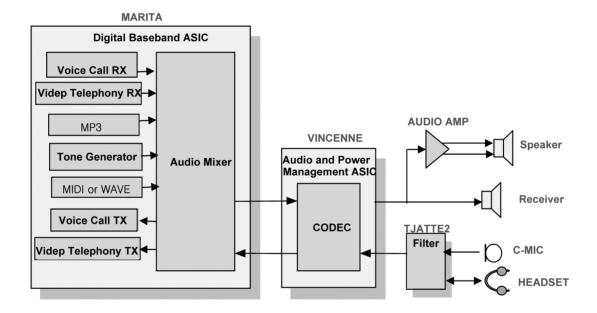


Figure. Audio Path Block Diagram

### 3.4.2 Audio Signal Processing & Interface

Audio signal processing is divided Uplink path and downlink path.

The uplink path amplifies the audio signal from MIC and converts this analog signal to digital signal and then transmit it to DBB Chip (Marita).

This transmitted signal is reformed to fit in GSM & WCDMA Frame format and delivered to RF Chip.

The downlink path amplifies the signal from DBB chip (Marita) and outputs it to Receiver (or Speaker).

The audio interface consists of PCM encoding and decoding circuitry, microphone amplifiers and earphone drivers.

The PCM encoder and decoder blocks are two-channel, 16-bit circuits with programmable gain amplifiers (PGA).

The decoder has a receive volume control. The audio inputs and outputs can be switched to normal or auxiliary ports.

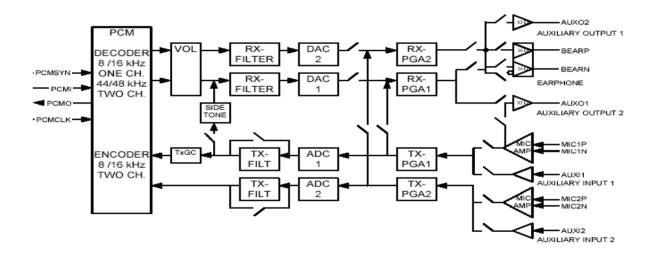


Figure. Audio Interface Detailed Diagram (VICENNE)

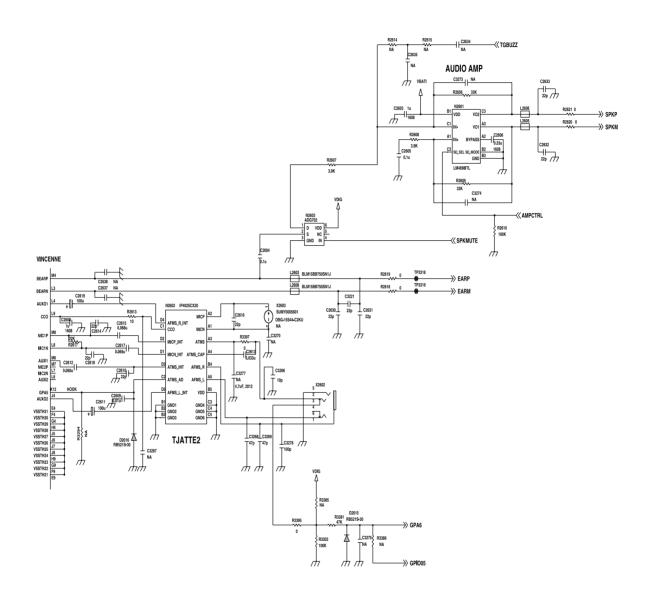


Figure. Audio Section scheme

### 3. TECHNICAL BRIEF

### 3.4.3 Audio Mode

Audio Mode includes three states. (Voice call, Midi.MP3). Each states is sorted by the total 7 Modes according to external Devices (Receiver, Loud Speaker, Headset).

Video Telephony Mode Operate on state of the WCDMA CALL.

| NA           | ode                  | VINCENNE In/Out Port |             |  |  |
|--------------|----------------------|----------------------|-------------|--|--|
| IVIC         | oue                  | IN                   | OUT         |  |  |
|              | Receiver Mode        | MIC1P/MIC1N          | BEARP/BEARN |  |  |
| Voice call   | Loud Speaker Mode    | MIC1P/MIC1N          | BEARP       |  |  |
| voice can    | Headset Mode         | AUXI1                | AUXO1/AUXO2 |  |  |
|              | Video Telephony Mode | MIC1P/MIC1N          | BEARP       |  |  |
| MIDI         | Only Loud Speaker    |                      | BEARP       |  |  |
| MP3          | Loud Speaker Mode    |                      | BEARP       |  |  |
| Headset Mode |                      |                      | AUXO1/AUXO2 |  |  |

**Table Audio Mode** 

### 3.4.4 Voice Call

## 3.4.4.1 Voice call Downlink Mode(Receiver, Speaker, Headset)

This section provides a detailed description of the Voice Call RX functions.

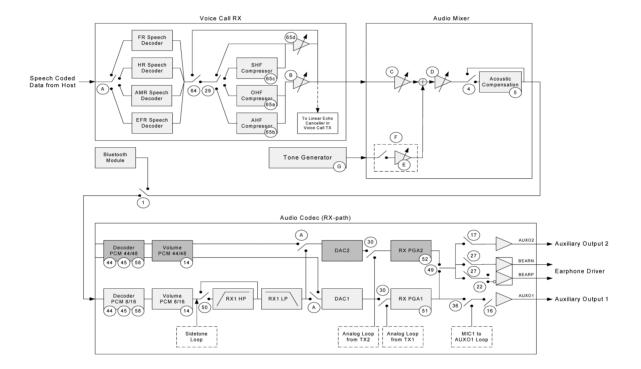


Figure. Voice call Downlink Scheme

#### 3. TECHNICAL BRIEF

The voice decoder accepts a serial input stream of linear PCM coded speech. The receive band-pass filter is the next step in the CODEC receive path. Following the filter is the DAC, followed by a PGA enabling to adjust or trim the circuit in the product for different sensitivity of the earphone and spread in the RX path. The final step in the receive path is the earphone amplifier and the auxiliary output. The auxiliary audio amplifier is intended to drive low impedance headphones. The earphone amplifier and the auxiliary audio outputs can be powered down (muted) via I2C. Both the earphone driver and one of the auxiliary drivers can simultaneously provide an output signal during voice decoding.

• **Receiver Mode**: Earphone amplifier  $\rightarrow$  BEARP/N Port  $\rightarrow$  Receiver(32 $\Omega$ )

• Loud Speaker Mode : Earphone amplifier → BEARP Port → Analog S/W(ADG702) →

AUDIO AMP(LM4894IBP)  $\rightarrow$  Speaker(8 $\Omega$ )

•Video Telephony Mode : Earphone amplifier  $\rightarrow$  BEARP Port  $\rightarrow$  Analog S/W(N2603)  $\rightarrow$ 

AUDIO AMP (LM4894IBP)  $\rightarrow$  Speaker(8 $\Omega$ )

Headset Mode : Auxiliary audio amplifier → AUXO1/2 →

TJATTE2 IN (AFMS\_R\_INT/AFMS\_L\_INT)  $\rightarrow$  TJATTE2 OUT(AFMS\_R/AFMS\_L)  $\rightarrow$  Head Phone

**Speaker Phone Mode** has two GPIO switching control ports. One is **SPKMUTE** and the other is **AMPCTRL**. SPKMUTE controls analog switch( ADG702) and AMPCTRL controls shutdown of AUDIOAMP(LM4894IBP). **Video Telephony Mode** has same paths with Loud Speaker Mode.

| Mode            | SPKMUTE | AMPCTRL |  |
|-----------------|---------|---------|--|
| Receiver        | High    | Low     |  |
| Headset         | High    | Low     |  |
| Loud Speaker    | Low     | High    |  |
| Video Telephony | Low     | High    |  |

#### **Table Speaker Phone Mode GPIO control state**

\* SPKMUTE; MARITA GPIO36 \* AMPCTRL; MARITA GPIO06

### 3.4.4.2 Voice Call Uplink Mode (Receiver, Speaker, Headset)

This section provides a detailed description of the Voice Call TX functions.

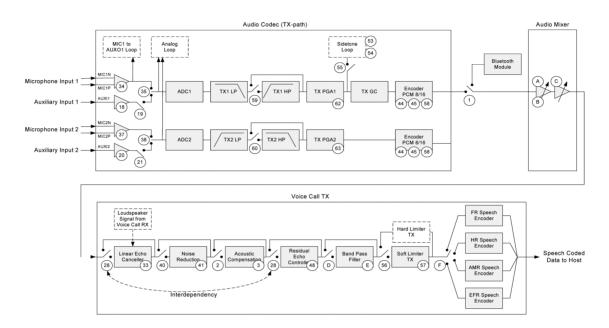


Figure. Voice call Uplink Scheme

The Uplink supports two microphones and two auxiliary inputs to the speech encoder blocks. Both microphone inputs are compatible with an electric microphone.

The VINCENNE internal voltage source (CCO) provides the necessary drive current for the electric microphone. The voltage source is via I2C programmable to supply 2.2V or 2.4V. But the voltage source of our Model is to supply 2.4V.

The auxiliary audio inputs can be used as an alternative source of speech, a source from an external microphone or as an analog loop connection. Figure shows that the audio inputs are fed to the transmit PGAs, which enables to adjust the total gain in the product for different sensitivities of the microphones and spread in the transmit paths. The ADCs are followed by the transmit band pass filters, which accept the maximum output swing that the microphone preamplifiers can deliver without clipping, and maintain a good signal-to-noise ratio. The high pass filter in the TX-paths can be disabled via I2C; still removing the DC offset from the signal. For one of the two transmit paths, a transmit gain control amplifier precedes the final encoding of the PCM output.

#### 3. TECHNICAL BRIEF

Each Voice Uplink Mode paths shown below.

Receiver Mode: C-MIC(OBG-15S44) → TJATTE2 IN (MICP/N) → TJATTE2 OUT

(MICP\_INT/MICN\_INT) → VICENNE Input(MIC1N/1P)

Loud Speaker Mode : C-MIC(OBG-15S44) → TJATTE2 IN (MICP/N) →

TJATTE2 OUT(MICP\_INT/MICN\_INT) → VICENNE Input(MIC1N/1P)

Video Telephony Mode : C-MIC(OBG-15S44) → TJATTE2 IN (MICP/N) → TJATTE2 OUT

(MICP\_INT/MICN\_INT) → VICENNE Input(MIC1N/1P)

**Headset Mode**: Headset MIC → EARJACK S/W(X2602, Pin Num 2) → TJATTE2 IN(ATMS\_CAP)

TJATTE2 OUT (ATMS\_INT) VICENNE Input(AUXI1)

When  $\mbox{the headset}$  is inserted,  $\mbox{GPA6}(\mbox{Circuit Diagram net Name})$  converted into low state.

So, the headset icon is displayed on Main LCD.

### 3.4.5 MIDI (Ring Tone Play)

This section provides a detailed description of the MIDI and WAV-file functions.

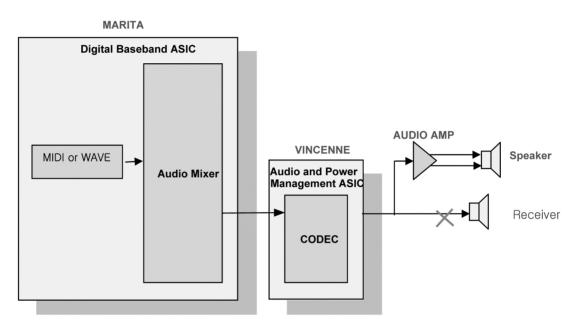


Figure. MIDI Scheme

External MIDI path is the same as Voice Loudspeaker downlink Mode, except source in MARITA (DSP and Audio Mixer).

MIDI : MARITA → PCM Decoder → Earphone amplifier → BEARP Port → Analog S/W(ADG702) →
AUDIO AMP(LM4894IBP) → Speaker(8Ω)

MIDI being played through external Device Speaker only. MIDI Mode control port shown below

| STATE(SPK ONLY) | SPKMUTE | AMPCTRL |  |
|-----------------|---------|---------|--|
| MIDI ON         | LOW     | High    |  |
| MIDI OFF        | High    | Low     |  |

**Tabel MIDI GPIO Control STATE** 

\* SPKMUTE; MARITA GPIO36 \* AMPCTRL; MARITA GPIO06

### 3.4.6 MP3 (Audio Player)

This section provides a detailed description of the MP3 file functions.

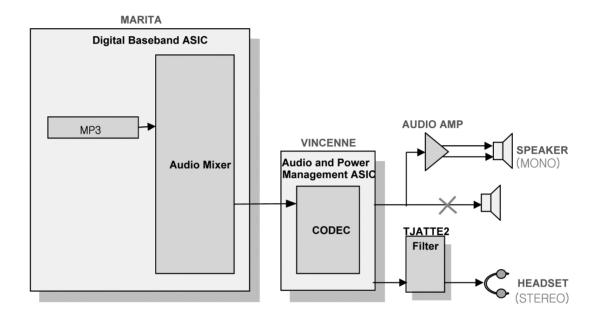


Figure. MP3 Scheme

MP3 function supports PCM 44/48KHz sampling rate. The PCM44/48 RX-path is intended to be used as a stereo music headphones. It is also possible to connect a differential load or to use the RX-path with only one channel running (mono).

In stereo mode, auxiliary outputs (AUXO1 and AUXO2) can be used to drive the headset.

In single channel mode (mono), BEARP can be used to drive a load (Speaker).

## 3.4.7 Video Telephony

This section provides a description of the Video Telephony functions.

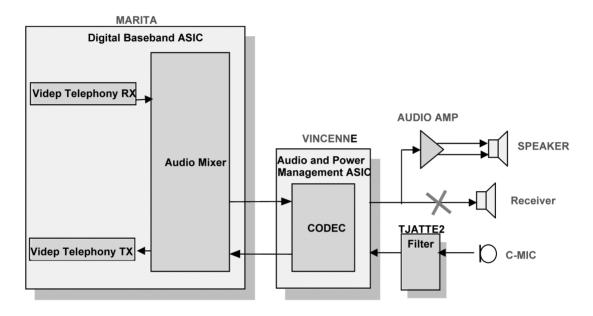


Figure. Video Telephony Scheme

Video Telephony Mode has same paths with Loud Speaker Mode.

| STATE(SPK ONLY)     | SPKMUTE | AMPCTRL |  |
|---------------------|---------|---------|--|
| Video Telephony ON  | LOW     | High    |  |
| Video Telephony OFF | High    | Low     |  |

**Tabel Video Telephony GPIO Control STATE** 

\* SPKMUTE; MARITA GPIO36 \* AMPCTRL; MARITA GPIO36

## 3.4.8 Audio Main Component

There are 6 components in U8100 schematic Diagram. Part Number marked on U8100 Schematic Diagram.

| N0 | ITEM          | Part Name  | Part Number |
|----|---------------|------------|-------------|
| 1  | Dual Speaker  | EMD1940A   |             |
| 1  | C-MIC         | OBG-15S44  | X2603       |
| 3  | Audio AMP     | LM4894IBP  | N2601       |
| 4  | TJATTE2       | IP4025CS20 | N2602       |
| 5  | Ear-JACK      | HSJ1730    | X2602       |
| 6  | Analog Switch | ADG702     | N2603       |

**Tabel Audio Component List** 

## **TJATTE2 Description**

The TJATTE2 is a 6-channel RC low pass filter array that is designed to provide filtering of undesired RF signals in the 800-2700 MHz frequency band.

In addition, the TJATTE2 incorporates diodes to provide protection to downstream components from Electrostatic Discharge (ESD) voltages as high as 8 kV.

| PIN | DESCRIPTION | PIN | DESCRIPTION | PIN | DESCRIPTION | PIN | DESCRIPTION |
|-----|-------------|-----|-------------|-----|-------------|-----|-------------|
| A1  | MICN        | B1  | GND         | C1  | CCO         | D1  | MICN-int    |
| A2  | MICP        | B2  | GND         | C2  | ATMS_AD     | D2  | MICP-int    |
| А3  | ATMS        | ВЗ  | GND         | СЗ  | GND         | D3  | ATMS-int    |
| A4  | ATMS-cap    | B4  | AFMS_R      | C4  | GND         | D4  | AFMS_R-int  |
| A5  | AFMS_L      | B5  | VDD         | C5  | GND         | D5  | AFMS_L-int  |

**Tabel TJATTE Pin Description** 

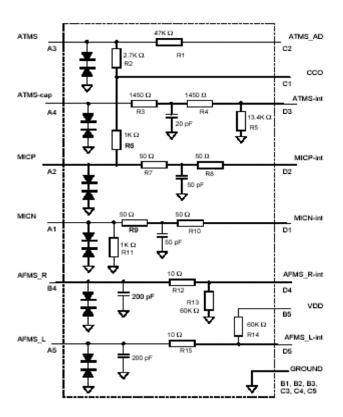


Figure. TJATTE2 Block Diagram

### 3.4.9 GPADC(General Purpose ADC) and AUTOADC2

The GPADC consists of a 14 input MUX and an 8-bit ADC. The analog input signal is selected with the MUX and converted in the ADC.

The GPADC has a built in controller, AUTOADC2, which is able to operate in the background without software intervention. The AUTOADC2 periodically measures the battery voltage or current. Figure shows the schematic of GPADC part. The GPADC channel spec is as following Table.

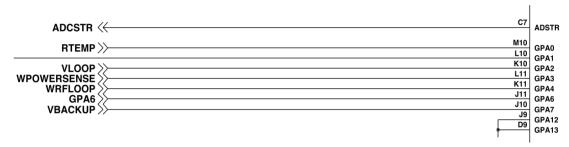


Figure. Schematic of GPADC and AUTOADC2

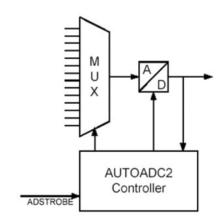


Figure. GPADC and AUTOADC2 Block diagram

| ADC 6 channels |             |                           |  |  |  |  |
|----------------|-------------|---------------------------|--|--|--|--|
| Resource       | Name        | Description               |  |  |  |  |
| GPA0           | RTEMP       | Radio temperature sense   |  |  |  |  |
| GPA2           | VLOOP       | Loop voltage sense        |  |  |  |  |
| GPA3           | WPOWERSENSE | Reference voltage for PAM |  |  |  |  |
| GPA4           | WRFLOOP     | Lock inform               |  |  |  |  |
| GPA6           | GPA6        | Headset detect            |  |  |  |  |
| GPA7           | VBACKUP     | Backup battery            |  |  |  |  |

Table. GPADC channel spec

### 3.4.10 Charger control

A programmable charger in AB2000 is used for battery charging. It is possible to set limits for the output voltage at CHSENSE- and the output current from DCIO via the sense resistor to CHSENSE-. The voltage at CHSENSE- and the current feed to CHSENSE- cannot be measured directly by the GPADC. Instead, the two measuring amplifiers translate these inputs to a voltage proportional to the input and within the range of the GPADC. Figure shows the schematic of charging control part.

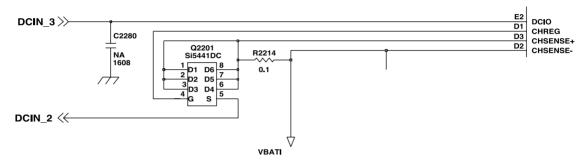


Figure. Schematic of charging control part

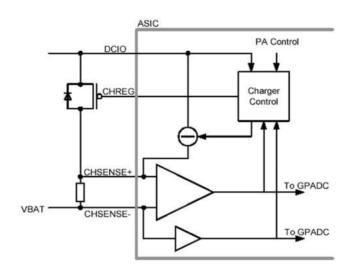


Figure. Battery charging block diagram

### 3.4.11 Fuel Gauge

AB2000 supports the measurement of the current consumption/charging current in the U8100 with a fuel gauge block. By constantly integrating the current flowing into and out of the battery, the fuel gauge block is used to determine the remaining battery capacity.

The function of the fuel gauge block is schematically described in Figure. A sense resistor R\_FGSENSE is connected in series with the battery. The voltage across the resistor, equivalent to the current entering/leaving the battery, is integrated using an ADC block.

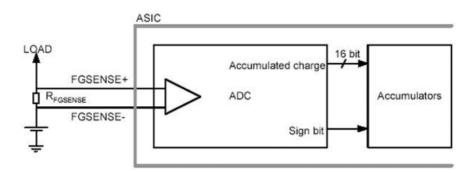


Figure. The analog front-end of the fuel gauge block

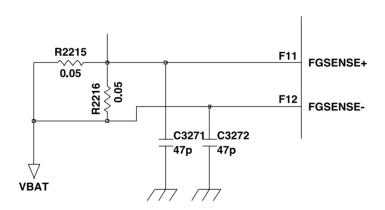


Figure. The Schematic of the fuel gauge block

| Name     | Туре   | Unused | Description                               |
|----------|--------|--------|---|
| FGSENSE+ | Analog | VBAT   | Fuel gauge current sensing input positive |
| FGSENSE- | Analog | VBAT   | Fuel gauge current sensing input negative |

Table. Fuel Gauge channel spec

### 3.4.12 Battery Temperature Measurement

The BDATA node, the constant current source, feed the battery data output while monitoring the voltage at the battery data node with GPADC. This battery data is converted to the battery temperature. Figure shows the schematic of battery temperature measurement part.

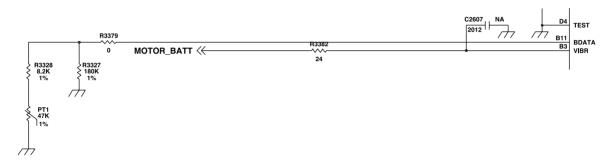


Figure. Battery Temperature Measurement

| Name  | Туре                 | Unused      | Description    |  |
|-------|----------------------|-------------|----------------|--|
| BDATA | Digital Input/Output | Unconnected | Current output |  |

**Table BDATA channel spec** 

### 3.4.13 Charging Part

The charging block in AB2000 processes the charging operation by using VBAT voltage. It is enabled or disabled by the assertion/negation of the external signal DCIO. Part of the charging block are activated and deactivated depending on the level of VBAT. Figure shows the schematic of charging part.

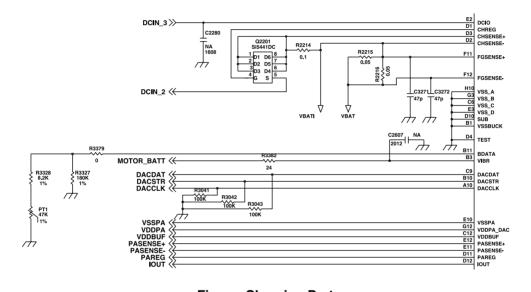


Figure. Charging Part

When VBAT is below a certain value, 3.2V, a current generator take care of initial charging of the CHSENSE+ node and internal trickle charge signal is active. This part of the charging block is powered on and active when DCIO is asserted. The DCIO signal is asserted when its voltage is above the voltage at VBAT. As soon as generator is turned off and all parts of the charging block are functional and active.

Battery block indication as shown in Fig

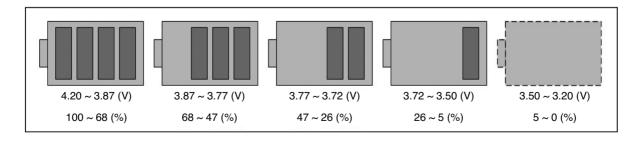


Figure. Battery Block Indication

#### Trickle charging

When the VBAT is below a certain value, 3.2V, a current generator take care of internal trickle charge signal is active. The charging current is set to 50mA.

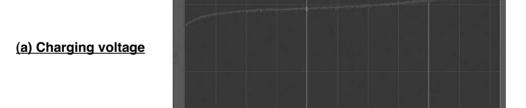
| Parameter       | Min | Тур | Max | Unit |
|-----------------|-----|-----|-----|------|
| Trickle current | 30  | 50  | 60  | mA   |

**Table BDATA channel spec** 

### **Normal charging**

When the VBAT voltage is within limits or the internal regulators are turned on, the current source for trickle charging is turned off and all parts of the charging block are active. The charging method is 'CCCV'. (Constant Current Constant Voltage)

This charging method is used for Lithium chemistry battery packs. The CCCV method regulates the charge current and the VBAT voltage. This charging method prevents the battery voltage to go above the charge set in the CCCV algorithm. This picture shows the charging voltage(a) and charging current change(b).



(b) Charging current

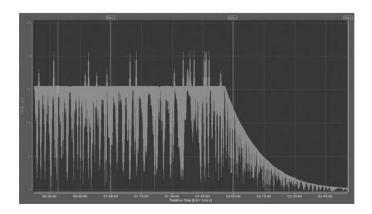


Figure. CCCV charging method

#### 3. TECHNICAL BRIEF

• Charging Method : CCCV (Constant Current Constant Voltage)

Maximum Charging Voltage: 4.2V
Maximum Charging Current: 600mA
Nominal Battery Capacity: 1200 mAh

Charger Voltage : 4.6VCharging time : Max 3.5h

Full charge indication current (icon stop current): 80mA
Low battery POP UP: Idle - 3.46V, Dedicated - 3.50V
Low battery alarm interval: Idle - 3 min, Dedicated - 1 min

• Cut-off voltage: WCDMA call - 3.1V, ELSE - 3.2V

### **Charging of Extended Temperature**

When the battery temperature is outside the normal charging specification, the battery voltage, VBAT, is maintained at 3.7V.

• Under 0 °C : Extended temperature

• From 0 °C to 55 °C : Normal charging temperature

• Over 55 °C : Extended temperature

## 3.5 Voltage Regulation

### 3.5.1 Internal Regulation

There are LDO (Low Drop Output) regulators and BUCK converter in AB2000 (Vincenne) chip. LDO regulators and BUCK converter generate the following voltages: 1.5V, 1.8V and 2.75V. The output of these LDOs supply VDD-A, VDD-B and VDIG with 2.75V. BUCK converter steps down the VBAT to 1.5V for VCORE and VRTC, and to 1.8V for VMEM voltage. The output of these LDOs and BUCK converter are as following Table. Figure shows the power supply of each module in U8100.

### 3.5.2 External Regulation

1.5V LDO - supply 1.5V for wanda core

2.8V LDO - supply 2.8V for IrDA

2.8V LDO - supply 2.8V for Camera

3.3V LDO - supply 3.3V for USB

4.5V DC-DC converter - supply 4.5V for LCD back light

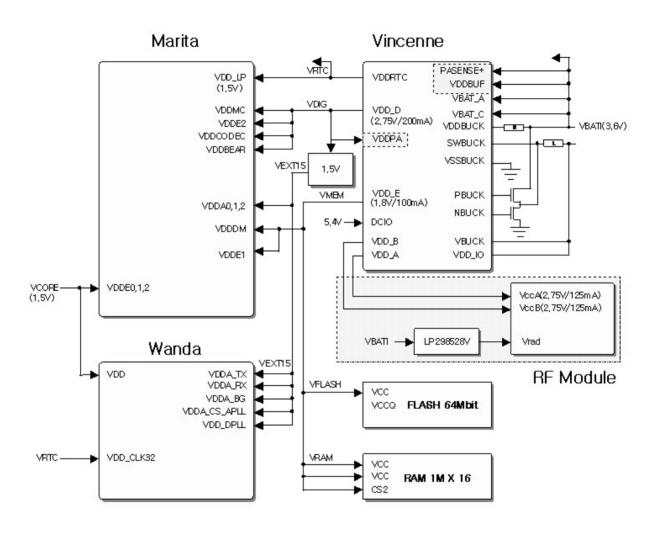


Figure. Power Supply Scheme

| Pin | Name    | Туре         | Output voltage | Description                  |
|-----|---------|--------------|----------------|------------------------------|
| B12 | VDD_A   | Power Supply | 2.75V          | Supply output                |
| A11 | VDD_B   | Power Supply | 2.75V          | Supply output                |
| M11 | VDD_D   | Power Supply | 2.75V          | Supply output                |
| L12 | VDD_E   | Power Supply | 1.8V           | Supply output                |
| L2  | VDDLP   | Power Supply | 1.5V           | Low Power supply output      |
| A2  | VDDBUCK | Power Supply | Unused: VBAT   | Buck converter switch supply |
| B1  | VSSBUCK | Power Supply | GND            | Buck converter switch ground |

**Table BDATA channel spec** 

## 3.6 General Description

The RF part includes a dual-band GSM/DCS part (900 and 1800MHz) and W-CDMA part for IMT-2000 (UL 1900MHz, DL 2100MHz). It also contains Antenna Switch, WCDMA duplexer, WCDMA Power Amplifier and GSM Power Amplifier.

The whole structure of Radio part is shown in Figure 3-1.

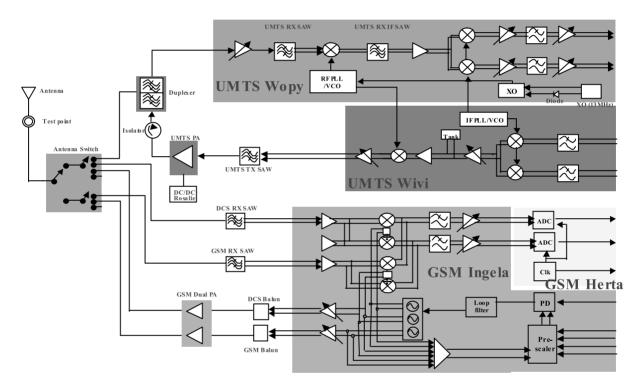


Figure 3-1. Block diagram of RF part

Starting at the antenna end, an antenna switch provides switching capability needed for three frequency bands (900, 1800 and 2100MHz). For the W-CDMA part, duplexer is included to facilitate the simultaneous transmission and reception required for the FDD mode.

The main components in the radio are Wopy (W-CDMA receiver ASIC), Wivi(W-CDMA transmitter ASIC), Ingela(GSM/GPRS transceiver) and two power amplifiers.

The mixed-signal circuit ASIC, Vincenne provides power supply for the main RF components.

The control flow for the Radio is shown in Figure 3-2.

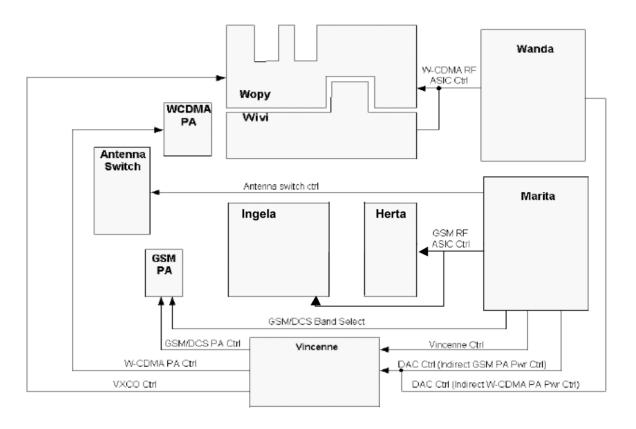


Figure 3-2. RF control signal flow diagram

The Marita(the main processor) controls the overall radio system. In the GSM/GPRS air interface mode, this control is handled via direct interfaces to individual RF components. The Marita(the main processor) also handles the antenna switch mechanism for selection of mode.

In the W-CDMA mode, the RF system is managed via the Wanda (WCDMA digital base-band coprocessor ASIC) and its DSP processor.

### 3.7 GSM Mode

#### 3.7.1 Receiver

The received RF signal on the antenna connector arrives via antenna switch at external band pass filters for band selectivity. One filter is required per supported GSM band. The corresponding LNA amplifies the signal for optimum noise suppression.

The LNA output signal is mixed with the on-channel LO generated by the proper VCO and transformed into a Q and an I signal. The I and Q signals are low pass filtered with two parallel high dynamic range filters.

Finally, the filtered I and Q signals are converted by a sigma-delta converter into two 13 Mbps digital bit streams by Herta(A/D converter), then fed to the Marita baseband ASIC.

#### A. Front end.

RF Front end consists of antenna, antenna switch(N1000), two RF SAWs(Z1100, Z1110) and dual band LNAs integrated in transceiver(N1100). The Received RF signals(GSM 925MHz ~ 960MHz, DCS 1805MHz ~ 1880MHz) are fed into the antenna or coaxial connector. An antenna matching circuit is between the antenna and the coaxial connector.

The Antenna Switch(N1000) is used to select the signal path, which is one of WCDMA, GSM RX, GSM TX, DCS RX, and DCS TX. The control signals VC1, VC2 and VCG of antenna switch (N1000) are connected to Marita baseband ASIC(D2000) to control the signal path. For example, when the GSM RX path is turned on, the received RF signal, which has passed through the antenna switch, is filtered by GSM RF SAW filter to suppress any unwanted signal except GSM RX band. The filtered RF signal is amplified by an LNA integrated in the transceiver IC(N1100) and is passed to a direct conversion demodulator. The process for DCS RX is also the same as GSM RX case.

The logic for antenna switch is given below Table 3-1.

|        | VC1         | VC2         | VCG         |
|--------|-------------|-------------|-------------|
| GSM TX | 0V          | 0V          | 2.8V ~ 3.0V |
| GSM RX | 0V          | 0V          | 0V          |
| DCS TX | 2.8V ~ 3.0V | 2.8V ~ 3.0V | 0V          |
| DCS RX | 0V          | 2.8V ~ 3.0V | 0V          |
| WCDMA  | 0V          | 0V          | 0V          |

Table 3-1. Antenna Switch logic

#### B. Receiver Block.

The circuit contains one frequency down-conversion section for each receive band and a common base band amplifier and filter section. The GSM900 RF part consists of a low noise amplifier followed by high dynamic range mixers.

The DCS 1800 RF part also has low noise amplifier connected to the other mixers.

The amplified RF signal is mixed with the quadrature local oscillator signal to create in-phase (I) and quadrature phase (Q) baseband signals. The I and Q signals are then buffered and low pass filtered. The same baseband circuitry is used for all bands.

Balanced signals are used for minimizing cross talk due to package parasitics. An impedance level at RF of 150 ohms for the GSM 900 input and 50 ohms for the DCS 1800 input is chosen to minimmize current consumption at best noise performance.

The low gain mode in GSM 900 is used in high input signal mode. There is no gain switch in DCS 1800.

Figure 3-3 shows a block diagram of the receiver block.

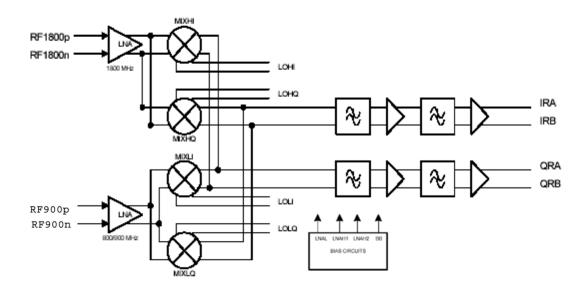


Figure 3-3. Block diagram of receiver part.

### C. LO Block

The LO signals from the receive VCO section drive the dividers for GSM 900 and DCS 1800 respectively to provide quadrature LO signals to the receive mixers. The LO signal is also supplied to the prescaler and transmit output buffer.

Figure 3-4 shows a block diagram of the LO block.

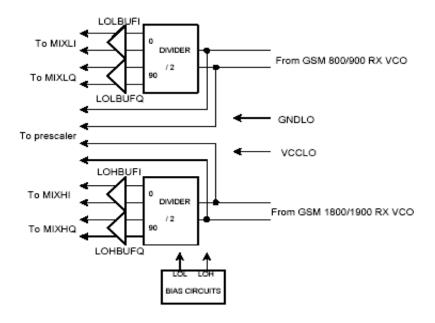


Figure 3-4. Block diagram of the LO part.

### D. VCO Block

The VCOs are fully integrated balanced LC oscillators with on-chip resonators. The receive VCOs run on double frequency.

Different frequency ranges can be selected in the VCOs for GSM/DCS band operation.

The VCOs are supplied from a separated external voltage regulator to avoid frequency pushing and up conversion of low frequency noise. A separate ground pin is also used as varactor ground reference to prevent DC voltage drop changes from affecting the VCO frequency.

Figure 3-5 shows a block diagram of the VCO block.

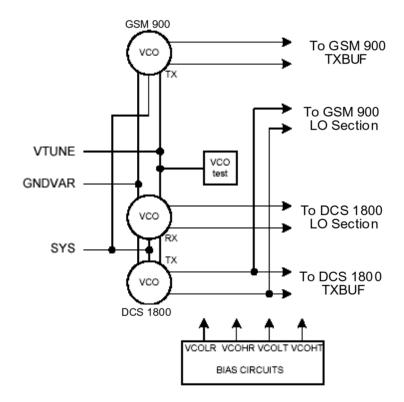


Figure 3-5. Block diagram of the VCO part.

### E. PLL Block

The PLL consists of a programmable prescaler with multiple division ratios and a phase and frequency detector with a charge pump with programmable output current. Channel frequency selection and transmitter modulation is controlled via the prescaler modulus inputs MODA ~ MODD and the prescaler offset value N offset. The MODA ~ MODD signals could be delayed 0, 5, 10 or 15 ns with MD bits to be synchronized with the XO signal.

Figure 3-6 shows a block diagram of the PLL block.

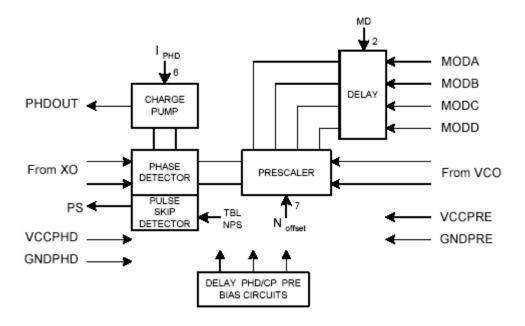


Figure 3-6. Block diagram of the PLL part.

#### 3.7.2 Transmitter

A 4-bit sigma-delta bit stream comes from the Marita ASIC including both channel information and the GMSK phase information. Via the 3-wire control bus also driven from Marita, the selection of transmitter band is made. The 4bits from the bit stream provides the fine-tuning of the division ratio before going to the divider of the used VCO (low band, 900MHz or high band, 1800MHz).

The modulated VCO signal is fed to the output buffer. One buffer is available for each of the low and high bands. Trimming capability is included for best match versus the PA used.

The GSM/GPRS transceiver, Ingela, output is passed to the dual-band PA that after amplification feeds the signal via a low pass filter to the antenna switch and further to the antenna.

The transmit block consists of two differential high power transmit output buffers with controllable output power. The modulated transmit signal from the VCO buffer is amplified to a level suitable to drive the external power amplifier. The buffer outputs are of open collector type and must be terminated into a suitable load.

Figure 3-7 shows a block diagram of the transmitter block.

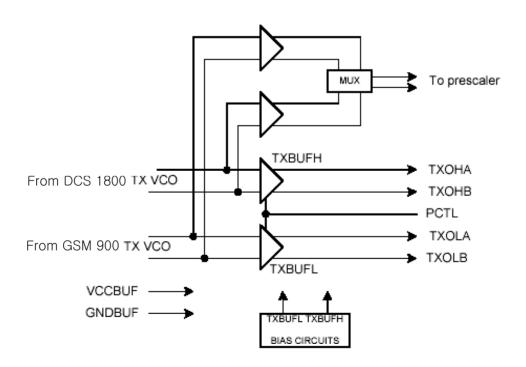


Figure 3-7. Block diagram for the transmitter.

## A. Power Amplifier

The Power Amplifier (N1300) is intended for use in EGSM and DCS/PCS mobile equipment. It is a module with two parallel amplifier chains, with one chain for the EGSM transmitter section and one for the DCS/PCS transmitter section. Each chain amplifies the RF signal from the respective transmitter to the antenna. The power amplifier supports class 10.

Band selection and the output power level of the RF amplifier are controlled by discrete signals Vband and Vapc respectively from the digital baseband controller ASIC.

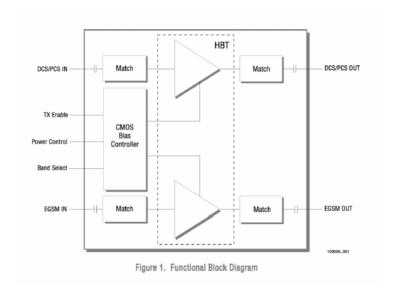


Figure 3-8. Block diagram of the Power Amplifier with Two Parallel chains.

#### 3.8 WCDMA Mode

#### 3.8.1 Receiver

The received RF signal on the antenna connector arrives via the antenna switch to the duplexer. The duplexer directs the signal to the LNA, which resides in Wopy (W-CDMA Receive ASIC) as every other active part of the radio receiver. The LNA has two different gain settings. From the output of the LNA, the signal is fed to the input of a RF SAW filter, and then appears at the differential output of the filter. The differential output of the RF SAW filter is connected to the differential mixer input, and the received signal is down-converted to a 190MHz IF frequency (with the RFLO signal) by the mixer.

At 190MHz, the signal is filtered in a differential (input and output) IF SAW filter, with the approximate bandwidth of 4MHz, and then again the signal is fed to Wopy (W-CDMA Receive ASIC), this time to the differential IF input, which also has a LNA.

From the 190MHz, the signal is mixed down to base-band I and Q which represented signals (using the IFLO signal). Finally the signals are filtered in low pass filters and amplified in base-band VGAs.

The I and Q represented signals appear at the output of Wopy (W-CDMA Receive ASIC) as differential voltages.

The large signal gain provided by the processing steps from the antenna down to base-band gives a DC offset at the outputs of Wopy (W-CDMA Receive ASIC). To eliminate this, there are DC-offset compensation loops included, one in the VGA of each of the I and the Q signals.

#### A. IFLO Section

The balanced IFLO signal from an external IFVCO drives the divider to provide qaudrature LO signals to the RxIF mixers. The LO buffers amplifies the signal to a suitable amplitude and DC level to drive the RxIF mixers.

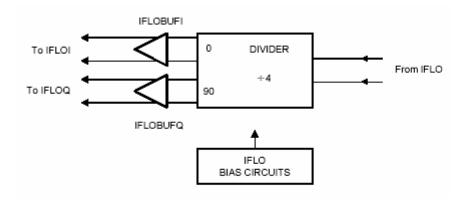


Figure 3-9. Block diagram of the IFLO section.

### **B. RFLO Section**

The VCO is a fully integrated balanced LC oscillator with on-chip resonator. An on-chip varactor is used to control the frequency over the desired tuning range.

A separate external voltage regulator supplies the VCO with power to avoid frequency pushing and up conversion of low frequency noise. A separate ground pin is also used as varactor ground reference to prevent DC voltage drop changes from affecting the VCO frequency. Via the serial interface, the VTUNE voltage can be set to VCC/2 to check the center frequency of the VCO. The PLL consists of a programmable prescaler with multiple division ratios and a phase and frequency detector with a charge pump with programmable output current. Channel frequency selection is set via the serial interface.

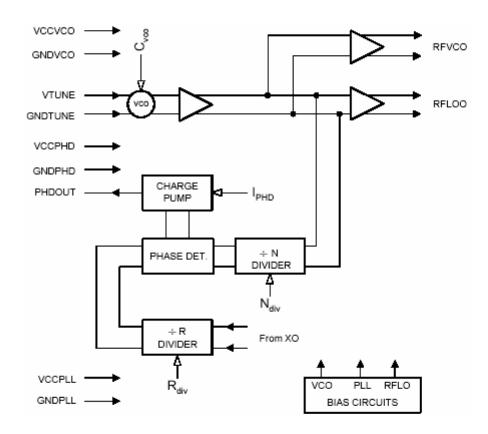


Figure 3-10. Block diagram of the RFLO section

## 3. TECHNICAL BRIEF

### C. Reference Section

The reference block consists of a balanced oscillator and a buffer amplifier. The crystal unit and the feedback capacitors are external. The current consumption when only the reference oscillator and the output buffer are activated must be kept to an absolute minimum.

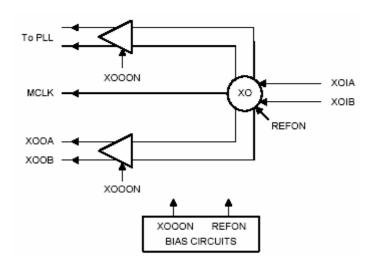


Figure 3-11. Block diagram of the Reference section.

### 3.8.2 Transmitter

Analogue differential signals (currents), representing I and Q, are sent to the radio ASCI Wivi (W-CDMA Transmitter ASIC) from the D/A converter in Wanda (W-CDMA digital base-band coprocessor ASIC). The signals are filtered in a reconstruction filter and then modulated up to 380MHz (using the IFLO signal). The signal is then amplified in a VGA and filtered in an external filter (an LC filter). After filtering, the signal is mixed to its final frequency (using the RFLO) and amplified in a differential output RF buffer with two different gain settings (high gain or low gain).

The differential RF signal is fed into a SAW filter with a single ended output, and is then amplified in a stand-alone RF buffer. After the RF buffer, the signal is filtered again in a SAW filter before it is fed to the PA (Power Amplifier).

In the PA the signal is amplified for the last time before leaving the radio. After the PA, the signal is sent through an isolator and through the duplexer, which directs the transmit signal to the antenna connector via the antenna switch.

The PA has variable supply voltage, which adapts itself by means of a control loop so that the linearity of the PA is kept constant. The variable supply voltage is provided from the battery through a DC/DC converter and a signal linearity detector sits at the PA output. The detected signal at the PA output is compared with a reference (supplied by the Vincenne, the mixed-signal circuit ASIC), and the error signal is used in a loop filter, which provides the control signal to the DC/DC converter.

#### A. Reconstruction Filters

The reconstruction filters consist of input buffers that provide the correct DC biasing for the preceding DAC in the digital baseband controller, and a low-pass filter for removing the unwanted high frequency components from the baseband input waveform.

The filter inputs are adapted for use with a current-source type of input signal.

#### B. IQ-modulator

The IQ-modulator receives the incoming I and Q analog baseband signals at baseband frequency and converts them to an intermediate frequency of 380MHz.

### C. Variable Gain Amplifier (VGA)

Comprising two cascaded variable gain amplifiers, the VGA-together with the RF mixer- controls the power of the transmitter.

The first of these two amplifiers, the so-called QVGA, enables fine-tuning of the transmitter by varying the gain in 0.25dB steps, that is 0/0.25/0.5/0.75dB. The second amplifier provides a 54dB gain range in 1 dB steps (54steps = 55 levels).

# D. IF Band Bass Filter (IFBP)

The IF filter suppresses spurious signals and eliminates unwanted frequency components generated in the IQ modulator and subsequently amplified in the VGA. The filter is tuned using an external RLC load as shown in Figure 3-12.

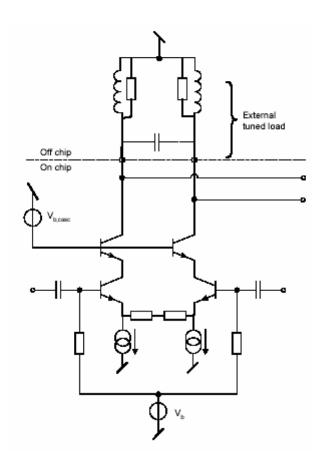


Figure 3-12. Principle Schematic of the IFBP.

#### E. RF Mixer and Buffer

The RF mixer converts the signal output from the IF BP filter from an intermediate frequency (IF) to the final radio frequency (RF). The mixer can be switched between three different gain levels: high gain (HG), medium gain (MG), and low gain (LG).

The LO buffer provides the buffering for either an internal LO signal generated within the internal RFPLL, or an external LO signal applied to the RFLO/RFLOBAR pins. External DC blocking is necessary for the external LO signal.

The RF buffer is used to drive an external PA stage. The buffer is of an open-collector design. The gain switching together with the VGA amplifier at IF will enable an output power control in 0.25 dB steps over no less than 80dB.

The programmable bias in the high and mid-gain settings is specified as a reduction of bias current from the maximum bias condition. It should achieve a reduction of bias current from the nominal value of 17mA to 3mA (signal ended) in 7 steps.

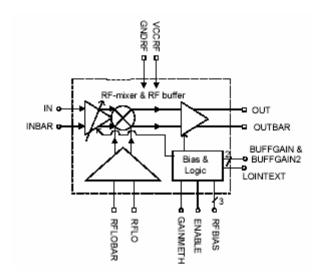


Figure 3-13. Block Diagram of RF Mixer and Buffer.

## F. Power Amplifier

The N1630(RF9266) is a high-power, high-efficiency linear amplifier module targeting W-CDMA transmitter ASIC. The module is fully matched to 50( for easy system integration and utilizes advanced GaAs HBT process technology. The PA features an integrated RF power output detection network and is compatible with DC-DC converter operation in DC power management applications. Additionally, a variable bias-current allows the idle current to be adjusted for optimum performance at a given RF output power.

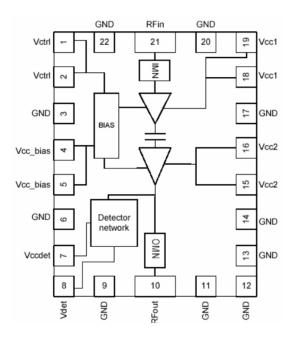


Figure 3-14. Block Diagram of W-CDMA power amplifier.

### 3.8.3 Frequency Generation

The Wopy (W-CDMA Receive ASIC) contains the active elements for a 13MHz VCXO, which is designed to be the reference frequency of the UE.

There are two synthesizers in the W-CDMA part of the radio, an intermediate frequency (IF) synthesizer and a radio frequency (RF) synthesizer. They generate the Intermediate Frequency Local Oscillator (IFLO) and Radio Frequency Local Oscillator (RFLO) signals. Both synthesizers are used in both the transmitter and the receiver, which gives the radio a fixed duplex distance of 190MHz.

The RF synthesizer is in the Wopy (W-CDMA Receive ASIC), except for the loop filter, which is external. The 13MHz clock is used as the reference, and the phase detector frequency is 200kHz. The programmable divider makes the RF synthesizer cover the 2300~2360MHz band.

The IF synthesizer is in the Wivi (W-CDMA Transmitter ASIC), except for the loop filter. The 13MHz is used as the reference, and the phase detector frequency is 1MHz. The IF VCO runs at 1520MHz given that the (programmable) reference divider is set to 13.

The synthesizers are controlled by Wanda (W-CDMA digital base-band coprocessor ASIC) via the serial bus to Wivi (W-CDMA Transmitter ASIC) and Wopy (W-CDMA Receive ASIC).

### A. IF PLL

The IF LO frequency synthesis comprises the four following parts:

- Input buffer: A 13MHz input buffer with DC-biasing provided at source.
- VCO: Operating on 1.52GHz which is 4times the TX-IF frequency (380MHz) and 8 times the RX-IF (190MHz), this is a fully integrated balanced LC oscillator with on-chip resonator. On-chip varactor are used to tune the VCO frequency.
- Prescaler
- Phase-detector with charge pump

For maintaining check on the VCO center frequency, the tuning voltage is set to Vcc/2. External DC blocking capacitors must be used on the IFLO/IFLOBAR signals.

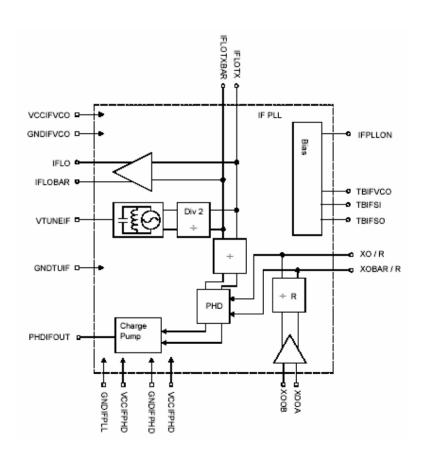
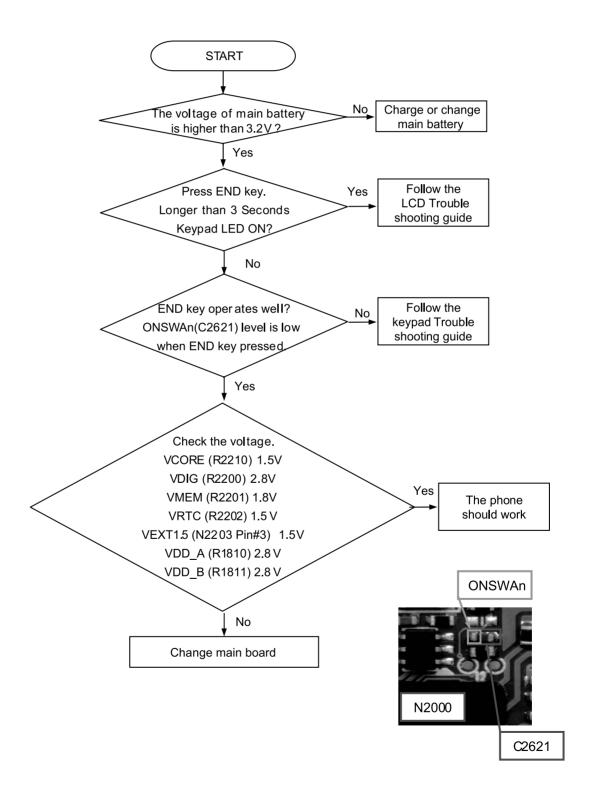
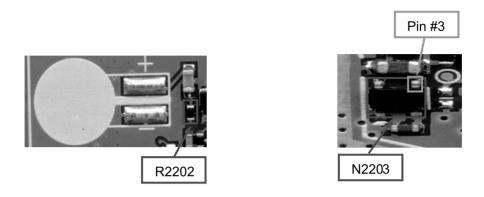


Figure 3-15. Block Diagram of Frequency Synthesizer Part(IF PLL).

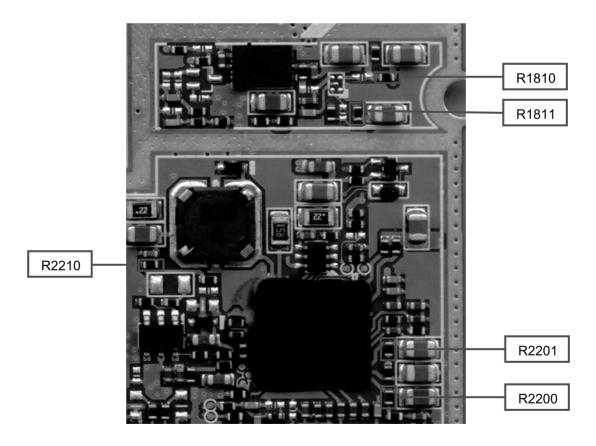
# 4. TROUBLE SHOOTING

## **4.1 Power ON Trouble**



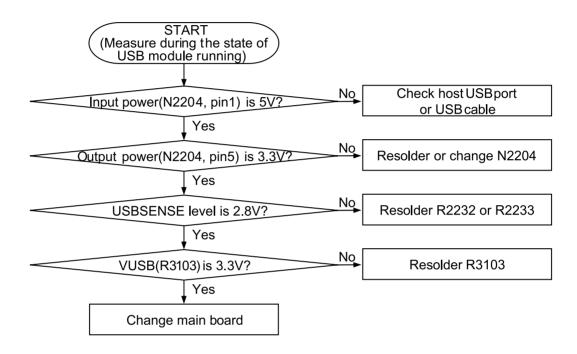


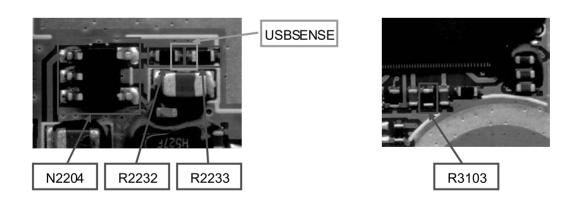
< Main Board - Top side >



< Main Board - Bottom side >

# 4.2 USB Trouble

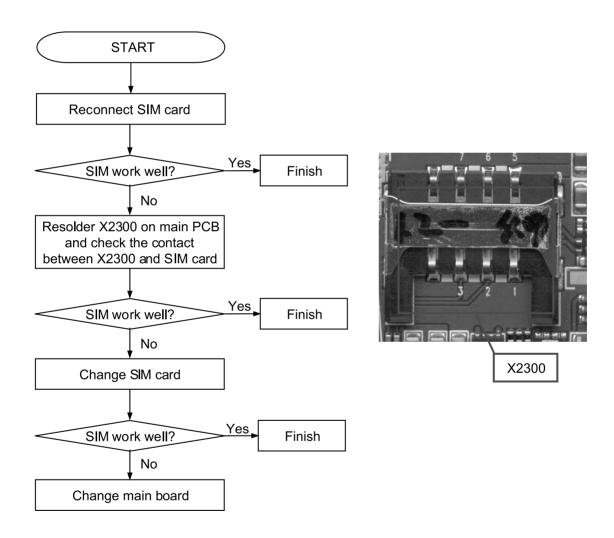




# **4.3 SIM Detect Trouble**

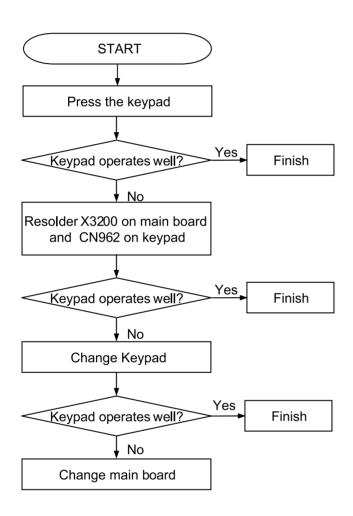
### · SIM control path

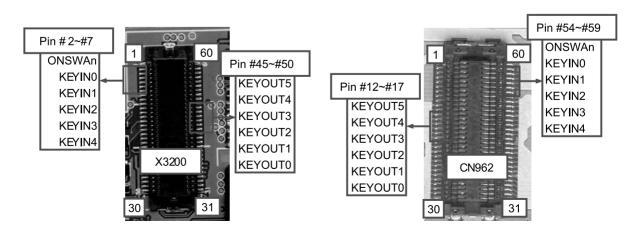
- MARITA generates SIM interface signals(2.75V level) to VINCENNE.
- Vincenne converts SIM interface signals to 1.8V/3V.



# 4.4 Keypad Trouble

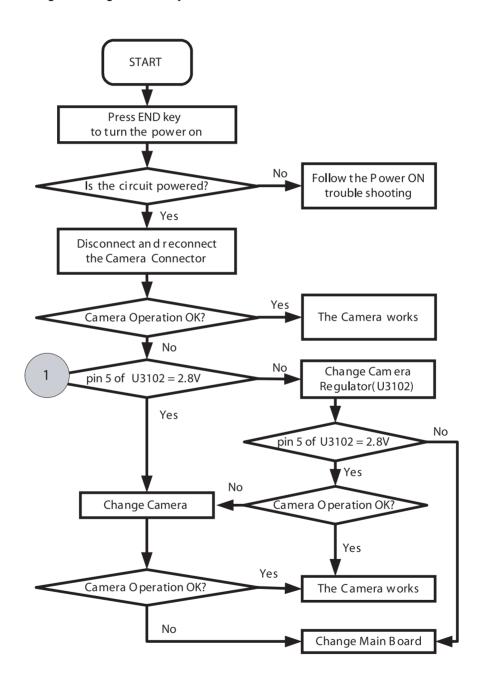
• Keypad signals go to MARITA and VINCENNE through board-to-board connector.



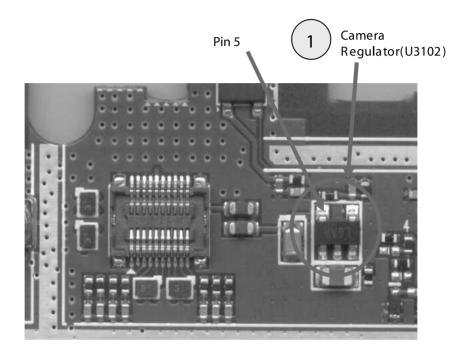


# 4.5 Camera Trouble

Camera control signals are generated by Marita

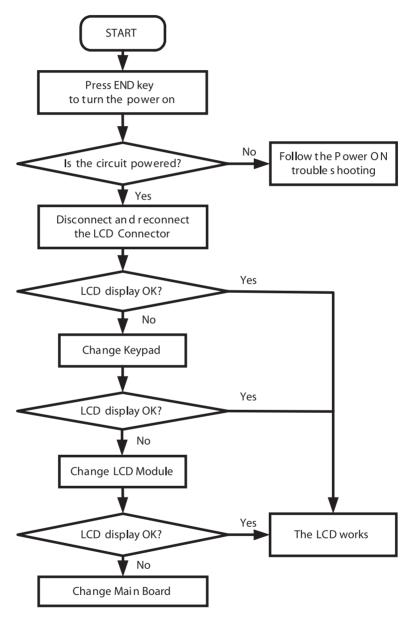


# Camera control signals are generated by Marita



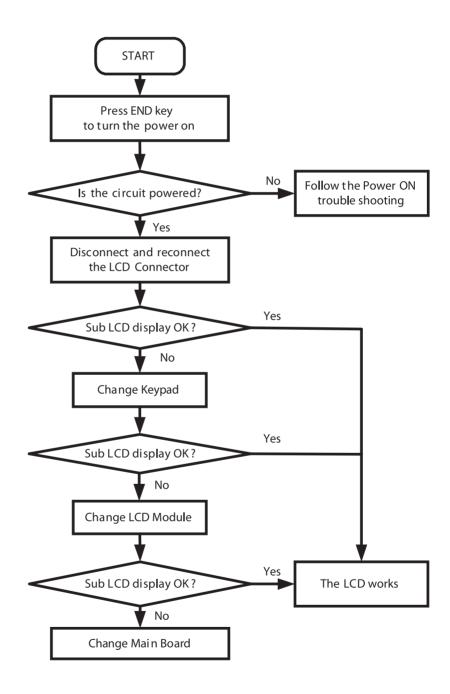
# 4.6 Main LCD Trouble

LCD control signals are generated by Marita.

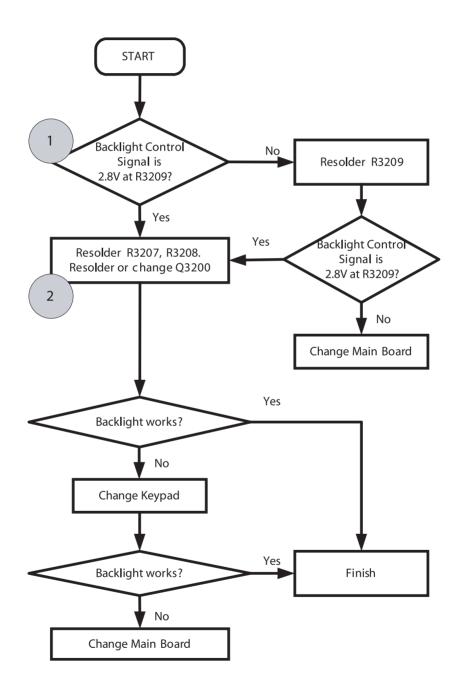


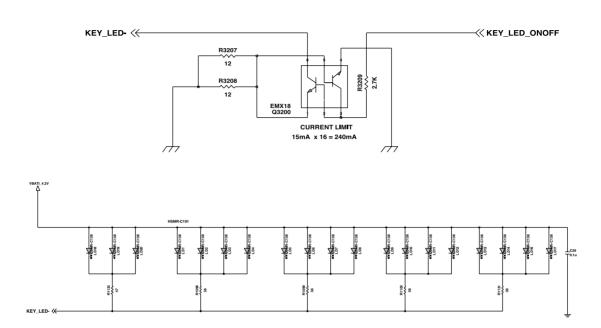
LCD control signals are generated by Marita.

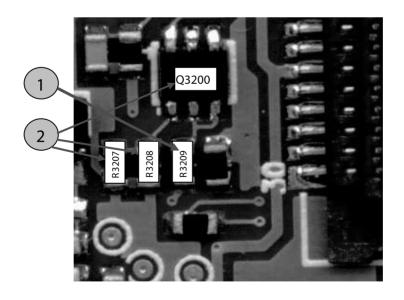
# 4.7 Sub LCD Trouble



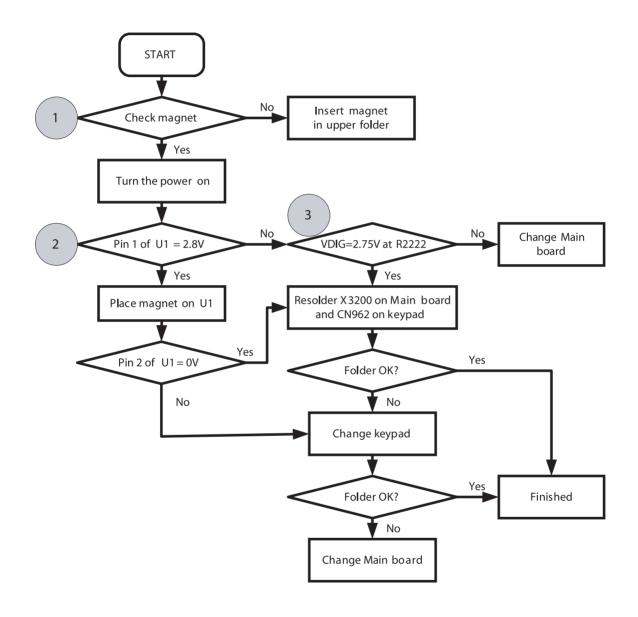
# 4.8 Keypad Backlight Trouble

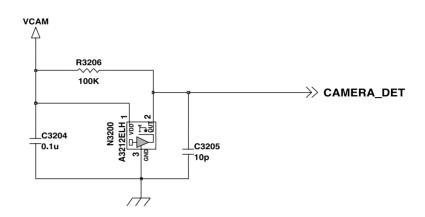


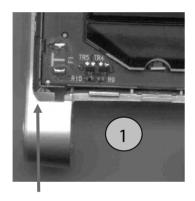




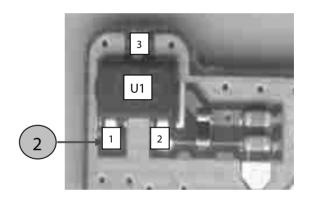
# 4.9 Folder ON/OFF Trouble

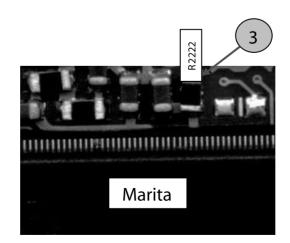




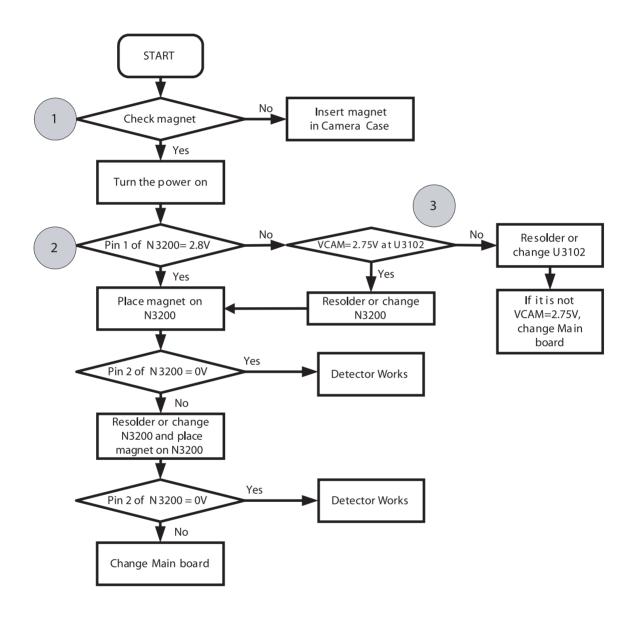


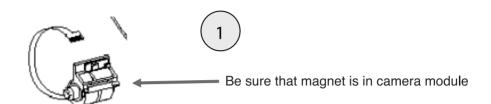


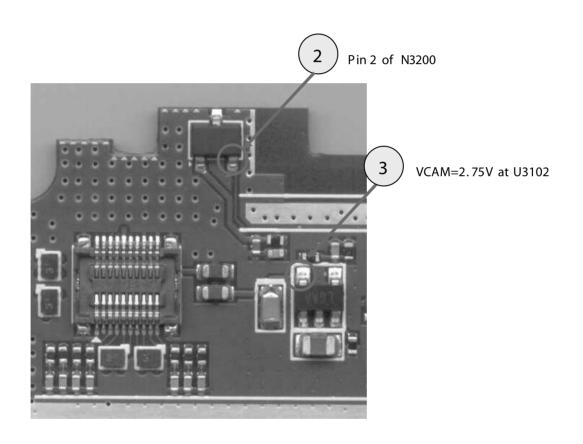




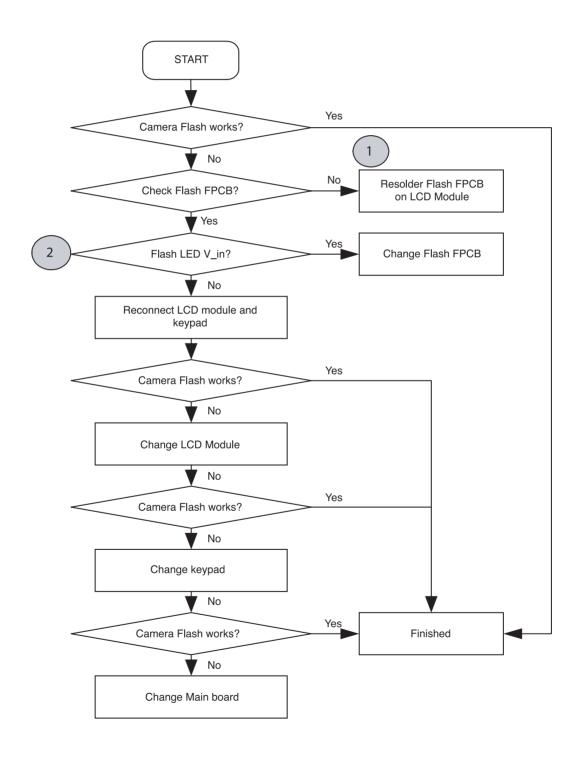
# **4.10 Camera Detection Trouble**

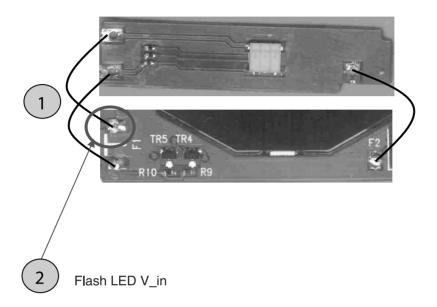






# 4.11 Camera Flash Trouble

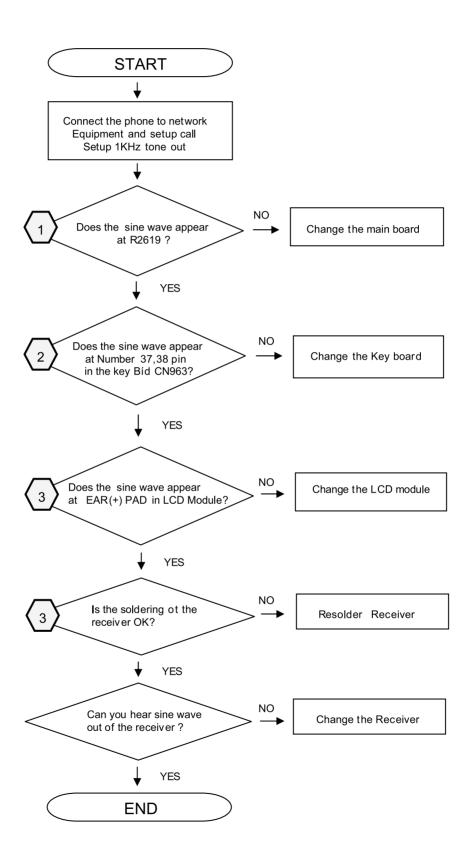


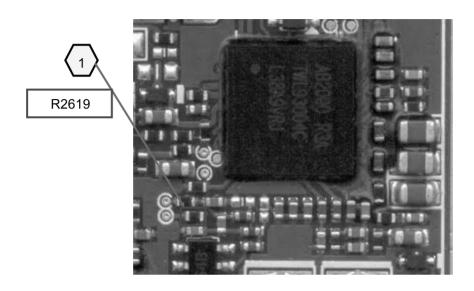


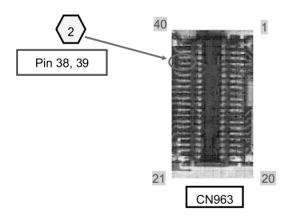
# **4.12 Audio Trouble Shooting**

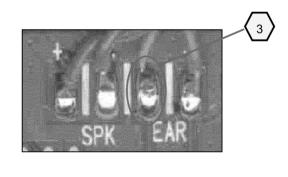
### A. Receiver

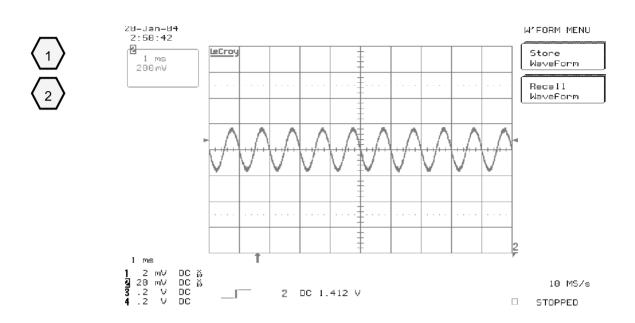
- · Signals to the receiver
  - Receiver signals are generated at Vincenne
    - BEARP, BEARM
  - Receiver path:
    - 1. Vincenne (BEARP, BEARM) ->
    - 2. X3200 on main board ->
    - •3. CN962 on key PCB ->
    - 4. CN963 on key PCB ->
    - •5. LCD Module ->
    - 6. Receiver
- Note: It is recommanded that engineer should check the soldering of R, L, C along the corresponding path before every step.



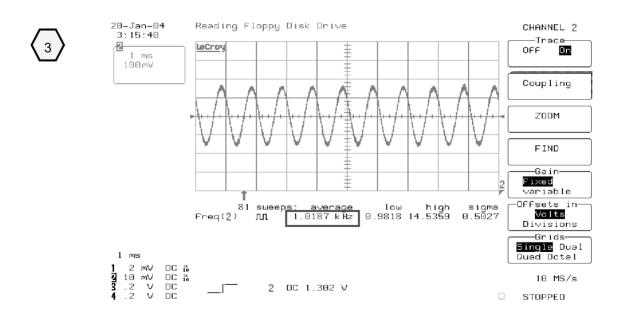








#### Measured 1khz Sine Wave Signal

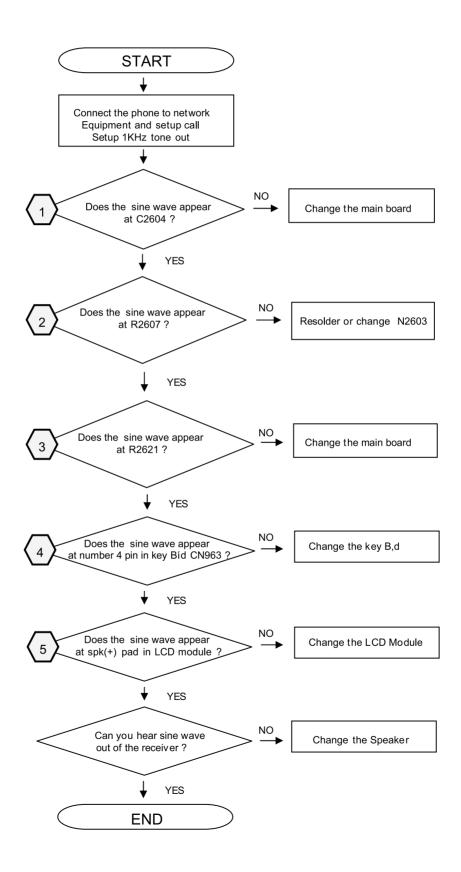


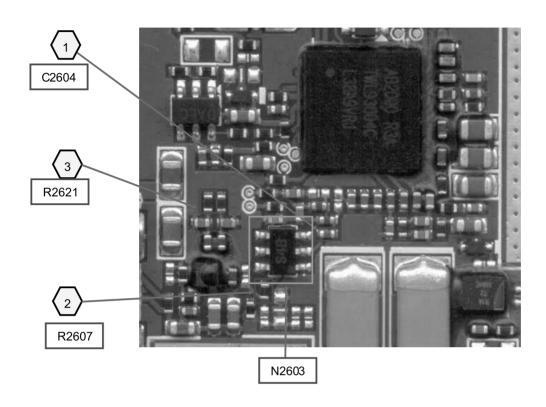
Measured 1khz Sine Wave Signal

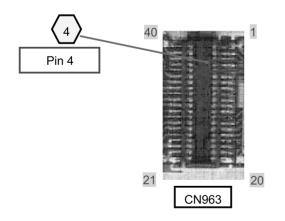
### 4. TROUBLE SHOOTING

### B. Speaker (Voice Loud Speaker, Midi, MP3, Key Tone)

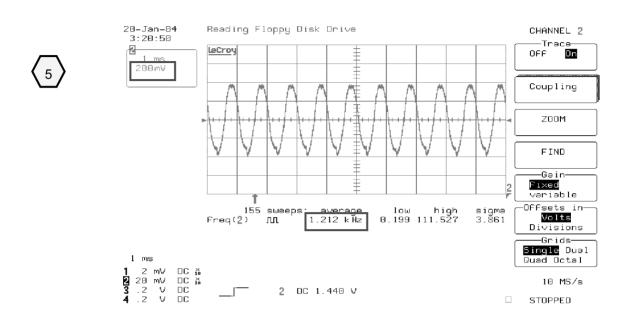
- · Signals to the speaker
  - Speaker signals are generated at Vincenne
    - BEARP
  - Speaker path:
    - •1. Vincenne (BEARP) ->
    - 2. C2604 on main board ->
    - •3. N2603(ADG) on main board ->
    - 4. N2601(Audio Amp) on main board ->
    - •5. CN963 on key PCB ->
    - 6. LCD Module ->
    - 7. Speaker
- Note: It is recommanded that engineer should check the soldering of R, L, C along the corresponding path before every step.









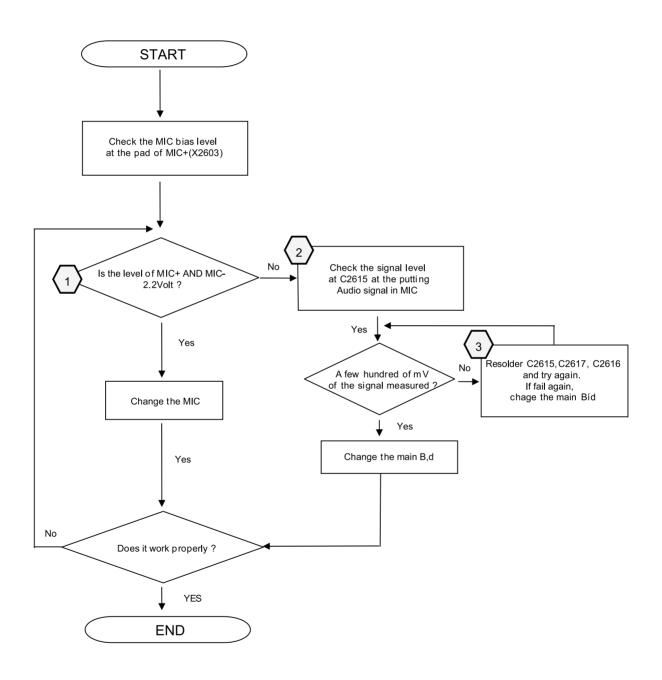


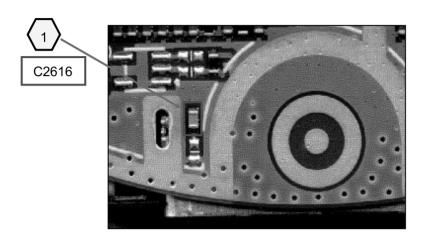
Measured 1khz Sine Wave Signal

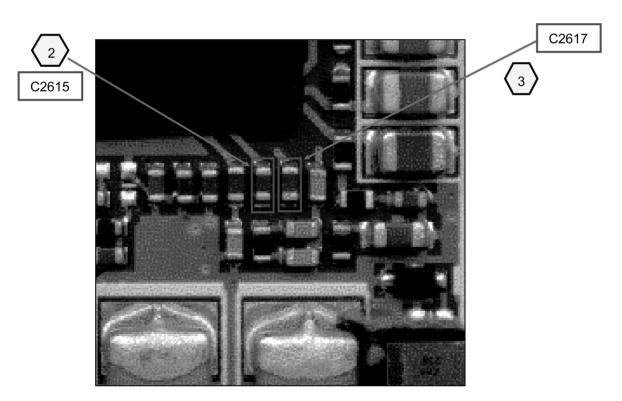
### 4. TROUBLE SHOOTING

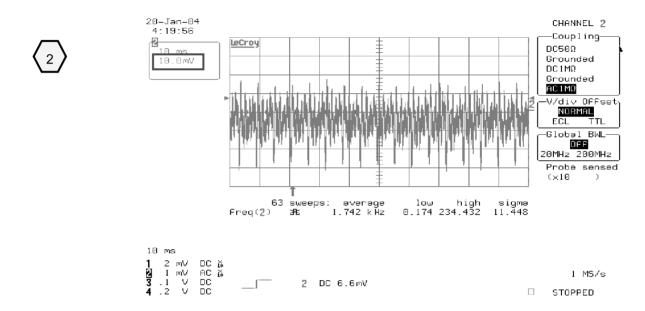
# C. Microphone (Voice call, Voice Recorder, Video Recorder)

- · Microphone Signal Flow
  - MIC is enable by MIC Bias
  - MICBAS, MICIP, MICIN signals to ABB (Vincenne)
- Check Points
  - Microphone bias
  - Audio signal level of the microphone
  - Soldering of components
- · Signal from the mic
  - MIC ->
  - N2602(TJATTE2) on main board ->
  - C2615 on main board ->
  - Vincenne



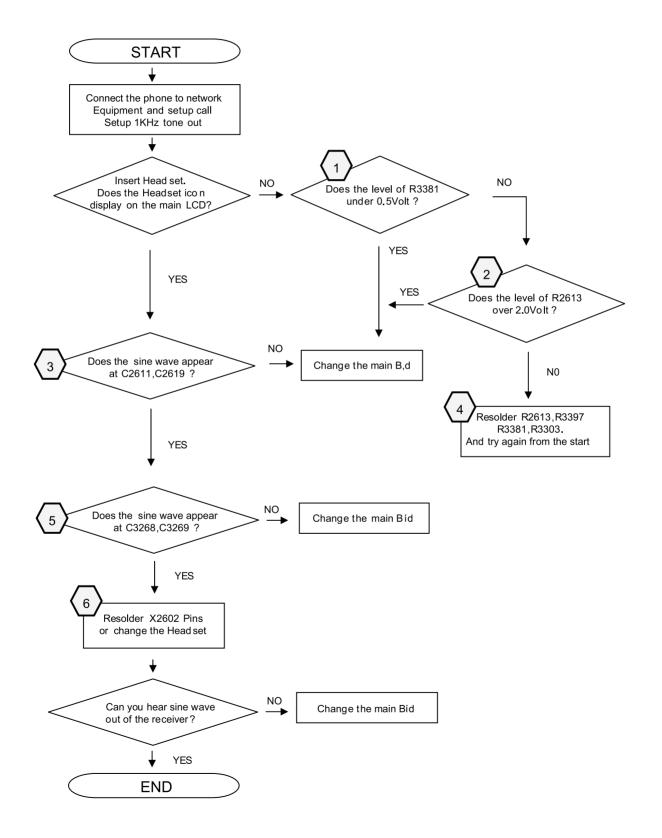




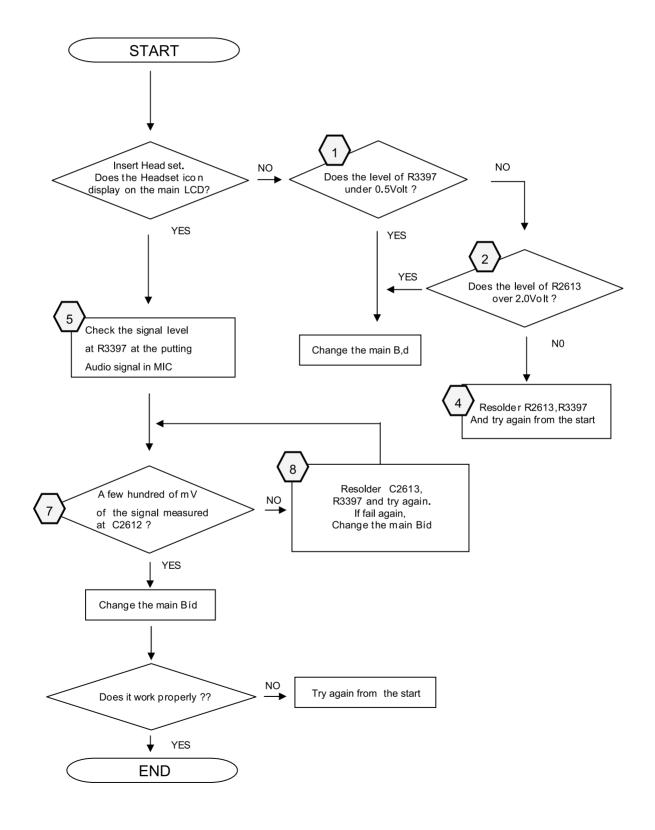


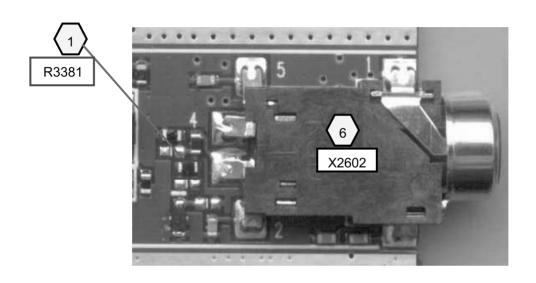
**Measured Some Noise Signal** 

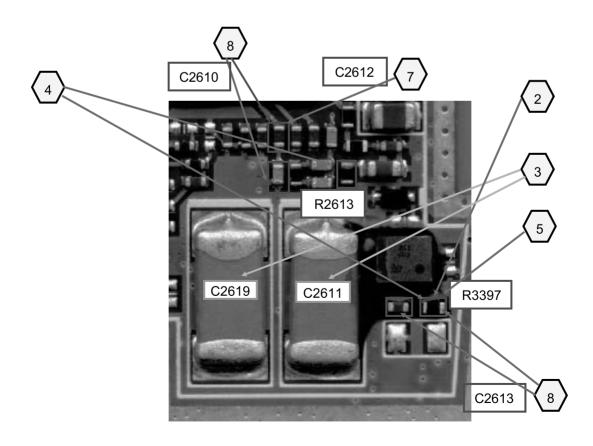
# D. Headset Receiver (Voice call, Video Telephony, MP3)



# E. Headset MIC(Voice call, Video Telephony)







### 4.13 Charger Trouble Shooting

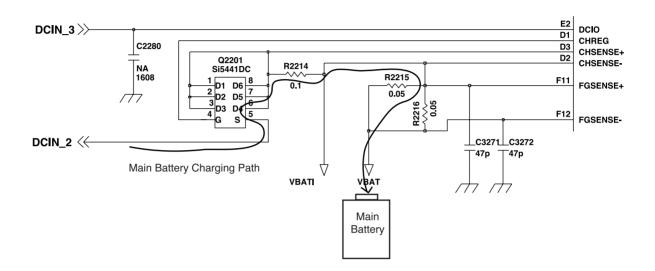


Figure. 13. Main Battery Charging Path

### · Charging Procedure

- Connecting TA and Charger Detection
- Control the charging current by AB2000(Vincenne)
- Charging current flows into the battery

#### · Check Point

- Connection of TA
- Charging current path
- Battery

#### Trouble shooting setup

- Connect TA and battery to the phone

#### Trouble Shooting Procedure

- Check the charger connecter
- Check the Charging current Path
- Check the battery

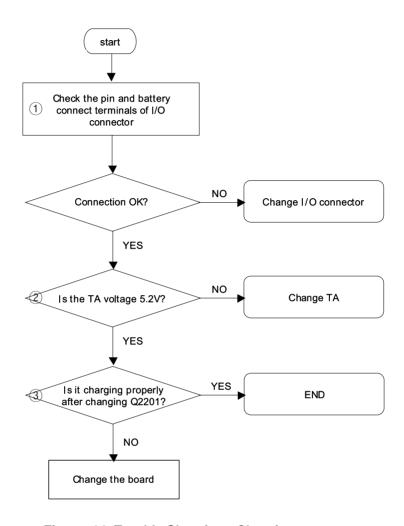


Figure. 14. Trouble Shooting - Charging

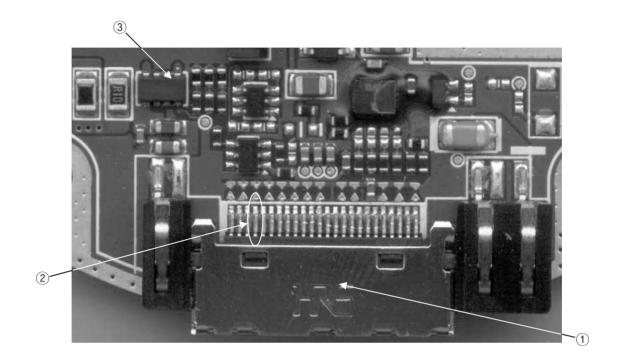


Figure. 15. Main Board - I/O connector and FET

# **4.14 RF Component**

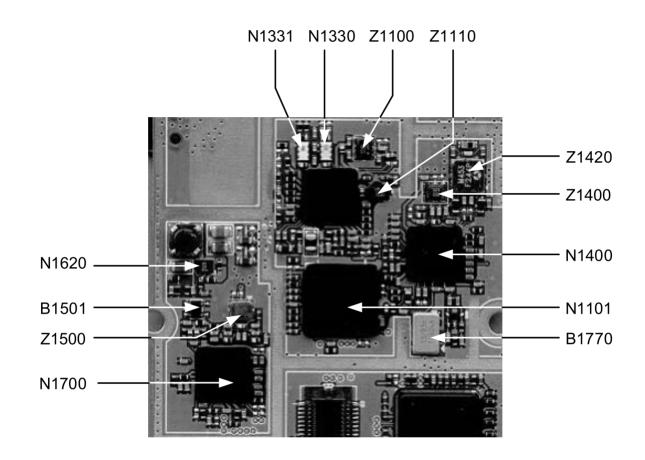


Figure 4-1. RF component (Top)

| Reference | Description        | Reference | Description     |  |
|-----------|--------------------|-----------|-----------------|--|
| B1501     | Temperature Sensor | N1700     | WCDMA TX IC     |  |
| B1770     | Crystal            | Z1100     | DCS RX SAW      |  |
| N1101     | GSM ADC            | Z1110     | GSM RX SAW      |  |
| N1330     | GSM TX Balun       | Z1400     | WCDMA RX RF SAW |  |
| N1331     | DCS TX Balun       | Z1420     | WCDMA RX IF SAW |  |
| N1400     | WCDMA RX IC        | Z1500     | WCDMA TX RF SAW |  |
| N1620     | DC/DC Convertor    |           |                 |  |

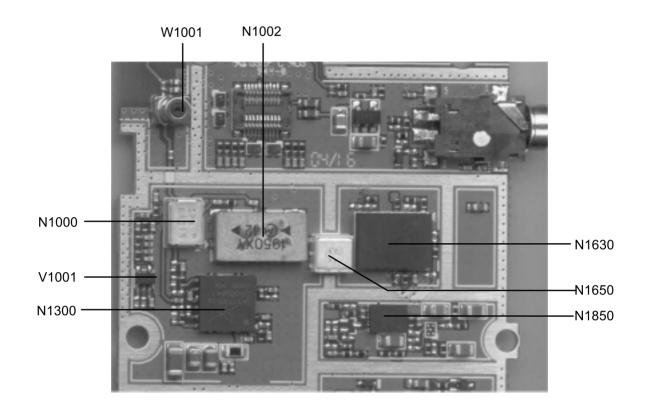
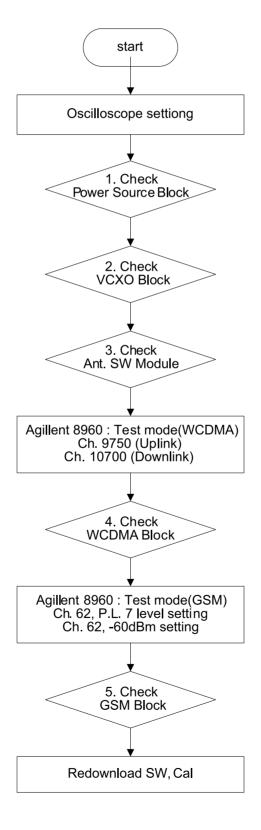


Figure 4-2. RF component (Bottom)

| Reference | Description Reference |                  | Description |
|-----------|-----------------------|------------------|-------------|
| N1000     | Ant. SW Module        | N1650            | Isolator    |
| N1002     | Duplexer              | N1850            | Regulator   |
| N1300     | GSM PAM               | V1001            | Transistor  |
| N1630     | WCDMA PAM             | M W1001 Test Cor |             |

### 4.15 Procedure to check



# **4.16 Checking Common Power Source Block**

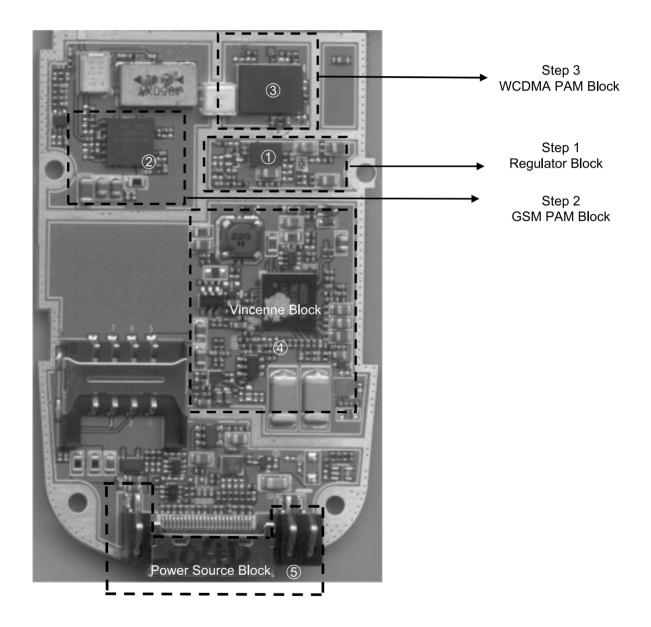


Figure 4-3. Common Source Block(Bottom)

### 4.16.1 Step 1

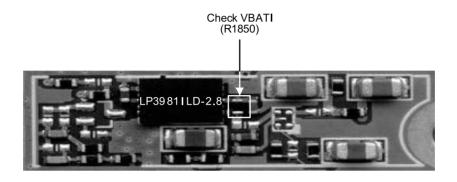
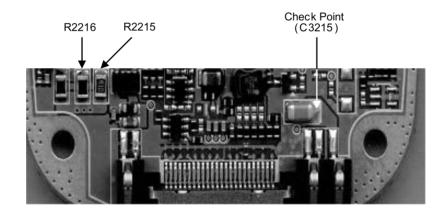


Figure 4-4. Regulator Block ①

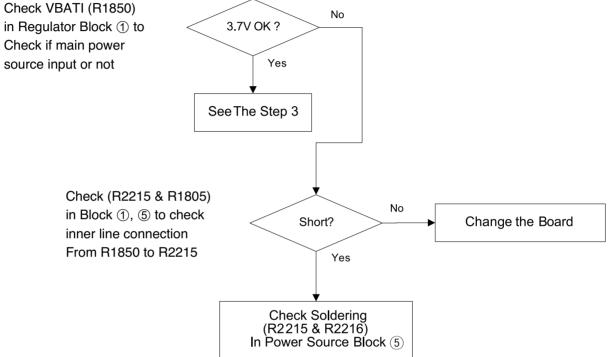


Step 1 Figure 4-5. Power Source Block ⑤ Check Point (C3215) in Power Source Block ⑤ To Check Power source Check Soldering (C3215) No 3.7V OK? Resddering to Check if main power source input or not Yes Change the Board Check Point (R2215) in Power Source Block (5) To Check Power source 3.7V OK? Short? Change the Board Yes Yes Check (C3215 & R2215) in Block (5)
to check inner line connection
From R1805 to R2215 Check Soldering (R2215 & R2216) In Power Source Block See The Step 2

# 4.16.2 Step 2

Step 2 Check VBATI (R1850)

Check if main power source input or not



### 4.16.3 Step 3

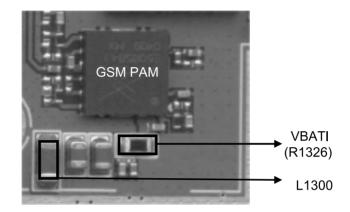
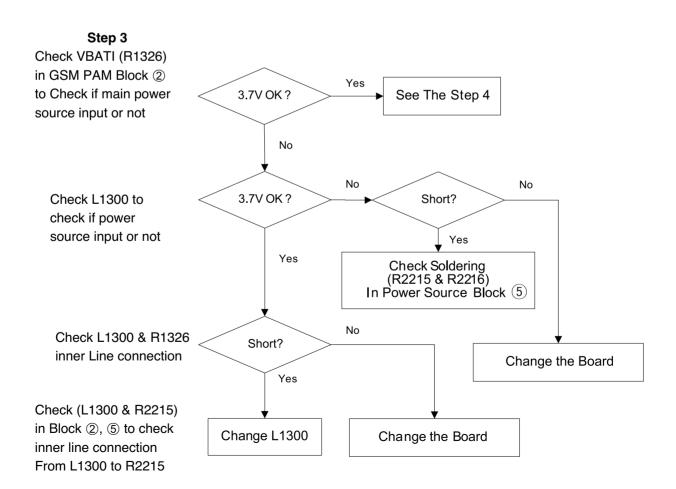


Figure 4-6. GSM PAM Block ②



# 4.16.4 Step 4

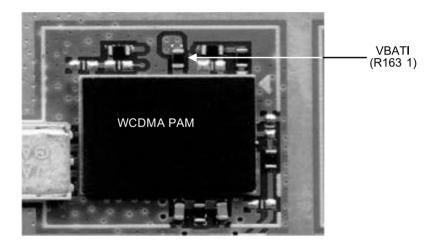


Figure 4-7. WCDMA PAM Block ③

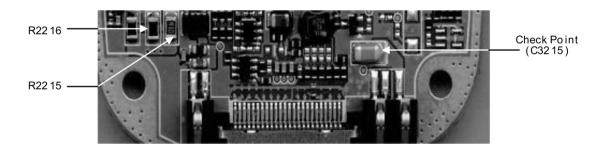
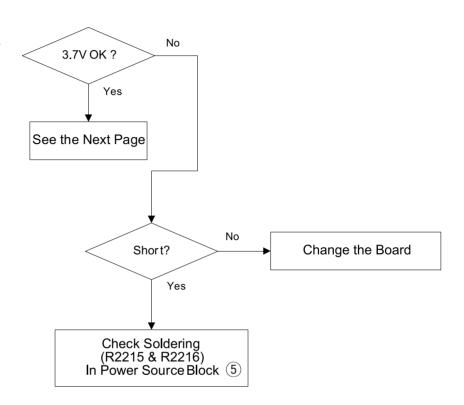


Figure 4-7-1. PAM-Power Source

Step 4
Check R1631 in WCDMA
PAM block



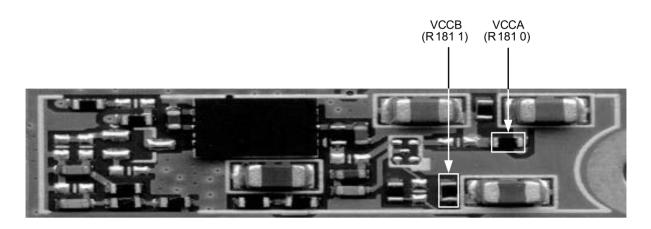
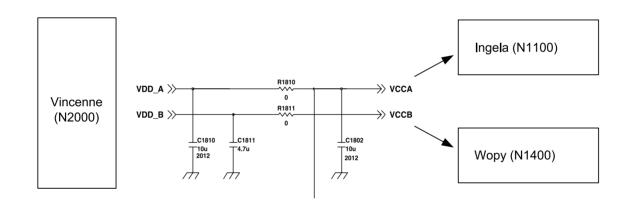
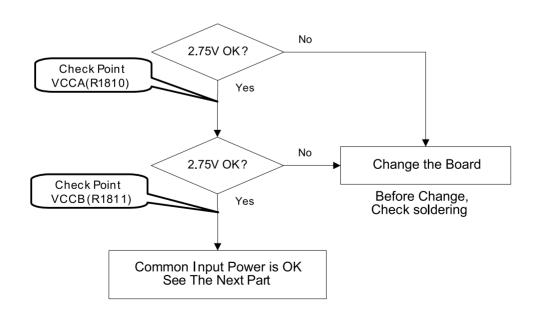


Figure 4-8. Power for Radio ASIC





## 4.16.5 Checking Regular Part

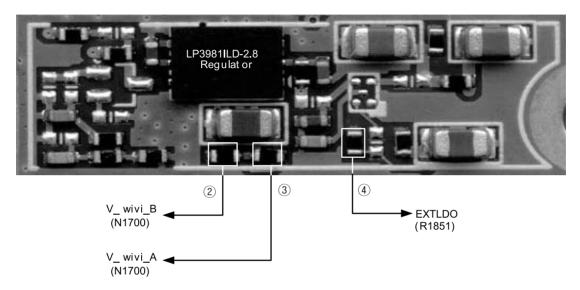


Figure 4-9. Regulator Block

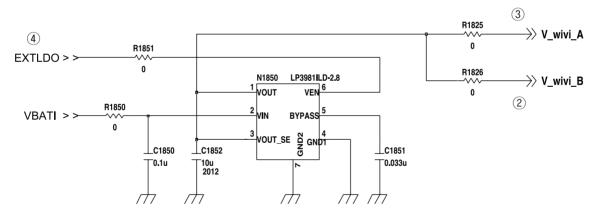
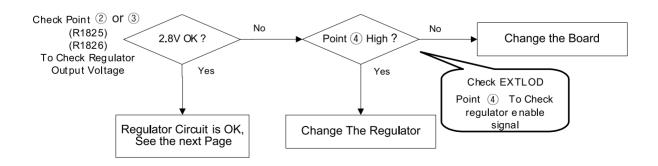


Figure 4-10. Regular Circuit Diagram



# 4.17 Checking VCXO Block

The reference frequency (13MHz) from B1770 (Crystal) is used WCDMA TX part, GSM part and BB part. Therefore you have to check below 4 point.

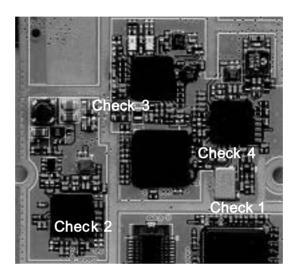


Figure 4-12. Top Place

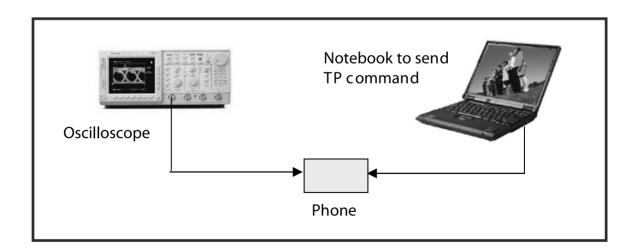


Figure 4-13. Connection for Checking VCXO Block

#### Check 1. Crystal part

If you already check this crystal part, you can skip check 1.

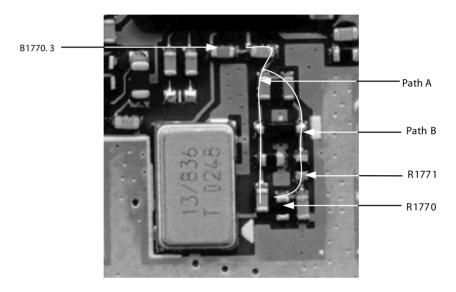


Figure 4-14. Test Point (Crystal Part)

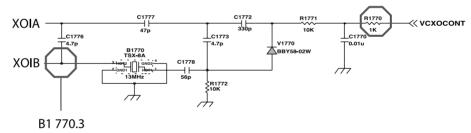


Figure 4-15. Schematic of the Crystal Part

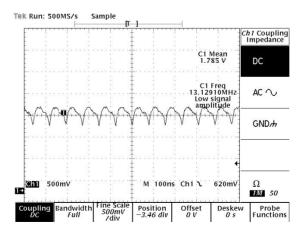


Figure 4-16. 13MHz at B1770.3

Check 2,3 13MHz at WCDMA TX part and GSM part

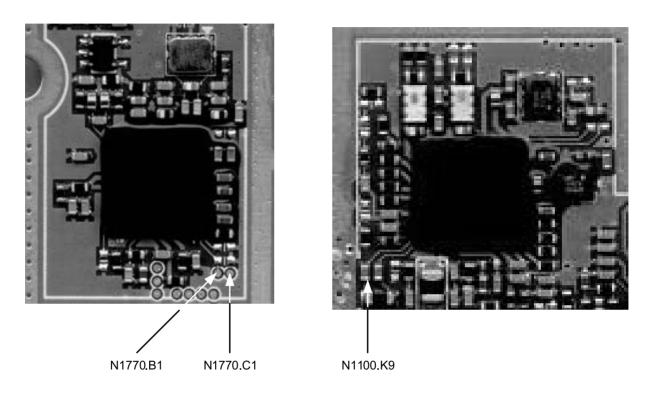


Figure 4-17. Test point (13MHz at TX Part)

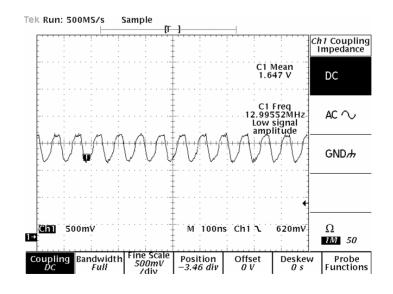


Figure 4-18. 13MHz at N1770.B1 and N1100.K9

Check 4. 13MHz at BB part

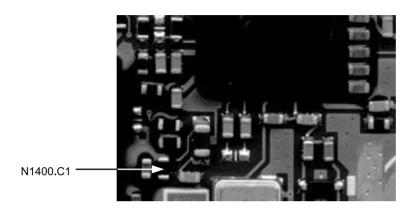


Figure 4-19. Test Point (13MHz at BB Part)

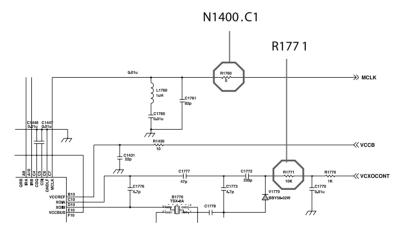


Figure 4-20. Schematic (13MHz at BB Part)

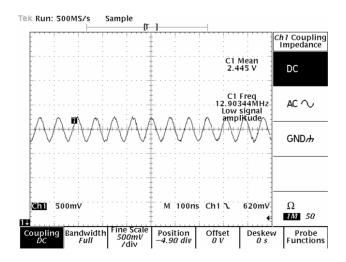
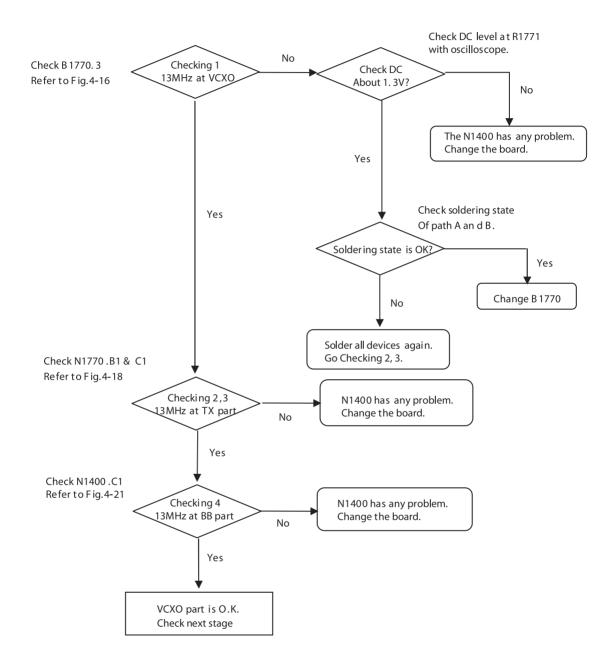


Figure 4-21. 13MHz at N1400.C1



# 4.18 Checking Ant. SW Module Block

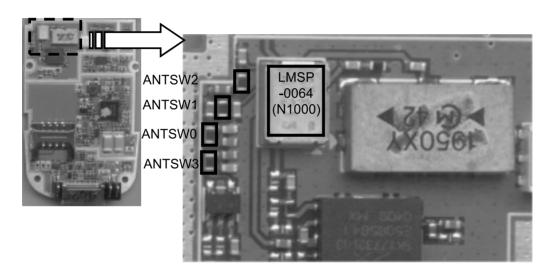
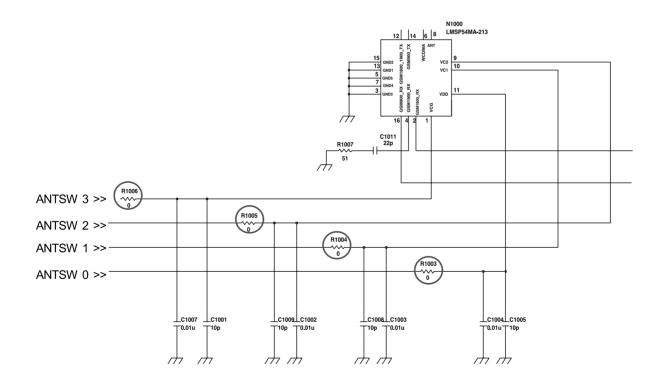
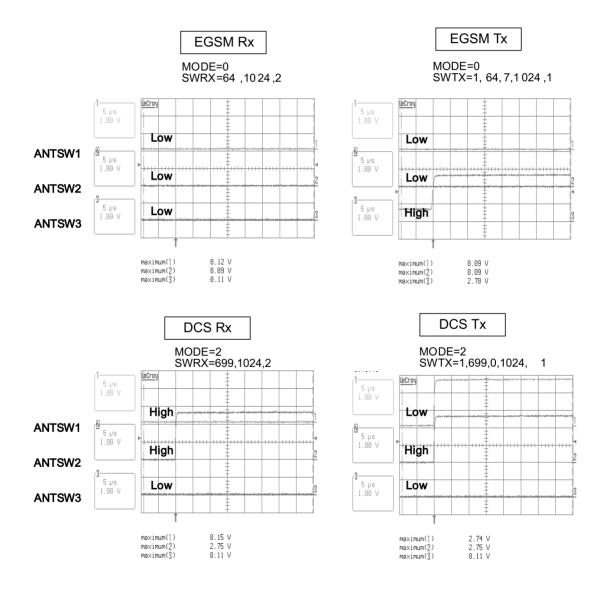


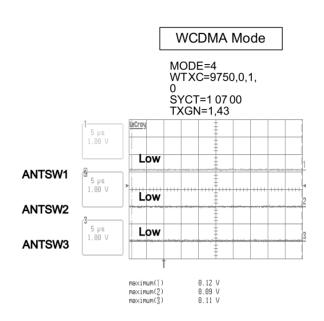
Figure 4-20. Antenna Switch Block(Bottom)



# 4.19 Checking Antenna Switch Block input logic

### 4.19.1 Mode Logic by TP Command



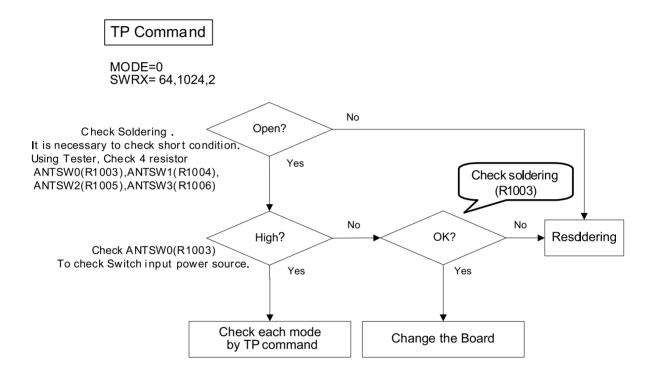


| Band    | ANTSW0 | ANTSW1 | ANTSW2 | ANTSW3 |
|---------|--------|--------|--------|--------|
| EGSM Tx | Н      | L      | L      | Н      |
| EGSM Rx | Н      | L      | L      | L      |
| DCS Tx  | Н      | Н      | Н      | L      |
| DCS Rx  | Н      | L      | Н      | L      |
| WCDMA   | Н      | L      | L      | L      |

Table 4-1. Antenna Switch Module Logic

### 4.19.2 Checking Switch Block power source

\* Before Checking this part, must check common power source (through Vincenne) part



#### A. EGSM Rx Mode

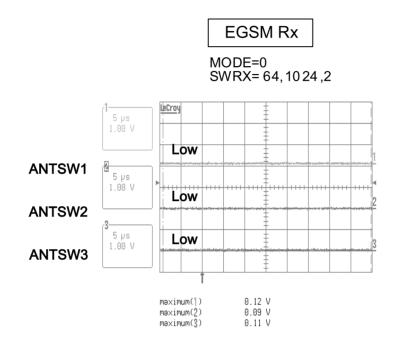
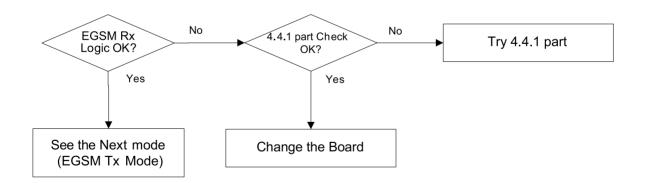


Figure 4-21. EGSM Rx Mode



#### **B. EGSM Tx Mode**

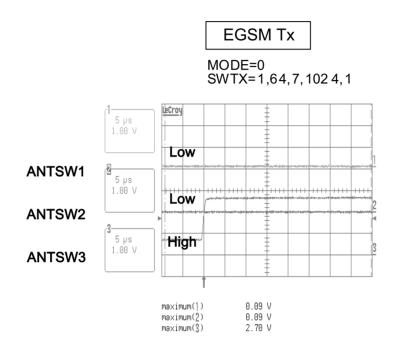
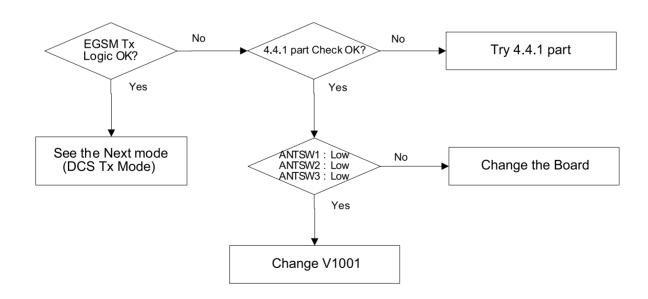


Figure 4-22. EGSM Tx Mode



#### C. DCS Rx Mode

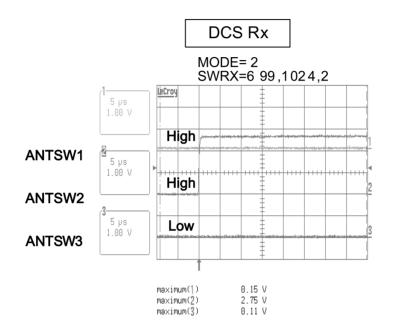
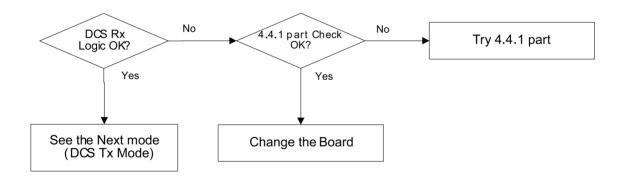


Figure 4-23. DCS Rx Mode



### D. DCS Tx Mode

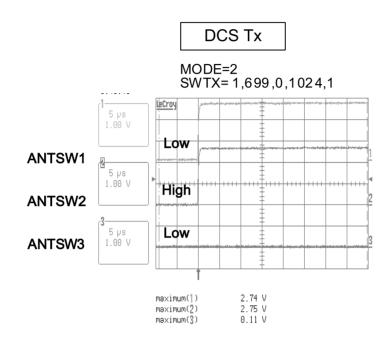
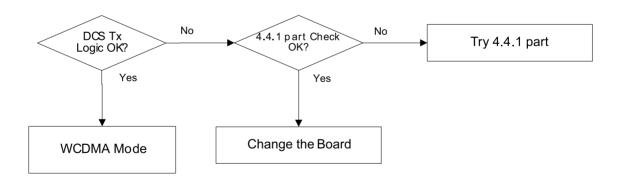


Figure 4-24. DCS Tx Mode



#### **E. WCDMA Mode**

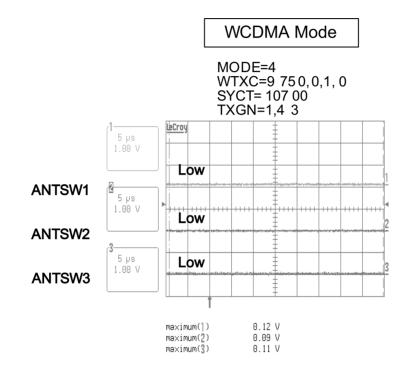
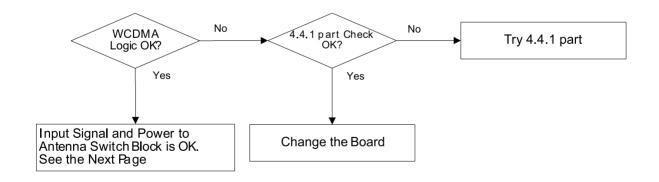
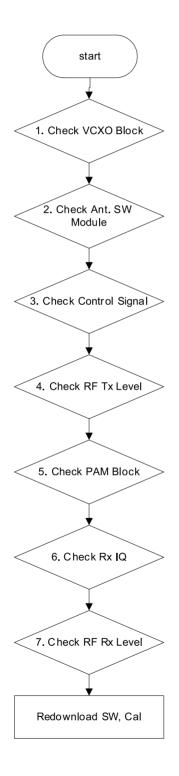
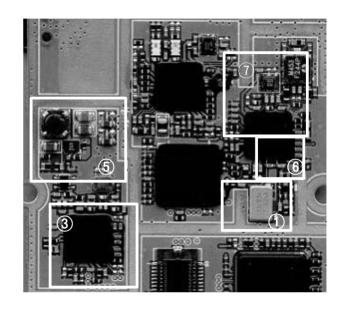


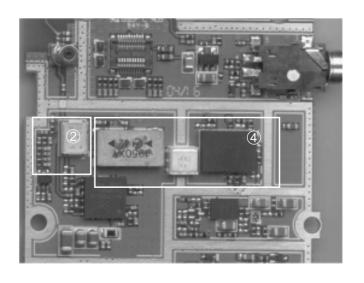
Figure 4-25. WCDMA Mode



# 4.20 Checking WCDMA Block







## 4.20.1 Checking

Refer to 4.4

# 4.20.2 Checking Ant. SW module

Refer to 4.5

## 4.20.3 Checking Control Signal

First of all, you have to check control signal. (data, clk, strobe)

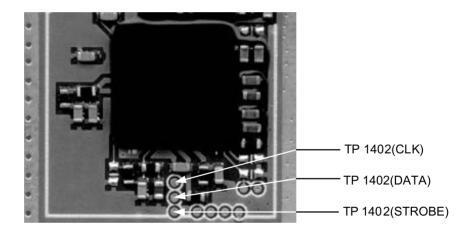


Figure 4-28. Test Point (Control Signal)

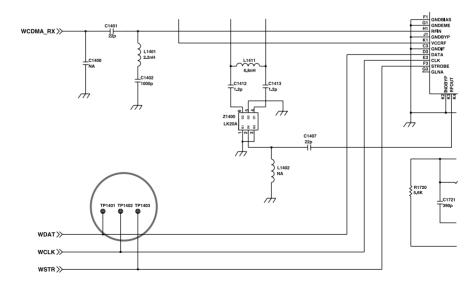


Figure 4-29. Schematic (Control Signal)

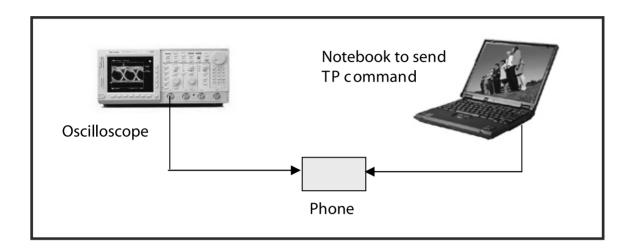


Figure 4-30. Connection for Checking Control Signal

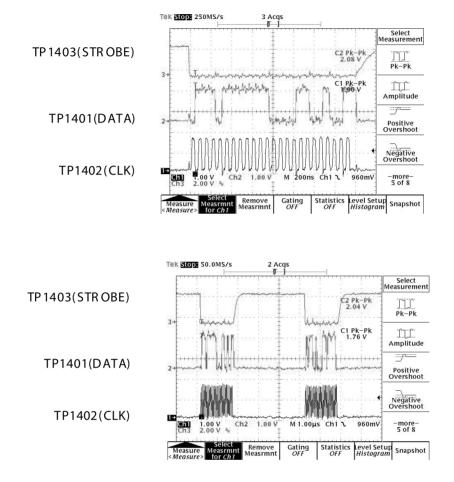
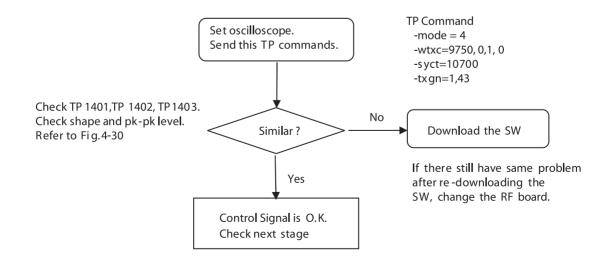


Figure 4-30. Control signal



# 4.20.4 Checking RF TX Level

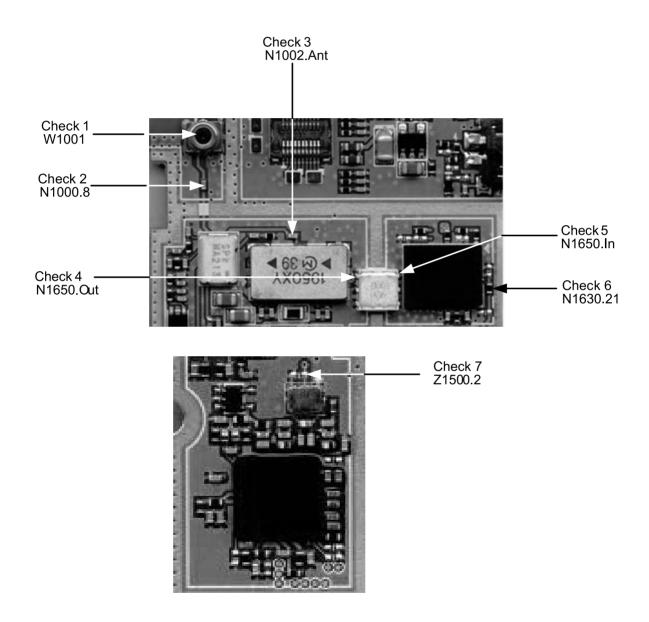


Figure 4-31. Test Point (RF TX Level)

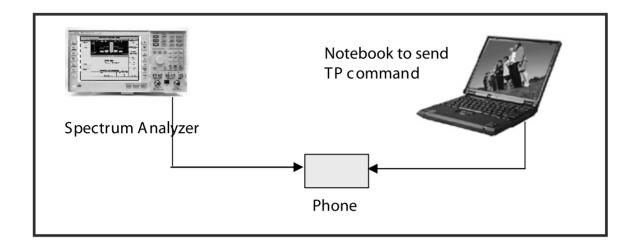
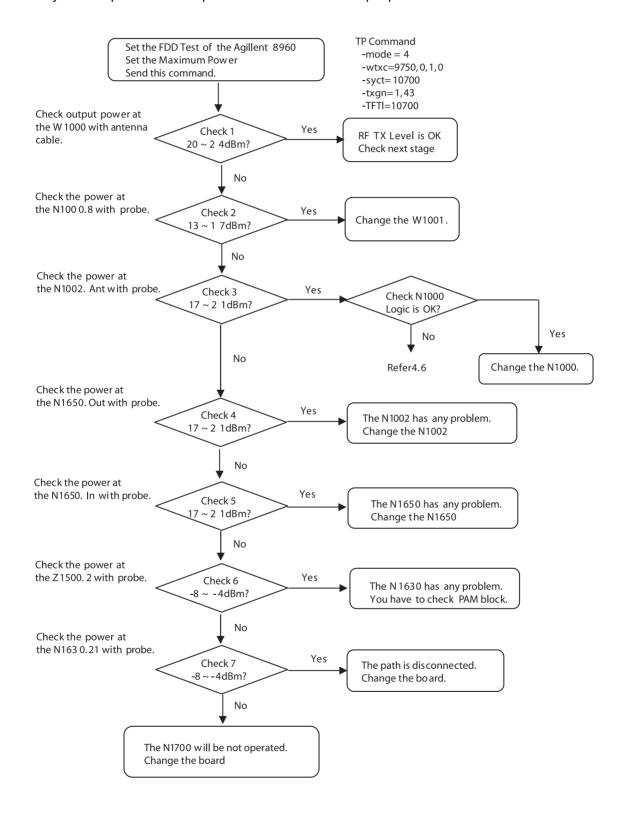
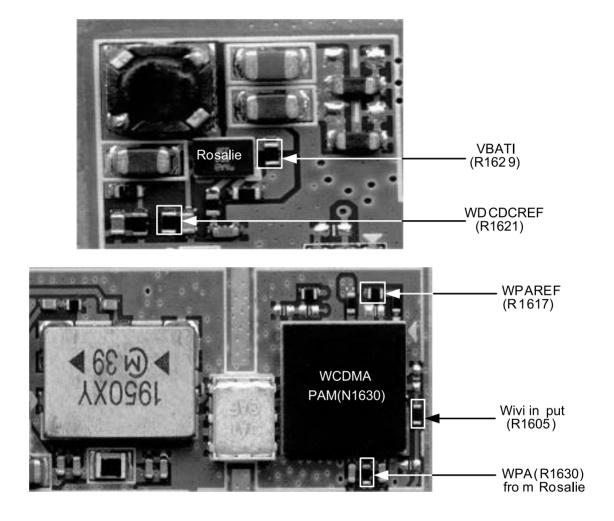


Figure 4-32. Connection for Checking RF TX Level

To verify that the phone fulfils requirements on maximum output power.



## 4.20.5 Checking PAM Block



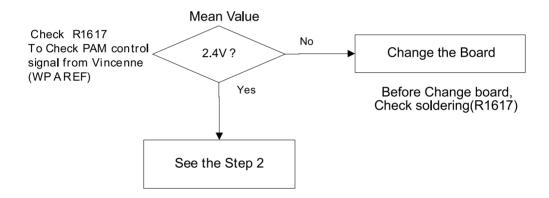
Step1: Check PAM(N1630) control signal from N2000 Step2: Check PAM(N1630) control signal from N1620

\* Before Checking this part, must check 4.2 Common power source(Battery Direct) part

**TP Command** 

- -mode =4
- -Wtxc=9750,0,1,0
- -Syct=10700
- -Txgn=1,43
- -TFTI=10700

Step1: Check PAM control signal from N2000

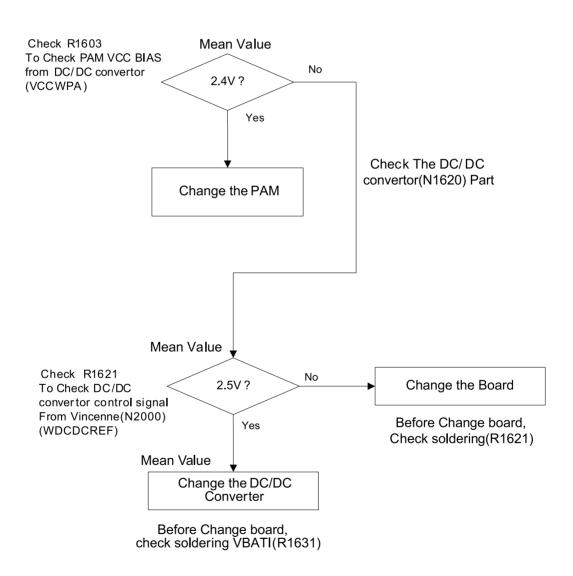


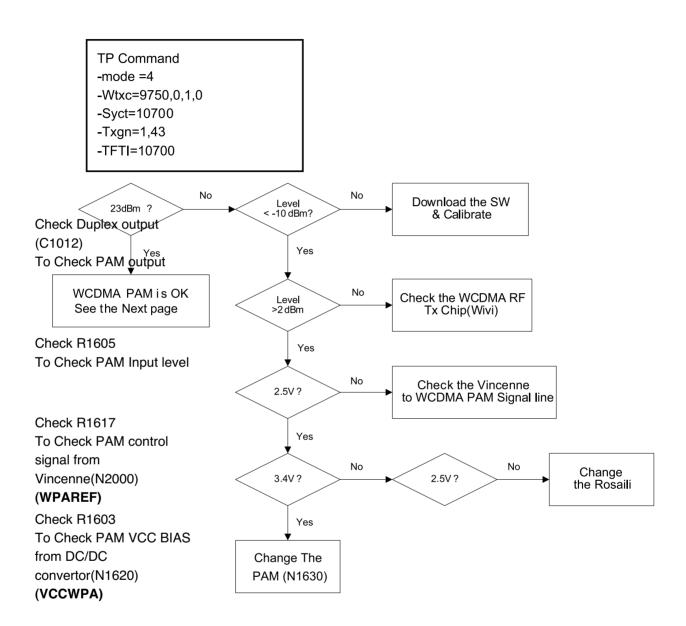
## 4. TROUBLE SHOOTING

**TP Command** 

- -mode =4
- -Wtxc=9750,0,1,0
- -Syct=10700
- -Txgn=1,43
- -TFTI=10700

Step2: Check PAM control signal from DC/DC converter(N1620)





## 4.20.6 Checking RX I,Q

To verify the RX path you have to check the pk-pk level and the shape of the RX I,Q.

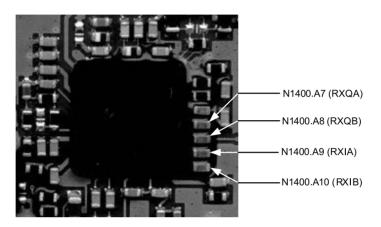
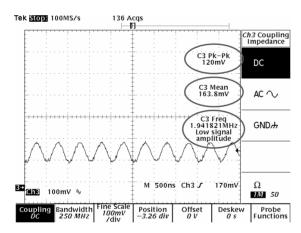
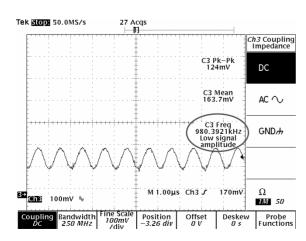


Figure 4-33. WCDMA RF RX IC (Top)



Feed a CW signal at 2142 MHz with a power level of –60dBm.

Figure 4-34. RX I,Q signal (CW:2142MHz)



Feed a CW signal at 2141 MHz with a power level of –60dBm.

Figure 4-35. RX I,Q signal (CW:2141MHz)

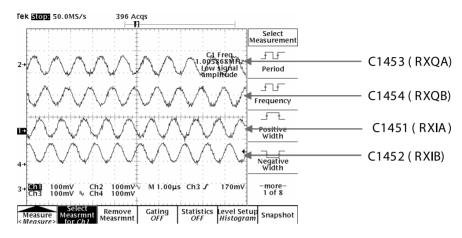
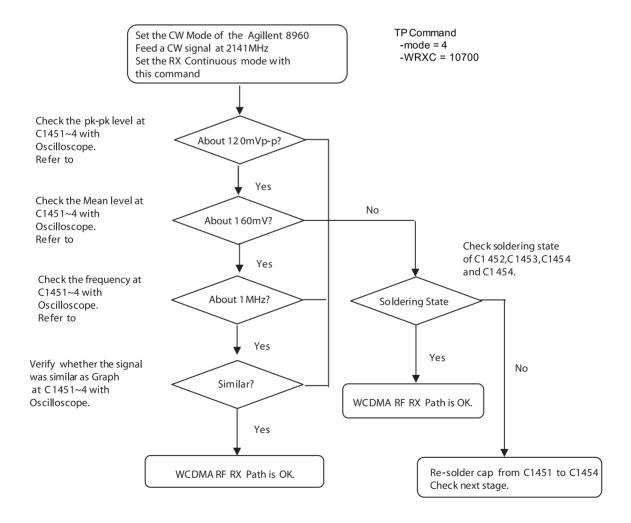


Figure 4-36. RX I, Q signal



# 4.20.7 Checking RX Level

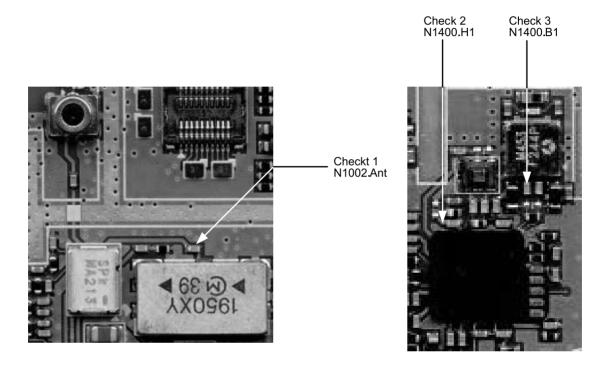


Figure 4-37. Peak level at N1400.B1

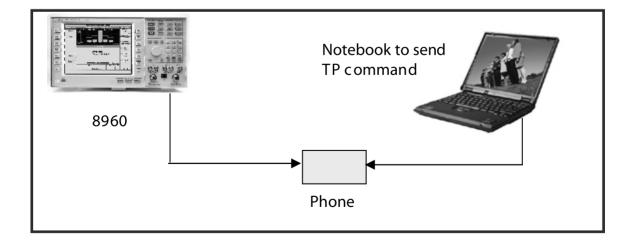
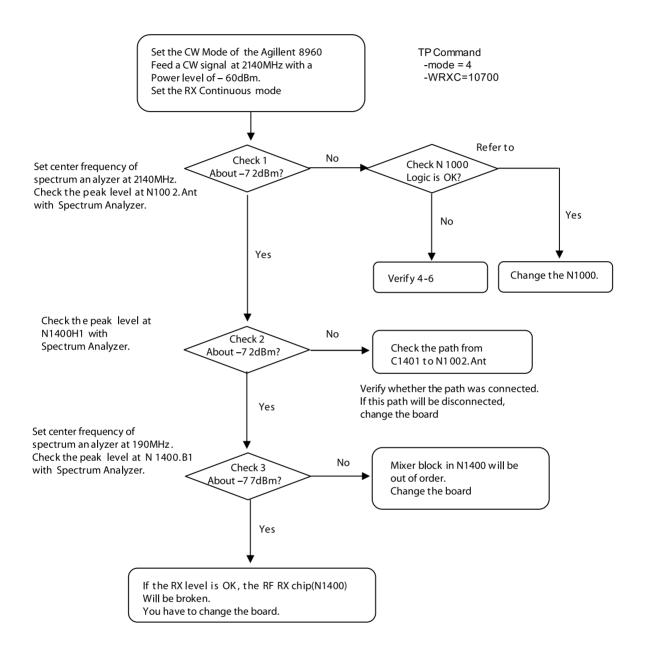
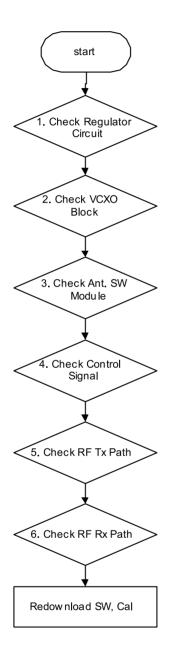
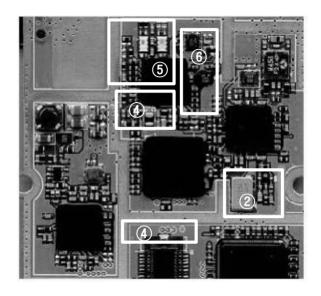


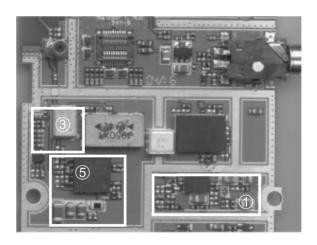
Figure 4-38. Connection for Checking RX Level



# 4.21 Checking GSM Block







## 4.21.1 Checking Regulator Circuit

Refer to chapter 4.3 Checking Common Power Source Block.

IF you already check this point while Checking Common Power Source Block, You can skip this test.

## 4.21.2 Checking VCXO Block

Refer to chapter 4.4 Checking VCXO Block.

IF you already check this point while Checking VCXO Block, You can skip this test.

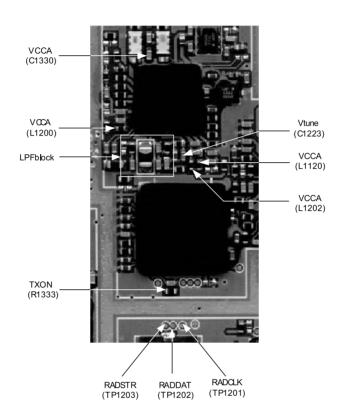
#### 4.21.3 Checking Ant. SW Module

Refer to chapter 4.6 Checking Antenna Switch Block input logic.

IF you already check this point while Checking Antenna Switch Block input logic, You can skip this test.

## 4.21.4 Checking Control Signal

Test Program Script MODE=0 SWTX=1,64,7,1024,1



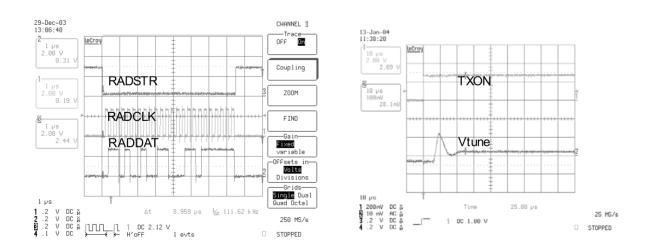
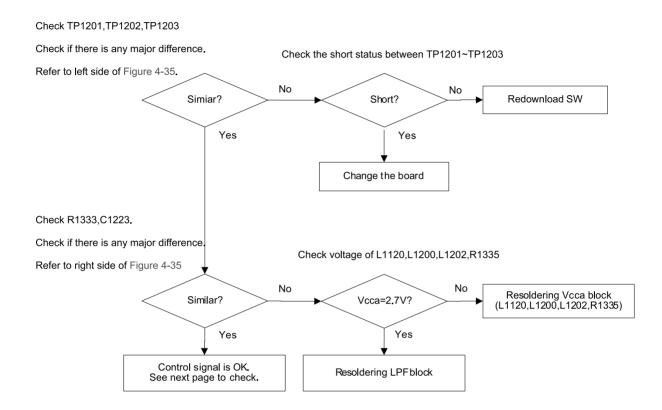


Figure 4-39. GSM RF Control signal



## 4.21.5 Checking RF Tx Path

## A. GSM Tx path Level

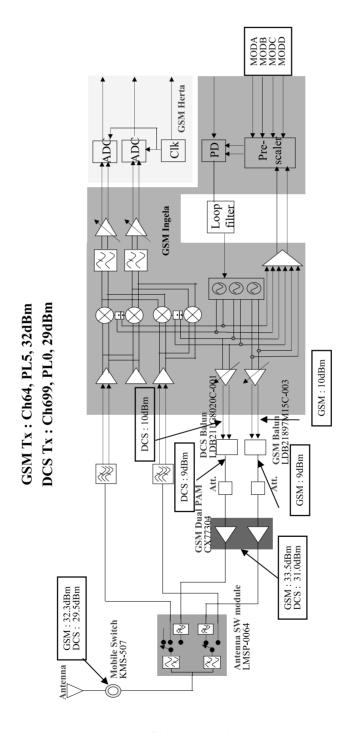


Figure 4-40. GSM/DCS Tx Path Level

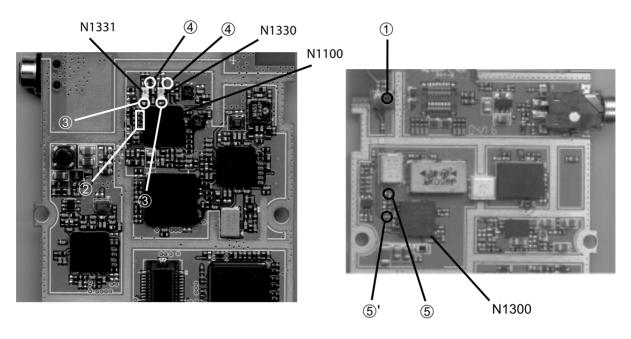
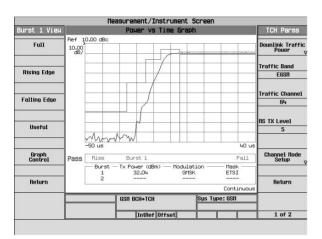
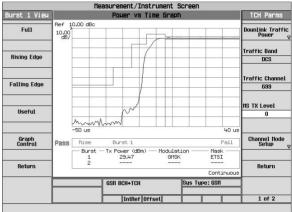


Figure 4-41. Test Point of GSM/DCS Tx path

## **B. GSM Tx Output Level Check**





2. DCS Tx

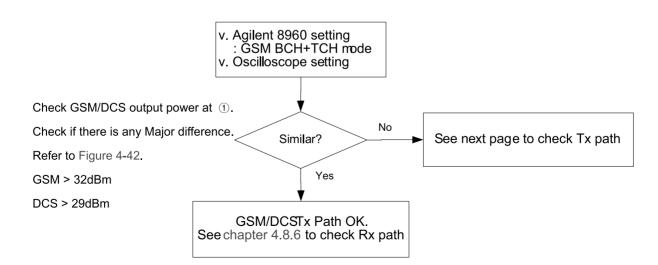
Figure 4-42. GSM Tx Level at ①

Test Program Script

1. GSM Tx

MODE=0 MODE=2

SWTX=1,64,5,1024,1 SWTX=1,699,0,1024,1



## C. GSM RF Transceiver IN/OUT Signal Check

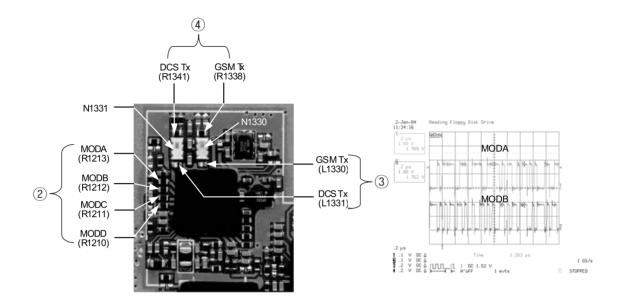
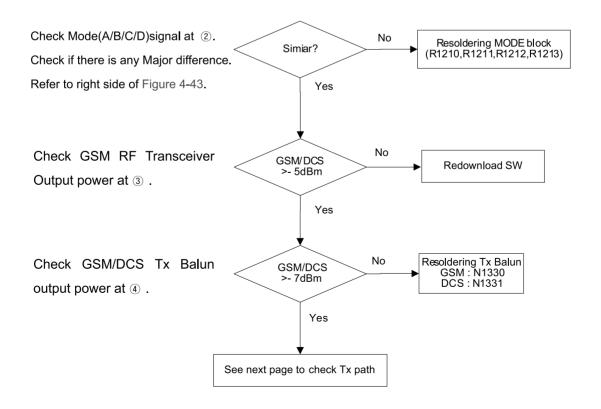


Figure 4-43. GSM Tx MODE signal



#### D. GSM PAM Check

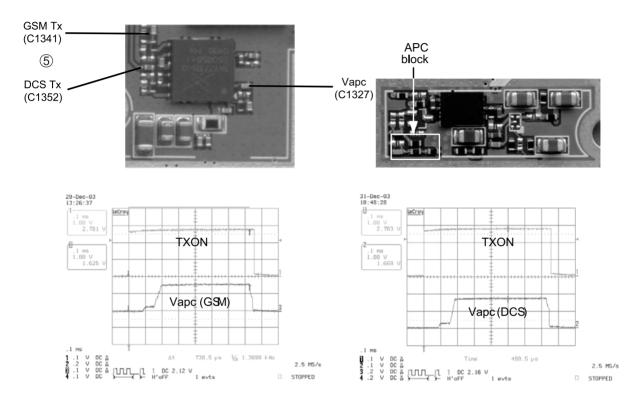
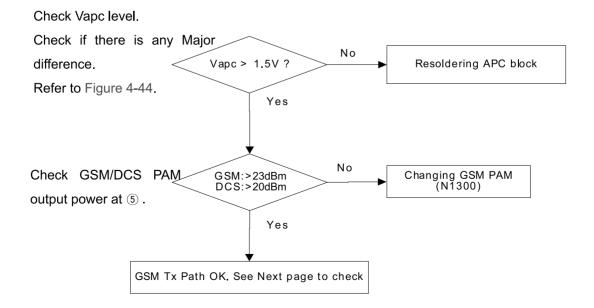


Figure 4-44. GSM/DCS Tx control signal



## 4.21.6 Checking RF Rx Path

## A. GSM Rx path Level

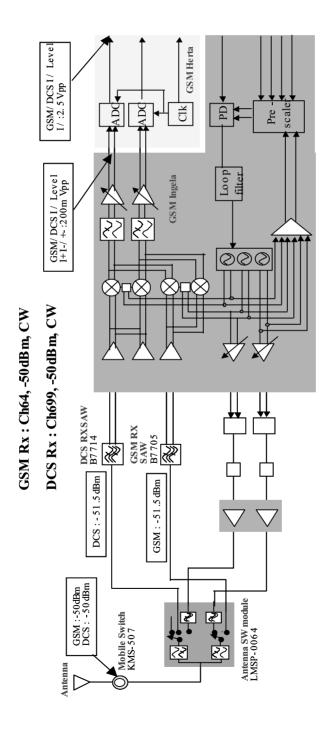
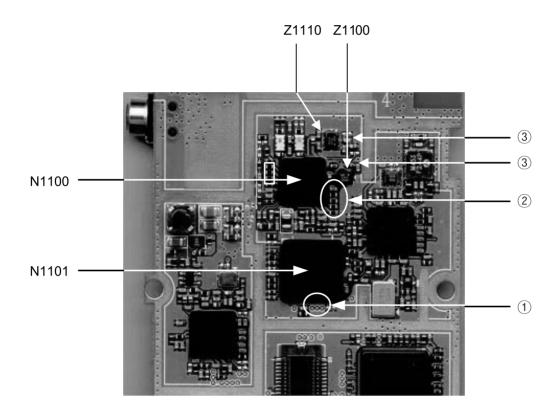


Figure 4-45. GSM/DCS Rx Path Level

## 4. TROUBLE SHOOTING



Test Program Script

1. GSM Rx 2. DCS Rx

MODE=0 MODE=2

SWRX=64,1024,2 SWRX=699,1024,2

v Agilent 8960 Setting

CW Mode

GSM:-50dBm@Ch65(948MHz) DCS:-50dBm@Ch700(1842.8MHz)

v Oscilloscope Setting

## B. GSM I/Q Signal Check

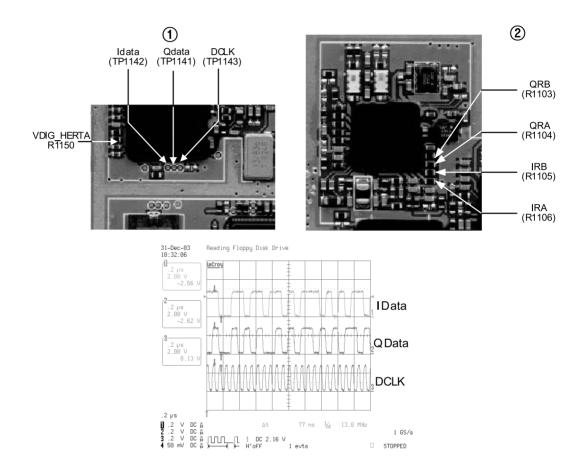


Figure 4-46. Herta IQ data and DCLK

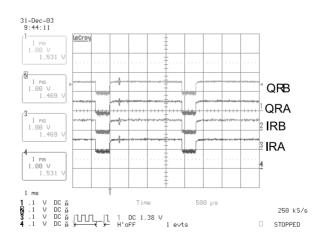


Figure 4-47. Ingela IQ signal

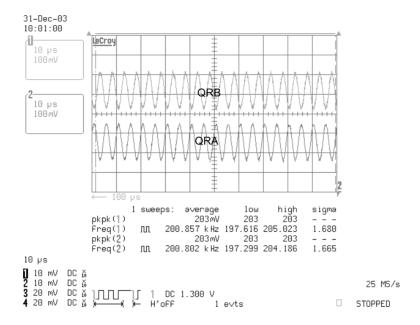
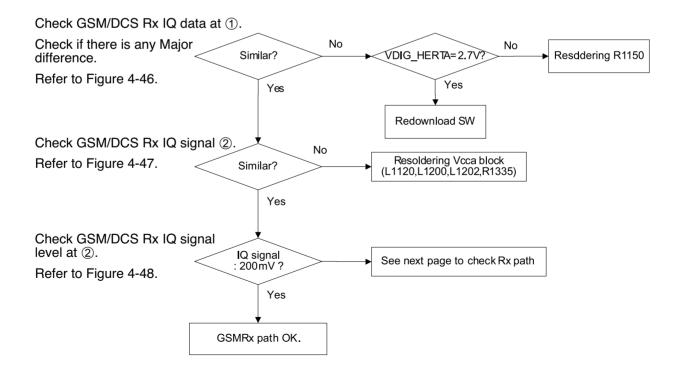


Figure 4-48. Ingela IQ signal



### C. GSM RF Level Check

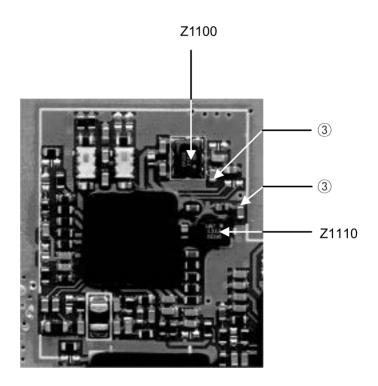
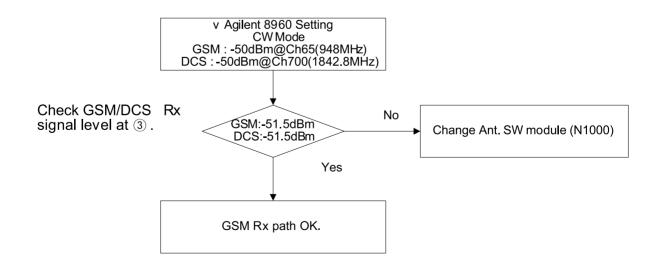


Figure 4-49. GSM/DCS Rx Path



## 5. BLOCK DIAGRAM

## 5.1 GSM & WCDMA RF Block

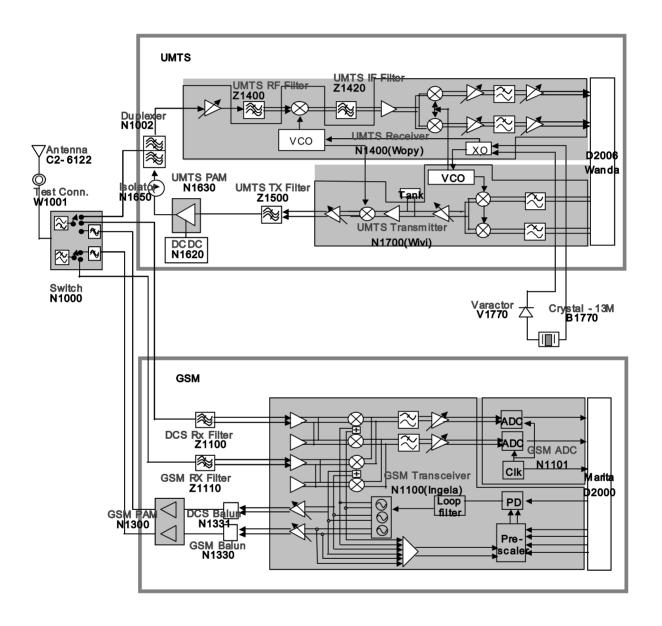


Figure 5-1. RF Block Diagram

| Block  | Ref. Name | Part Name      | Function       | Comment           |
|--------|-----------|----------------|----------------|-------------------|
| Common | N1000     | LMSP-0064      | Switch         | Band select       |
|        | W1001     | KMS-507        | Test Connector | Calibration, etc  |
|        | B1770     | TSX-8A         | Crystal        | Reference –13M    |
| WCDMA  | N1002     | DFYK61G95LBNCB | Duplexer       | TRX               |
|        | N1400     | LZT-108-       | Receiver       | RX                |
|        |           | 5323(WOPY)     |                |                   |
|        | Z1400     | LK20A          | RX RF Filter   | RX                |
|        | Z1420     | TMX-M453       | RX IF Filter   | RX                |
|        | N1620     | MAX1820ZEBC    | DC/DC          | TX                |
|        | N1630     | RF9266         | PAM            | TX                |
|        | N1650     | CEO0401G95DCB  | Isolator       | TX                |
|        | N1700     | LZT-108-       | Transmitter    | тх                |
|        |           | 5322(WIVI)     |                |                   |
|        | Z1500     | SX-S205B       | TX RF Filter   | TX                |
|        | D2006     | ROP-101-3033   | Analog         | TRX               |
|        |           | (WANDA)        | Baseband       |                   |
| GSM    | Z1100     | B7714          | DCS RX Filter  | Direct Conversion |
|        | Z1110     | B7705          | GSM RX Filter  | Direct Conversion |
|        | N1100     | LZT-108-5325   | Transceiver    | TRX               |
|        |           | (INGELA)       |                |                   |
|        | N1300     | CX77304        | PAM            | GSM/DCS Dual      |
|        | N1330     | LDB21897M15C   | GSM Balun      | TX                |
|        | N1331     | LDB211G8020C   | DCS Balun      | TX                |
|        | D2000     | POP-101-3035   | Modem          |                   |
|        |           | (MARITA)       |                |                   |

Table 5-1. RF Block Component

# **5.2 Interface Diagram**

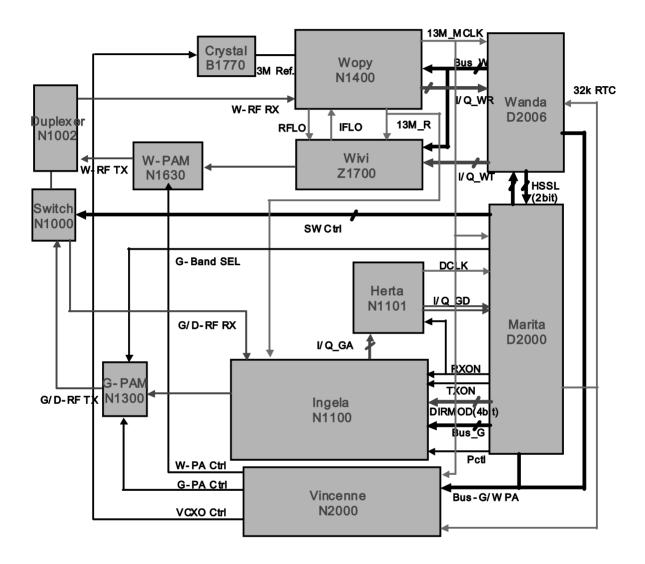


Figure 5-2. Interface Diagram 1

| Function Block | Name       | Schematic_Signal<br>Name | Function           |
|----------------|------------|--------------------------|--------------------|
| 1014           | 13M_MCLK   | MCLK                     | Main clock to BB   |
| 13M            | 13M_R      | XOOA/XOOB                | Ref for PLL        |
| LO             | RFLO       | RFLO/RFLOBAR             | RF LO Generation   |
|                | IFLO       | IFLO/IFLOBAR             | IF LO Generation   |
| 32K            | 32K        | RTCCLK                   | Real Time          |
|                | W-RF RX    | WCDMA_RX                 | RX RF signal       |
|                | W-RF TX    | WCDMA_TX                 | TX RF signal       |
|                | G/D-RF RX  | GSM_RX/DCS_RX            | RX RF signal       |
| Signal         | G/D-RF TX  | GSM_TXDCS_TX             | RX RF signal       |
| Signal         | I/Q_WR     | RXIA/RXIB/RXQA/RXQB      | WCDMA RXIQ         |
|                | I/Q_WT     | TXIA/TXIB/TXQA/TXQB      | WCDMA TXIQ         |
|                | I/Q_GA     | IRA/IRB/QRA/QRB          | GSM RX analog      |
|                | I/Q_GD     | IDATA/QDATA              | GSM RX digital     |
|                | SW Ctrl    | ANTSW0/1/2/3             | Band/System switch |
|                | G-Band SEL | BSEL0                    | GSM/DCS switch     |
|                | W-PA Ctrl  | WPAREF                   | PAM Ref. Bias      |
| Control        | G-PA Ctrl  | PAREG                    | Power control      |
|                | Pctl       | PCTL                     | TX power control   |
|                | VCXO Ctrl  | VCXOCONT                 | AFC                |
|                | RXON       | RXON                     | RX block ON        |
|                | TXON       | TXON                     | TX block ON        |
|                | Bus_W      | WDAT/WCLK/WSTR           | PLL program        |
| Bus            | Bus_G      | RADDAT/RADCLK/RADSTR     | PLL program        |
|                | Bus-G/WPA  | DACDAT/DACCLK/DACSTR     | TX Gain program    |

Table 5-2. Interface Signal Block

## 5.3 Detailed Interface Signal

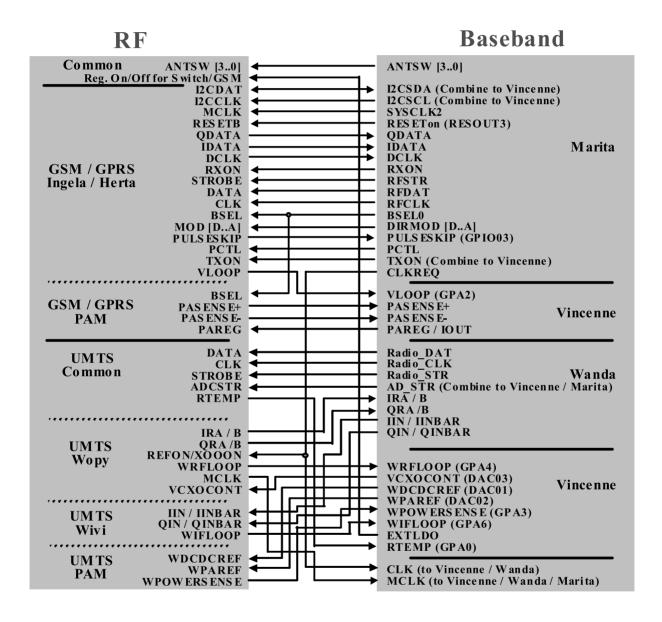


Figure 5-3. Interface Diagram 2

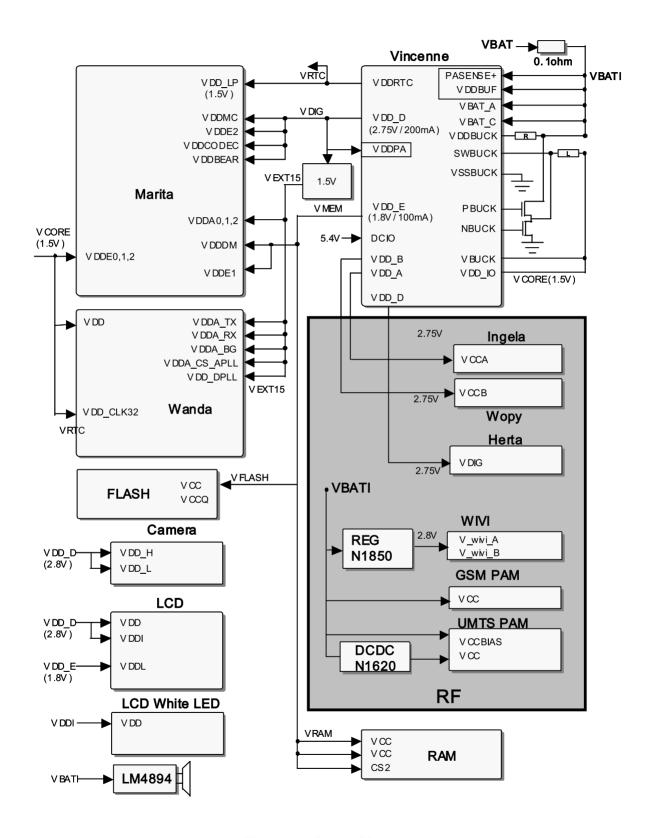
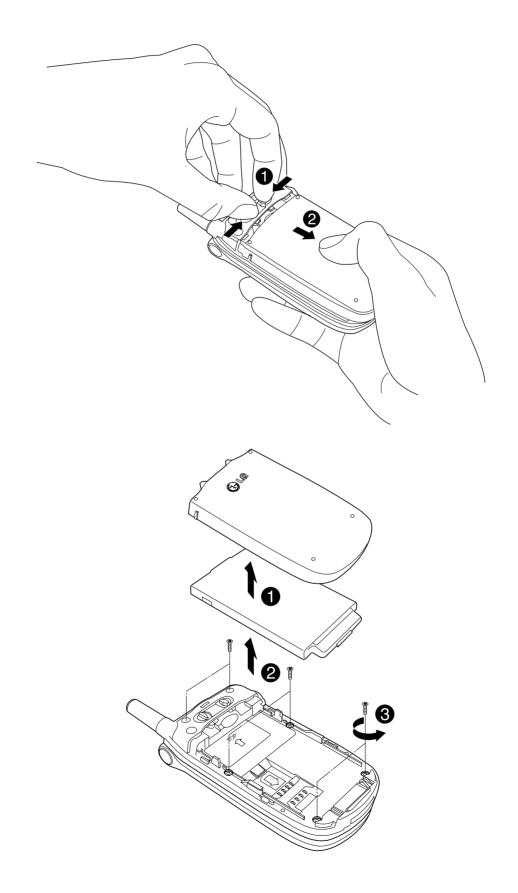
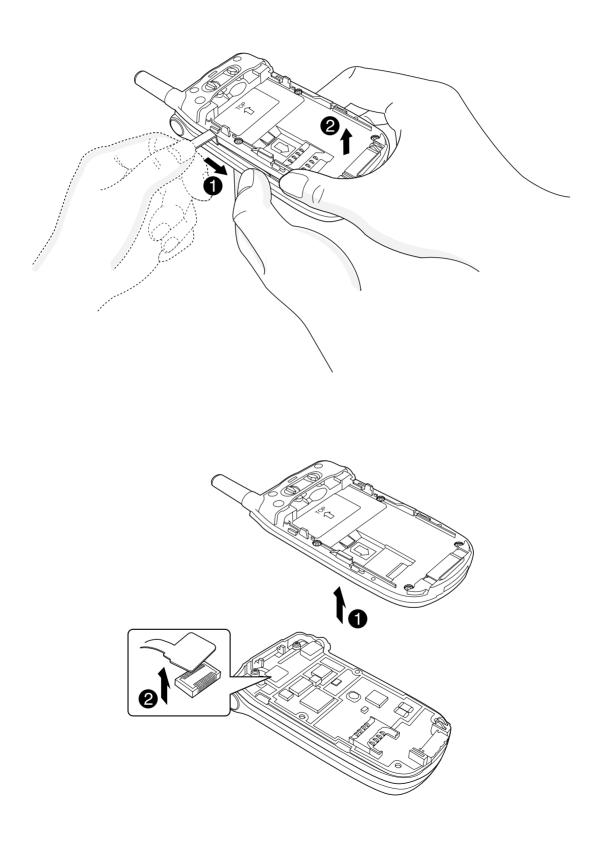
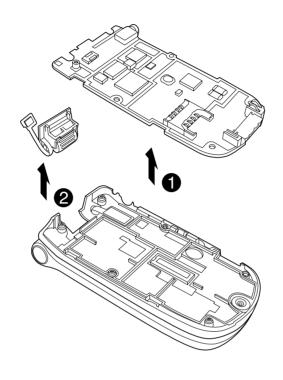


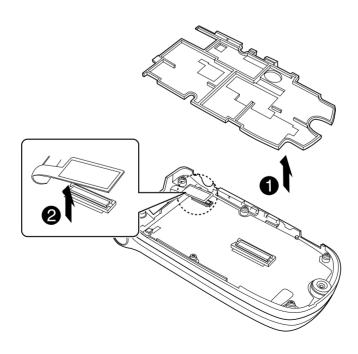
Figure 5-4. Power Diagram

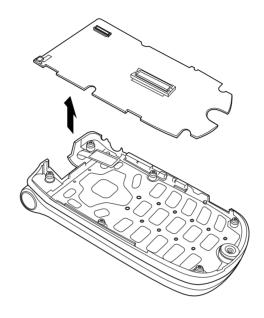
# **6. DISASSEMBLY INSTRUCTION**

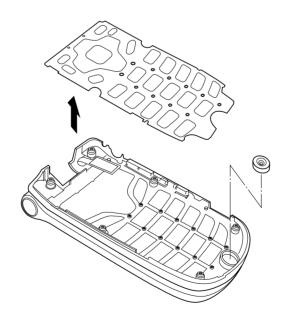


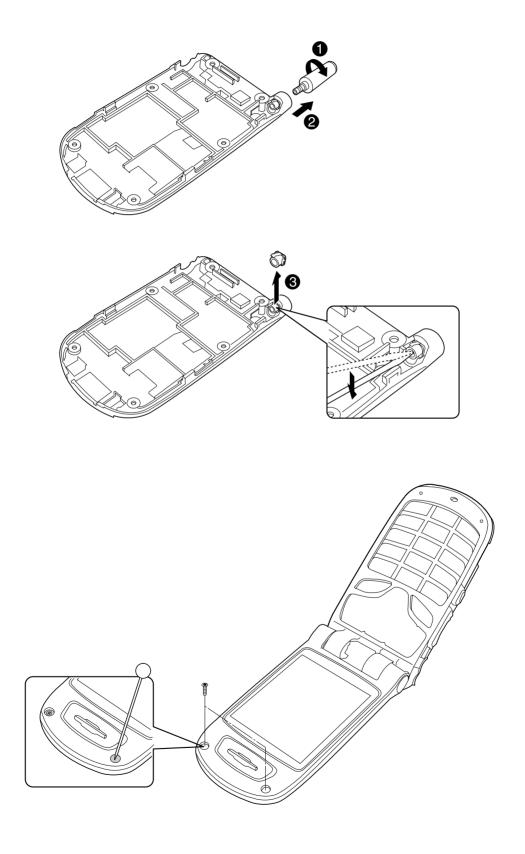


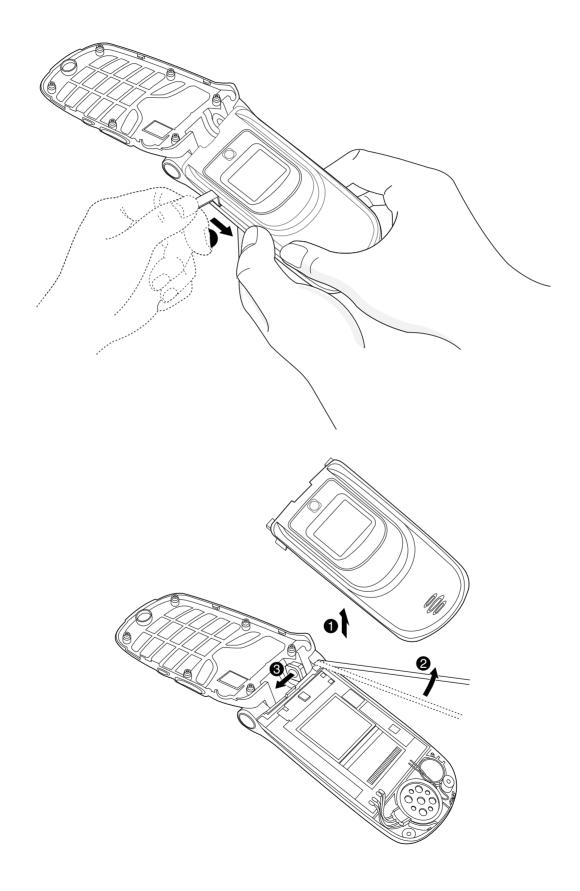


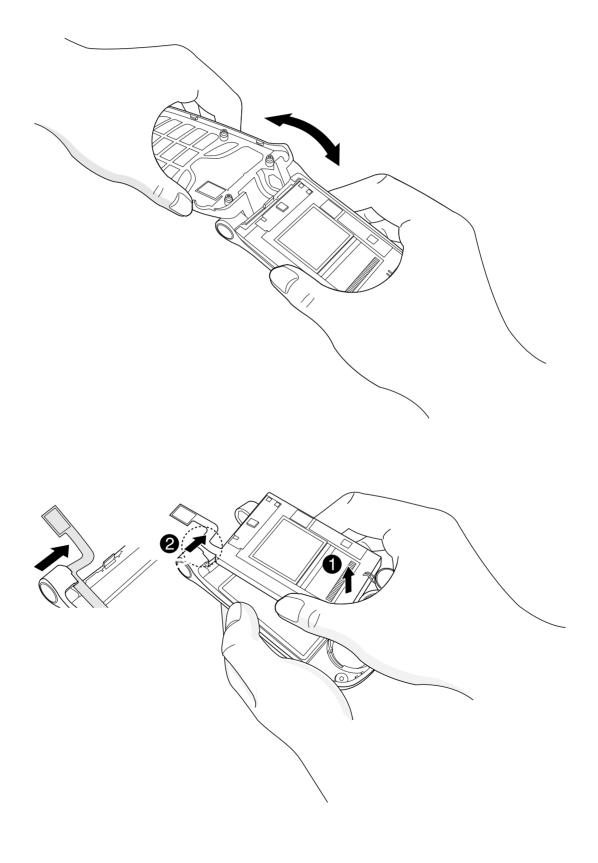


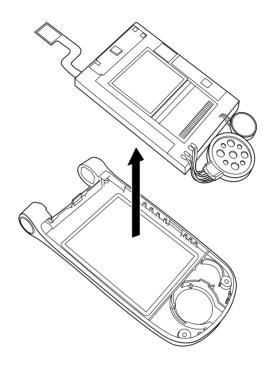












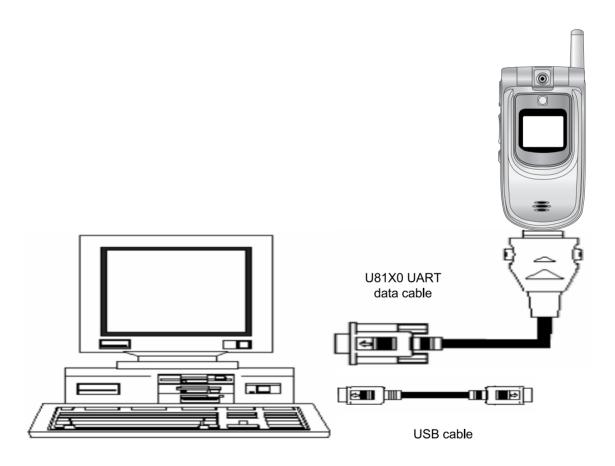
## 7. DOWNLOAD

# The Purpose of Downloading Software

- To make a phone operate at the first manufacturing
- A phone = Hardware + Software
- A phone cannot operate with hardware alone.
- The hardware with the suitable software can operate properly.
- To upgrade the software of the phone
- The software of the phone may be changed to enhance the performance of the phone.
- The older version software of the phone can be replaced to the newer version.
- Download Tools

FlashRW: Download tool for U81X0 software

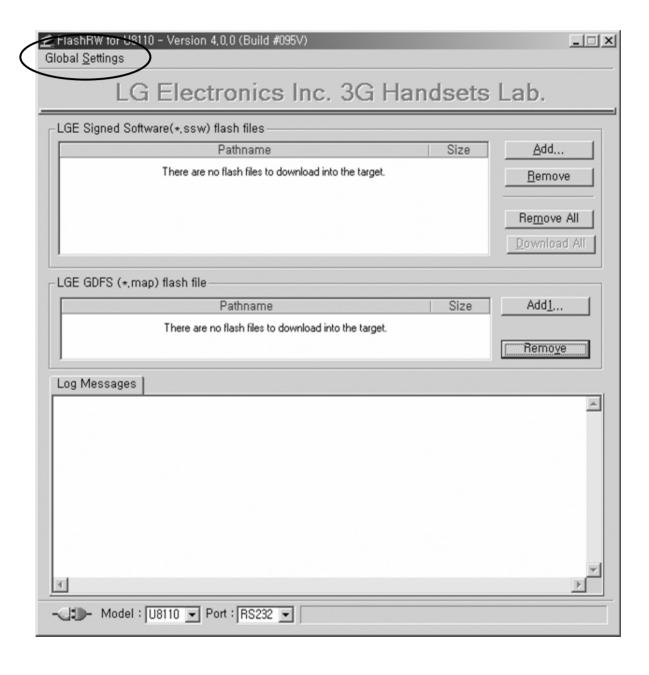
## **Download Environment Setup**



U81X0 Download can be done via UART & USB

# U81X0 Download (1) - FlashRW configuraation

- 1. Execute FLASHRW.exe.
- 2. Press the "Global Settings" on the top menu to configure FlashRW environment



## U8100 Download (2) - FlashRW configuraation

3. Select Loader File for Product.

You can use browse button to select Loader File.

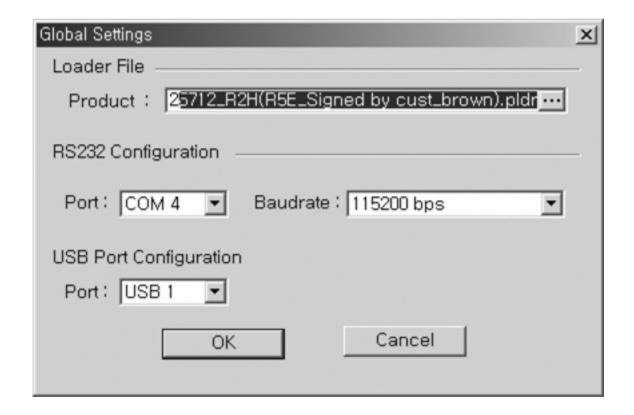
You must select only U8100\_CXC1325712\_R2H(R5E\_Signed by cust\_brown).pldr for U8100.

You may select any loader of 3 loaders in loader folder for U8100.

Loader File is provided with FlashRW.

4. Select Port configurations for both RS232 Port and USB Port.

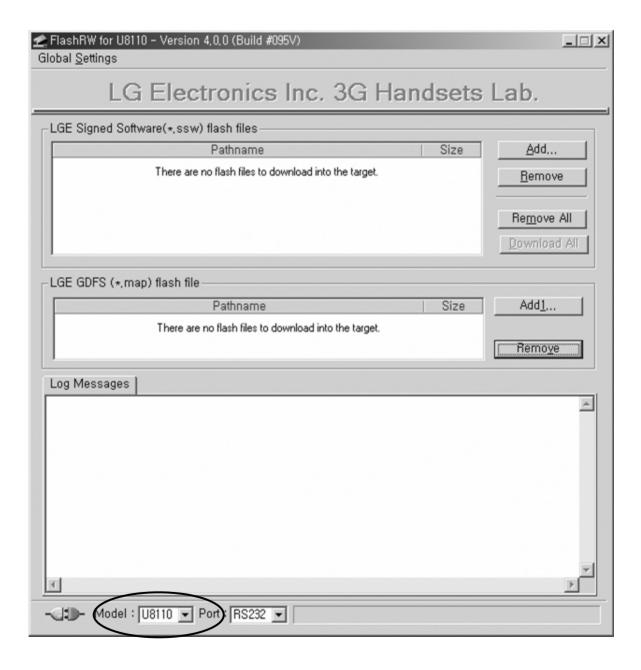
Baudrate should be 115200bps.



You have to do FlashRW configuration only at the first time of installation

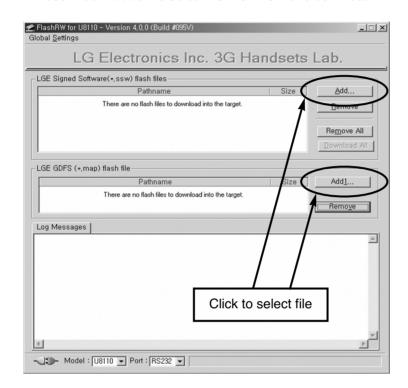
# **U81X0** Download (3) – Phone Model Selection

- 1. Press Button for Model.
- 2. Select Model to download images

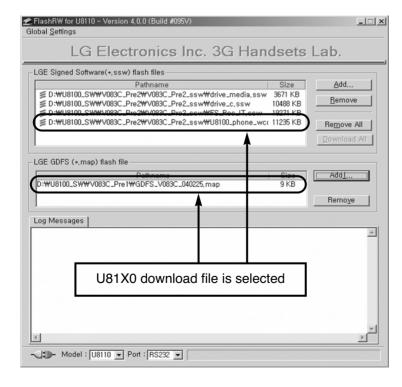


# U81X0 Download (4) - Download file selection

- 1. Press "Add" button to select LGE SSW files to download.
- 2. Press "Add1" button to select LGE GDFS file to download.



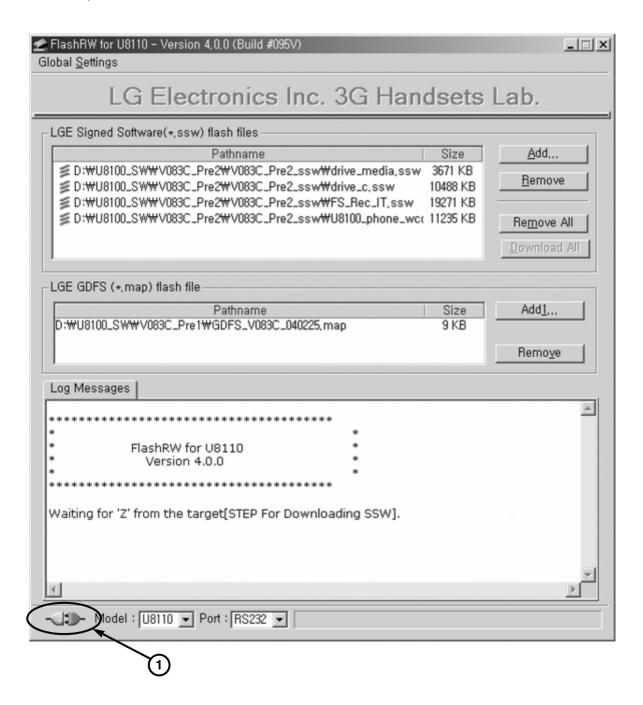
<Before Select>



<After Select>

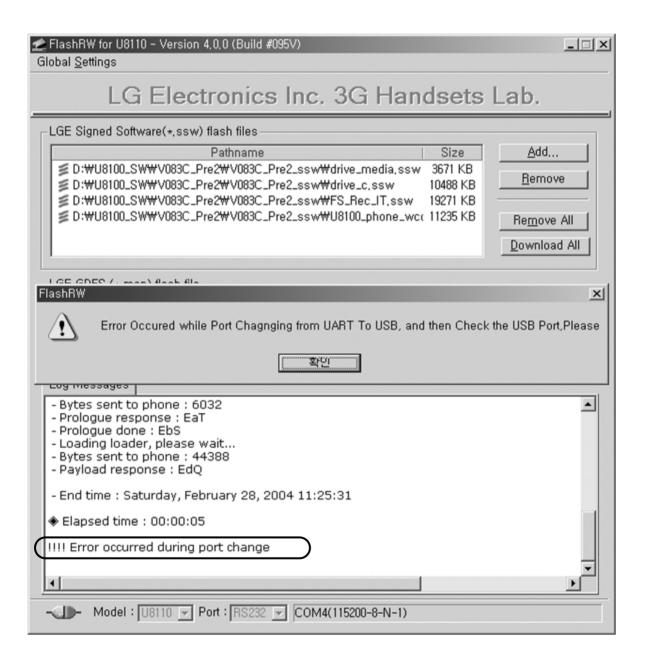
# U81X0 Download (5) - Connect & Download

- 1. Click on connector icon ( ) to connect to the phone Check the Dialog Box that say "Please, switch on the target".
- 2. Connect the phone to PC via Cable for Downloading. Phone should be turned off.
- 3. Turn the phone on to connect to PC.



## U81X0 Download (6) - USB Driver Install

If you use FlashRW Tool firstly, Error will happen because of USB Driver uninstalled.
 You have to do FlashRW USB Driver Installation only at the first time of installation



# U81X0 Download (7) - USB Driver Install

- 2. Push "the Next Button" in Found New Hardware Wizard
- 3. Select "Search for a suitable driver for my device" in Found New Hardware Wizard





## U81X0 Download (8) - USB Driver Install

- 4. Select "Specify a location" in Found New Hardware Wizard
- 5. Push "the Browse Button", and then select "USB driver Information file" This File is provided with FlashRW.





# U81X0 Download (9) - USB Driver Install

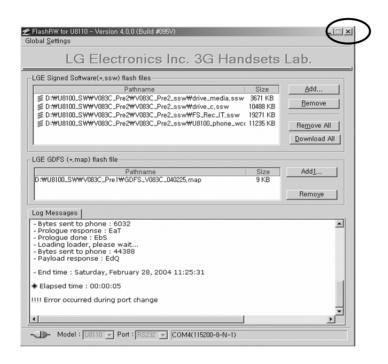
- 6. Push "the Next Button" in Found New Hardware Wizard
- 7. Push "the Finish Button" in Found New Hardware Wizard

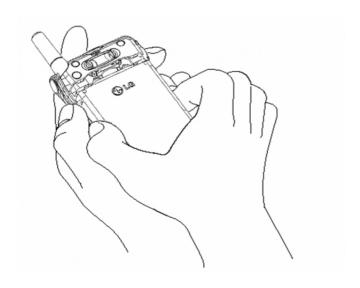




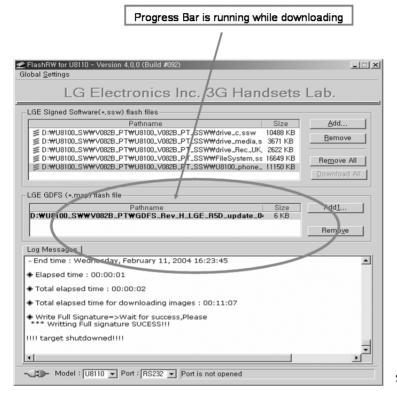
# U81X0 Download (10) - USB Driver Install

- 8. Close FlashRW.exe
- Remove & Insert Main battery to reset the phone
   This action for USB Driver Install is done only at the first time of installation
   If you want to download Software, just do as same as U81X0 Download (5) Connect & Download says

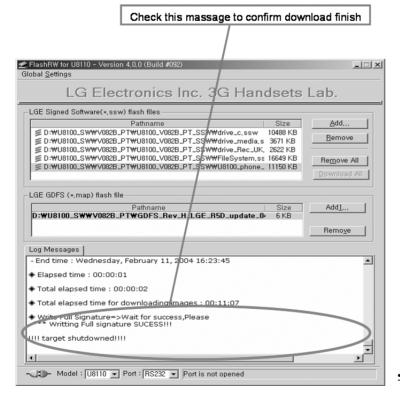




# U81X0 Download (11) - Connect & Download



< While Downloading >



< After Downloading finished >

# U81X0 Download (12) - Trouble shooting

- · Check these questions when trouble happens.
  - 1. Check if UART & USB Port configuration is right.
  - 2. Do not change RS-232 baud rate(115200BPS). It is fixed and never changed.
  - 3. Check if UART & USB Cable is connected.

## 8. CALIBRATION

## 8.1 General Description

This document describes the construction and the usage of the software used for the calibration of LG's GSM/GPRS/WCDMA Multimedia Mobile Phone (U8100). The calibration menu and their results are displayed in PC terminal by Mobile phone.

This calibration software includes GSM, DCS, WCDMA Band RF partscalibration and Battery calibration. This calibration software was called "XCALMON(eXtended CALibration and MONitor program)". From now on, the calibration software will be called XCALMON in this document.

### **8.2 XCALMON Environment**

#### 8.2.1 H/W Environment

- PC with RS-232 Interface & GPIB card installed
- GSM/GPRS/WCDMA Multimedia Mobile Set (U8100)
- Agilent 8960 Series 10 E5515C Instrument (E1985B ver04.08)
- Tektronix PS2521G Power Supply
- ETC (GPIB cable, Serial cable, RF cable, Power cable, Dummy battery)

#### 8.2.2 S/W Environment

- National Instrument GPIB &VISA (ver 2.60 full)driver install
- Agilent 8960 VXI driver(E1960)install
- XCALMON EXE files
- OS: Window98, Window2000, WindowXP
- Serial port configuration :

Baud rate:115200 /Char length:8bit /No Parity/No Flow control Stop bits:1 bit

## 8.2.3 Configuration Diagram of Calibration Environment

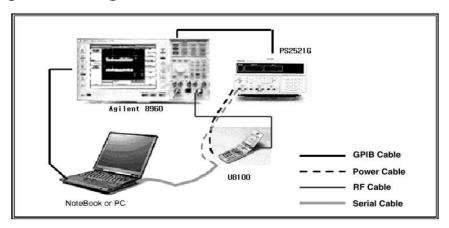


Figure 8-1. Calibration Configuration Figure

## 8.3 Calibration Explanation

#### 8.3.1 Overview

In this section, it is explained each calibration item in the XCALMON. Also the explanation includes technical information such as basic formula of calibration and settings for key parameters in each calibration procedure.

At first, when any of calibration is done, the results are displayed in the XCALMON result window and the result of calibration will be stored in GDFS (Global Data Flash Storage).

#### 8.3.2 Calibration Items

### A. EGSM 900 Band

- MODA-D(MD bit)Delay Calibration
- RXVCO Varactor Operating Point Calibration
- TXVCO Varactor Operating Point Calibration
- TX Loop Bandwidth Calibration
- VCXO Calibration
- TX Power Calibration
- RSSI and AGC Calibration

#### **B. DCS 1800 Band**

- RXVCO Varactor Operating Point Calibration
- TXVCO Varactor Operating Point Calibration
- TX Loop Bandwidth Calibration
- TX Power Calibration
- RSSI Cal i br at i on

#### C. WCDMA Band

- RF VCO Center Frequency Calibration
- TX Carrier Suppression Calibration
- TX LPF Bandwidth Calibration
- TX Maximum Output Power Calibration
- TX Power Table Calibration
- TX Open Loop Power Control Calibration
- RX LPF Bandwidth Calibration
- RX LNA Gain Switch and AGC Hysteresis Calibration
- RX AGC Gain Max and Rx RSSI Calibration

#### 8.3.3 EGSM 900 Calibration Items

### A. MOD-A(MD bit) Delay Calibration

#### - Purpose

The procedure is designed to calibrate the timing alignment between the MODA-D signals and the reference signal (13 MHz). It also ensures that the MOD signals have stable values when they are clocked into the divider of the Phase-Locked Loop (PLL).

- Procedure Proposal
- 1. Set the ME to mid channel in the GSM TX band.
- 2. Set the delay setting in default mode, that is, no delay.
- 3. Wait approximately 300 us to 400 us to allow the PLL to lock.
- 4. Measure the RMS phase error. A threshold value of >20 deg indicates that the PLL is running in the forbidden time region.
- 5. Save the RMS phase error result locally.
- 6. Step up the delay setting according to Table 8.1 below.
- 7. Repeat from step 4.
- 8. Choose delay setting that gives maximum distance to the consecutive field of corrupted RMS phase error values in the vector.
- 9. Store delay setting both to the GD\_RF\_Mod\_Delay and to the GD\_DirMod\_Mod\_Delay.
- 10. Reset the radio.

| Index | DIMC | MD    |
|-------|------|-------|
| [0]   | 0    | 00(0) |
| [1]   | 0    | 01(1) |
| [2]   | 0    | 10(2) |
| [3]   | 0    | 11(3) |
| [4]   | 1    | 00(0) |
| [5]   | 1    | 01(1) |
| [6]   | 1    | 10(2) |
| [7]   | 1    | 11(3) |

Table 8-1. Delay Settings for the MOD-A

### **B. RXVCO Varactor Operating Point Calibration**

- Purpose

To adjust the varactor diode to a pre-determined operating point, so that the loop voltage of the RXVCO (measured with an ADC in AB 2000) is within the valid range. This is necessary to secure that all RX channels can be reached.

- Procedure Proposal
- 1. Put the ME in static RX mode.
- 2. Measure the loop voltage with the AB 2000 ADC for all CVCO settings, that is, 0 ~7. Find a CVCO value that fulfills the requirements on loop voltage for low and high channel.
- 3. If there are several CVCO values that fulfill the loop voltage requirements, then the optimum CVCO value is the one that centers the loop voltage within the specified limits.
- Store the selected CVCO in the memory.
   (GD\_RX\_VCO\_Centre\_Frequency\_Adjustment\_Band)
- 5. Reset the radio.

### C. TXVCO Varactor Operating Point Calibration

- Purpose

To adjust the varactor diode to a pre-determined operating point, so that the loop voltage of the TXVCO (measured with an ADC in AB 2000) is within the valid range. This is necessary to secure that all TX channels can be reached.

- Procedure Proposal
- 1. Put the phone in static TX mode.
- 2. Measure the loop voltage with the AB 2000 ADC for all CVCO settings, that is, 0 ~7. Find a CVCO value that fulfills the requirements on loop voltage for low and high channel.
- 3. If there are several CVCO values that fulfill the loop voltage requirements, then the optimum CVCO value is the one that centers the loop voltage within the specified limits.
- Store the selected CVCO in the memory.
   (GD\_TX\_VCO\_Centre\_Frequency\_Adjustment\_Band)
- 5. Reset the radio.

#### D. TX Loop Bandwidth Calibration

- Purpose

The loop bandwidth is calibrated to match the pre-filtering of the modulation in DB 2000 by adjusting the phase detector current.

Note: This also indirectly adjusts the VCO gain that can otherwise not be calibrated.

This will ensure a correct transfer function for the modulation and keep phase error to a minimum.

- Procedure Proposal
- 1. Put the ME in switched TX mode on mid channel in frequency interval 11 for EGSM (with random modulation).
- 2. Measure the RMS phase error at the RF connector.
- 3. Tune the phase detector current (IPHD)until the phase error is minimized. If two IPHD settings gave the same RMS, choose the lowest value. Measure 10 bursts for each value.
- 4. Calculate and store the IPHD values in GDFS (GD\_IPHD\_8Temperature\_and\_24Channel\_Compensation\_Band)
- 5. The offsets in the table are steps in the IPHD Table 8.2 and all offsets refer to the calibrated value (Trim) at mid channel in room temperature.

|   | Frequency Interval |    |    |    |    |    |    |    |    |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |
|---|--------------------|----|----|----|----|----|----|----|----|---|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
|   | 0                  | 1  | 2  | 3  | 4  | 5  | 6  | 7  | 8  | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 |
| 0 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 1 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 2 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 3 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 4 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 5 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 6 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |
| 7 | -2                 | -2 | -2 | -2 | -1 | -1 | -1 | -1 | -1 | 0 | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 2  | 2  | 2  | 2  |

Table 8-2. IPHD Compensation for EGSM Band

#### E. VCXO Calibration

#### - Purpose

This procedure aims to calibrate the value of DAC3 to establish a VCXO-frequency that is sufficiently close to 13 MHz at room temperature. It also ensures that the VCXO tuning range is sufficient, and that the temperature compensation table for VCXO is completed accordingly.

Note: The frequencies in this section are related to the 13 MHz VCXO-frequency.

Depending on the calibration procedure, the 13 MHz VCXO frequency can be acquired by first measuring an EGSM, DCS, or W-CDMA RF frequency at the antenna and then translating the measured frequency to the 13 MHz VCXO frequency.

- Procedure Proposal
- 1. Put the ME in switched low power TX mode with a modulated carrier on a mid channel. Use the calibrated value of the cap array and phase detector current.
- 2. Tune DAC3 in AB 2000 (VCXOCONT)to end and mid values, and check tuning range.

Acquire the following VCXO (13 MHz) frequencies:

fmin =13 MHz VCXO-frequency @DAC3=1

fmid =13 MHz VCXO-frequency @DAC3=1024

fmax =13 MHz VCXO-frequency @DAC3=2047

Note that it is necessary to translate the measured RF-frequency (EGSM,DCS,or W- CDMA)to the 13 MHz VCXO-frequency.

- 3. Acquire the ME temperature, TCal, from the temperature sensor in ME.
- 4. Store fmin,fmid,fmax and TCal for calculation.
- 5. Calculate the DAC-value, VCXOCONTCal, that gives zero frequency error at the mid channel, using piecewise linear interpolation, and store the value in the memory

(GD\_RF\_SYNT\_CONFIG\_ID and GD\_VCXO)

6. Calculate

 $K_LO = (fmid - fmin)/1023$ 

 $K_HI = (fmax - fmid)/1023$ 

Each value is then multiplied by 100 and rounded to nearest integer, with the results stored in the memory (GD\_RF\_SYNT\_CONFIG\_ID).

AFC\_DAC\_STEP\_LO =ROUND(100\*K\_LO)

AFC\_DAC\_STEP\_HI =ROUND(100\*K\_HI)

where ROUND(x)=x rounded to the nearest integer.

### F. TX Power Calibration

- Purpose

These procedures describe how to tune the different power levels of the power amplifier to output powers corresponding to values in GSM 05.05, and explain how to calculate intermediate power levels that will ensure a good power versus time performance.

- Procedure Proposal
- 1. Reset the DIRMOD-block, and select a, mid channel using the trimmed value on the capacity array for VCO tuning and a default IPHD value as phase detector current. Turn on dummy burst modulation.
- 2. Use the Multi-burst method to characterize the relation between output power and the DAC-value. Then store the DAC values that give the closest approximations to the power targets defined in Table 8-3.
- 3. To avoid yield problems with the power template and switching transients spectrum a margin to the compression point of the PA should be observed. However, the output power must be kept within the tolerances specified in Table 8-3.
- 4. Store DAC values in memory (GD\_FullPower\_Band).
- 5. Initiate the intermediate value calculation, which calculates and st or e t he values in memory (GD\_IntermediatePower\_Up/Down\_1.7\_Band).
- 6. The difference between the transmitter power at two adjacent power control levels, measured at the same frequency, shall not be less than 0.5 dB and not more than 3.5 dB.

| Parameter | Target Full Power (dBm) | Tolerances (dB) |     |
|-----------|-------------------------|-----------------|-----|
| PL 5      | 33.0                    | +0.5 – 1.0      | Vol |
| PL 6      | 31.0                    | ±0.3            | Vol |
| PL 7      | 29.0                    | ±0.5            | Vol |
| PL 8      | 27.0                    | ±0.5            | Vol |
| PL 9      | 25.0                    | ±0.5            | Vol |
| PL 10     | 23.0                    | ±0.5            | Vol |
| PL 11     | 21.0                    | ±0.5            | Vol |
| PL 12     | 19.0                    | ±0.5            | Vol |
| PL 13     | 17.0                    | ±0.5            | Vol |
| PL 14     | 15.0                    | ±0.5            | Vol |
| PL 15     | 13.0                    | ±0.5            | Vol |
| PL 16     | 11.0                    | ±0.5            | Vol |
| PL 17     | 9.0                     | ±0.5            | Vol |
| PL 18     | 7.0                     | ±0.5            | Vol |
| PL 19     | 5.0                     | ±0.5            | Vol |

**Table 8-3. Target Power Levels for EGSM** 

### G. RSSI and AGC Calibration

#### - Purpose

This procedure satisfies the two following requirements:

Calibrate an absolute power level on the antenna to a corresponding RSSI value. This value together with a pre-defined slope figure is then used to calculate the RSSI value of an arbitrary received antenna power. The formula y=kx+m is used. (Where k is the slope value, x the RSSI value, y the actual level, and m is an offset value.)

Calculate the attenuation when the Low Noise Amplifier is switched off in the receiver branch. The attenuation value is stored in the flash memory and used when very high input signals are fed into the ME.

- Procedure Proposal
- 1. Select switched receiver on a mid EGSM Channel.
- 2. Feed a modulated -68.5dBmsignal, on the same mid EGSM-Channel to the antenna input. Measure the RSSI value, calculate the RSSI table and store the value in GDFS as parameter: GD\_RXLEVS\_DBM\_BURST\_M\_BAND.
- 3. On the same channel, now feed a modulated -50dBmsignal and measure the RSSI value.

- 4. Switch off the LNA, using the command FREC=3,0,1, and measure the RSSI value.
- 5. Calculate the difference between on and off (converting the result to, real dB attenuation) and store the result in GD MPH RX AGC Parameters Band.

#### 8.3.4 DCS 1800 Calibration Items

### A. RXVCO Varactor Operating Point Calibration

Purpose

To adjust the variatordiode to a pre-determined operating point, so that the loop voltage of the RXVCO (measured with an ADC in AB 2000) is withinthe valid range. This is necessary to secure that all RX channels can be reached.

- Procedure Proposal
- 1. Put the ME in static RX mode.
- 2. Measure the loop voltage with the AB 2000 ADC for all CVCO settings, that is, 0 ~ 7. Find a CVCO value that fulfills the requirements on loop voltagefor low and high channel.
- 3. If there are several CVCO values that fulfill the loop voltage requirements, then the optimum CVCO value is the one that centers the loop voltage within the specified limits.
- 4. Store the selected CVCO in the memory. (GD BAND RX VCO Centre Frequency Adjustment)
- 5. Reset the radio.

### **B. TXVCO Varactor Operating Point Calibration**

- Purpose

To adjust the variatordiode to a pre-determined operating point, so that the loop voltage of the TXVCO (measured with an ADC in AB 2000) is within the valid range. This is necessary to secure that all TX channels can be reached.

- Procedure Proposal
- 1. Put the phone in static TX mode.
- 2. Measure the loop voltage with the AB 2000 ADC for all CVCO settings, that is,  $0 \sim 7$ . Find a CVCO value that fulfills the requirements on loop voltage for low and high channel.
- 3. If there are several CVCO values that fulfill the loop voltage requirements, then the optimum CVCO value is the one that centers the loop voltage within the specified limits.
- 4. Store the selected CVCO in the memory. (GD\_BAND\_TX\_VCO\_Centre\_Frequency\_Adjustment)
- 5. Reset the radio.

### C. TX Loop Bandwidth Calibration

- Purpose

The loop bandwidth is calibrated to match the pre-filtering of the modulation in DB 2000 by adjusting the phase detector current.

Note: This also indirectly adjusts the VCO gain that can otherwise notbe calibrated.

This will ensure a correct transfer function for the modulation and keep phase error to a minimum.

- Procedure Proposal
- 1. Put the ME in switched TX mode on mid channel in frequency interval 11 for DCS (with random modulation).
- 2. Measure the RMS phase error at the RF connector.
- 3. Tune the phase detector current (IPHD) until the phase error is minimized. If two IPHD settings gave the same RMS, choose the lowest value. Measure 10 bursts for each value.
- 4. Calculate and store the IPHD values in GDFS (GD\_IPHD\_8Temperature\_and\_24Channel\_Compensation\_Band)
- 5. The offsets in the table are steps in the IPHD Table 8.4 and all offsets refer to the calibrated value (Trim) at mid channel in room temperature.

|   | Frequency Interval |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |
|---|--------------------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
|   | 0                  | 1  | 2  | 3  | 4  | 5  | 6  | 7  | 8  | 9  | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 |
| 0 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 1 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 2 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 3 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 4 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 5 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 6 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |
| 7 | -6                 | -6 | -5 | -4 | -4 | -3 | -3 | -2 | -2 | -1 | -1 | 0  | 0  | 1  | 1  | 2  | 2  | 3  | 3  | 4  | 4  | 5  | 5  | 5  |

Table 8-4. IPHD Compensation for DCS Band

#### **D. TX Power Calibration**

#### - Purpose

To tune the different DCS power levels of the power amplifier tooutput powers corresponding to values in GSM 05.05 and calculate the intermediate levels that ensure a good power versus time performance.

- Procedure Proposal
- Reset the DIRMOD-block, and select a "mid channel using the trimmed value on the capacity array for VCO tuning and a default IPHD value as phase detector current. Turn on dummy burst modulation.
- 2. Use the Multi-burst method to characterize the relation between output power and the DAC-value. Then store the DAC values that give the closest approximations to the power targets defined in Table 8-5.

### 8. CALIBRATION

- 3. To avoid yield problems with the power template and switchingtransients spectrum a margin to the compression point of the PA should be observed. However, the output power must be kept within the tolerances specified in Table 8-5.
- 4. Store DAC values in memory (GD\_FullPower\_Band).
- 5. Initiate the intermediate value calculation, which calculatesand store the values in memory (GD\_IntermediatePower\_Up/Down\_1.7\_Band).
- 6. The difference between the transmitter power at two adjacent power control levels, measured at the same frequency, shall not be less than 0.5 dB and not more than 3.5 dB.

| Parameter | Target Full Power (dBm) | Tolerances (dB) |     |
|-----------|-------------------------|-----------------|-----|
| PL 0      | 30.0                    | +0.5 – 1.0      | Vol |
| PL 1      | 28.0                    | ±0.3            | Vol |
| PL 2      | 26.0                    | ±0.5            | Vol |
| PL 3      | 24.0                    | ±0.5            | Vol |
| PL 4      | 22.0                    | ±0.5            | Vol |
| PL 5      | 20.0                    | ±0.5            | Vol |
| PL 6      | 18.0                    | ±0.5            | Vol |
| PL 7      | 16.0                    | ±0.5            | Vol |
| PL 8      | 14.0                    | ±0.5            | Vol |
| PL 9      | 12.0                    | ±0.5            | Vol |
| PL 10     | 10.0                    | ±0.5            | Vol |
| PL 11     | 8.0                     | ±0.5            | Vol |
| PL 12     | 6.0                     | ±0.5            | Vol |
| PL 13     | 4.0                     | ±0.5            | Vol |
| PL 14     | 2.0                     | ±0.5            | Vol |
| PL 15     | 0.0                     | ±1              | Vol |

**Table 8-5.Target Power Levels for DCS** 

#### E. RSSI Calibration

#### - Purpose

This procedure calibrates an absolute power level on the antennaagainst a corresponding RSSI value. This value together with a pre-defined slope figure is then used to calculate the RSSI value of an arbitrary received antenna power. The formula y=kx+m is used. (Where k is the slope value, x the RSSI value, y the actual level, and m is an offset value).

- Procedure Proposal
- 1. Select switched receiver on a mid DCS-Channel.
- 2. Feed a modulated -68.5dBmsignal, on the same mid DCS Channel to the antenna input. Measure the RSSI value, calculate the RSSI table, and store it to the memory (GD\_BAND\_RXLEVS\_DBM\_BURST\_M[2]) -1 byte.

#### 8.3.5 WCDMA Calibration Items

### A. RF VCO Center Frequency Calibration

- Purpose

This procedure is designed to calibrate the RFVCO (Radio Frequency Voltage Controlled Oscillator) center frequency of the Ericsson RF 2110 (hereafter referred to as the RF 2100) and ensure that all channels can be reached with sufficient margin.

The objective of the calibration is to determine a CVCO (Center VCO) value that guarantees the functionality of the RFLO (Radio Frequency Local Oscillator).

- Procedure Proposal
- 1. Start the VCXO and RFVCO. VCXOCONT is set to its calibrated value, Ericsson AB 2000 DAC3.
- 2. Measure the loop voltage (WRFLOOP), with the AB 2000 ADC (GPA4), for all CVCO settings, that is, 0-7. Find a CVCO value that fulfills the requirements on loop voltage for low and high channel. If there are several CVCO values that fulfill the loop voltage requirements, then the optimum CVCO value is that that centers the loop voltage within the specified limits.
- 3. Store the calibrated CVCO value in GD\_RF\_SYNT\_CONFIG\_ID.

## **B. TX Carrier Suppression Calibration**

- Purpose

DC offset compensation the carrier, to the wanted signal at the IQ-modulator output.

The leakage is caused by imperfections in the basebandIQ-path and inside the IQ-modulator. It impairs the modulation accuracy and results in a high vector magnitude (EVM). The outcome of the calibration is values for RECDCI and RECDCQ that minimize the carrier.

- Procedure Proposal
- Set the ME in TX mode on mid-channel. Use typical TX settings. Generate 960 kHz square-wave on both I and Q with amplitude = 8 (sine-wave could be used instead).

Start with the best value from earlier calibrated units on RECDCI on RECDCQ.

- 2. Measure the relative power between the 1950 MHz carrier and 1949.04 MHz at the antenna output. Jump to step 6 if the requirement is met.
- 3. Step RECDCI from 0 to 3. Set TXON = 0 and wait 1 ms before changing RECDCI from 3 to 5. Set TXON = 1, wait 1 ms and continue with stepping from 5 to 7.
- 4. Set RECDCI to the value that minimizes the 1950 MHz carrier. If this involves a change of sign the TXON switching and delay sequence in point 3 must be executed. Jump to 6 if the requirement is met
- 5. Find and set RECDCQ to the value that minimizes the 1950 MHz carrier. This can be made by stepping RECDCQ from 0 to 7 with the TXON switching and delay sequence in step 3.
- 6. If the requirements are not met, repeat steps 3, 4 and, if necessary, 5 once with the new RECDCI and RECDCQ (found in 4 and 5) as initial values. Otherwise proceed with step 6.
- 7. Save the finaldBcvalue (for statistics), RECDCI and RECDCQ. Store the calibrated parameters in GD\_RF\_TX\_CONFIG\_ID.

## C. TX LPF Bandwidth Calibration

#### - Purpose

The low pass filters within the Ericsson DB 2100 (hereafter referred to as DB 2100) are designed to prevent spurious emissions output from the TX IQ-D/A (Digital-Analog) converters Œ without adversely affecting the signal or causing a deterioration of the modulation accuracy.

The objective of this calibration is to determine the values for LPQ and LPBW that offer the best trade off against the system-related requirements. These settings determine the cut-off frequency and should always have the same value.

- Procedure Proposal
- 1. Use typical TX settings. Generate a 960 kHz square-wave at baseband without phase shift between I and Q. The amplitude should be about 50% of fullscale.
- 2. Measure the relative power between 1952.88 MHz (fc+ 3\*960 kHz) and 1949.04 MHz (fc Œ 960 kHz) in dB at the antenna output. Find the setting of LPQ =LPBW between 3 and 15 that obtains the dBcvalue closest to the typical value. Start with the best value from earlier calibrated units. Spectrum analyzer settings (example):
  - RBW = 300 kHz, Span = 8 MHz.
- 3. Set LPQ=LPBW to the found value in 2. Also save thedBcand the decided LPQ = LPBW value for statistics. Store the calibrated parameters in GD\_RF\_TX\_CONFIG\_ID.

## **D. TX Maximum Output Power Calibration**

### - Purpose

These procedures verify that the ME can meet the requirements onmaximum output power. The calibration aims to establishWPABias, VGA and QVGA settings that fulfill ACLR requirements for maximum output power, both in high, medium, and low gain mode.

These calibrations are designed to conform to the ME maximum output power and ACLR requirements specified in 3GPP Spec TS34.121.

- Procedure Proposal
- 1. Use typical TX settings, mid channel.
- 2. Set gain to the best value based upon previous calibrated units.

- 3. Measure output power as broadband power.
- 4. If the ACLR requirements, described in Table 11 are not met, calculate the test step necessary to achieve the correct power. Use correlation from earlier calibrated units to calculate the new gain setting (default correlation between VGA and output power is 1 dB and for QVGA 0.25dB).
- 5. Measure ACLR at this power level.
- 6. If the ACLR requirement is not met, reduce VGA and QVGA.
- 7. Measure and store the temperature at this point. This provides the value forTPmax.
- 8. This power and gain setting is to be used in calibration of TX power table.
- 9. Set gain to maximum power in medium gain mode and measure ACLR at this power level.RFBiasshould be set to 1 andWPABiasshould be set to the same value as for maximum output power.
- 10. If the requirements are not met, step the gain down and measure ACLR until the requirements are met. The correlation between ACLR and output power is that 1 dB in power equals typical 3 dB in ACLR. Use correlation from earlier calibrated units to calculate the new gain setting.
- 11. This power, Pmax measMG, is input to the calibration of TX power table.
- 12. Set gain to maximum power in low gain mode and measure ACLR at this power level. RFBiasshould be set to 1 andWPABiasshould be set to the same value as for maximum output power.
- 13. If the requirements are not met, step the gain down and measure ACLR until the requirements are met. Use known correlation from earlier calibrated units to calculate the new gain setting.
- 14. This power, Pmax measLG, and gain setting provides input to the calibration of TX power table.

#### E. TX Power Table Calibration

#### - Purpose

The calibration data contained within the TX Power Table controls the gain for all types of power change; including, the inner-loop power control and maximum output power of the platform.

The purpose of this calibration is to complete the TX Power gain table with values for VGA, QVGA, RFBIAS, WPABias, and WDCDCREF that meet the specified requirements for inner-loop power-control and Maximum output power. The size of hysteresis area must also be found.

These calibrations are designed to conform to the ME maximum output power, inner loop power control, change of TFC and (PRACH preamble tolerances)requirements specified in 3GPP Spec TS34.121.

#### - Procedure Proposal

This calibration consists of two parts: first measurements and then an off-line calculation. The measurement results are used for characterizing the hardware so that proper settings can be calculated for all tables. Settings and limitations are also used from maximum output calibration.

- 1. Perform measurements
- (1) VGA behavior in LG (Low Gain) mode. PABias should not be offset and RFBIAS should be 1.
- (2) VGA behavior in MG (Medium Gain mode). PABias should not be offset and RFBIAS should be 1.
- (3) QVGA behavior in LG mode
- (4) IQ-Gain behavior in LG mode.
- (5) WPABias gain step size. Every eighth setting is measured twice. For better accuracy take the average of each step pair. Interpolate the gain steps in between the averaged measured values.

- (6) WDCDCREF gain step size. Every fifth setting is measured twice. For better accuracy take the average of each step pair. Interpolate the gain steps in between the averaged measured values.
- (7) Size of step between LG/MG and MG/HG and between each setting of RFBIAS (1-7). The main purpose is to find the relative difference at different frequencies. Distribute with equal frequency offset except if there are known ,worst-case frequencies. Measured at 5 channels, maximum and minimum steps reported. Average value of minimum and maximum should be used in following calculations.
- (8) Measure properties: Measure the following properties using a modulated signal: WPA-gain expansion versus output power on mid channel. Compensation needed for maximum output power over the band (13 channels).
- 2. Perform offline calculations
- (1) Calculate the compensation values for Table 8-6. Store these values in GD\_RF\_TXGAIN\_TB\_SEL\_ID.
- (2) Extract the range of needed compensation tables (minimum and maximum).
- (3) Calculate the expected compensation for each table in dB (use ,table 0 for the table that is ,0 dB or closest to ,0 dB) and spread out the rest to achieve equidistant compensations.
- (4) Calculate and store the 24 sets of tables, GD\_RF\_TX\_GAIN\_TB0\_ID to

GD\_RF\_TX\_GAIN\_TB23\_ID. Each set of tables shall include:

One High-gain table: 44 bytes.
One Low-gain table: 44 bytes.
One RFBias table: 22 bytes.
One WDCDCRef table: 44 bytes.
One WPABias table: 44 bytes.

One value for IQ-Gain: 1 bit (will occupy 1 byte).

One value for TABLE\_OVERLAP: 1 byte. One value for UPPER\_LIMIT: 1 byte.

- (5) Calculate the actual compensation (for maximum output power) that each of these 24 tables will give. Store this in GD\_RF\_TX\_FREC\_INT\_ID.
- 3. Store data in GDFS

| Temp. |      |      |      |      |      | ι    | JARFCI | N    |      |      |      |      |
|-------|------|------|------|------|------|------|--------|------|------|------|------|------|
|       | 9612 | 9637 | 9662 | 9687 | 9712 | 9737 | 9763   | 9788 | 9813 | 9838 | 9863 | 9888 |
| -15   |      |      |      |      |      |      |        |      |      |      |      |      |
| 0     |      |      |      |      |      |      |        |      |      |      |      |      |
| 15    |      |      |      |      |      |      |        |      |      |      |      |      |
| 30    |      |      |      |      |      |      |        |      |      |      |      |      |
| 45    |      |      |      |      |      |      |        |      |      |      |      |      |
| 60    |      |      |      |      |      |      |        |      |      |      |      |      |
| 75    |      |      |      |      |      |      |        |      |      |      |      |      |
| 90    |      |      |      |      |      |      |        |      |      |      |      |      |

**Table 8-6.The Complete Gain Compensation Table** 

## E. TX Open Loop Power Control Calibration

#### - Purpose

The purpose of the calibration of open loop power control is to store parameters for the Open Loop Power Control algorithm. This is a pure off-line calculation. Use data (positions and output power, in dBm) from table 0. Curve fitting should be done preferably with minimum square method.

System related requirements:

Open loop power control

Maximum allowed UL TX Power

**UE** Transmitted power

- Procedure proposal
- 1. Create a curve fitting for the low-gain region, use positions with a power greater than -50 dBm:

  Position = B3 \* Pout + A3
- 2. Extract A3 and B3.
- 3. The power level (output power) at the highest position in the low-gain region sets the parameter P2.
- 4. Divide the high-gain region into two regions at the split between mid-gain and high-gain. The output power at this position sets the parameter P1.
- 5. Do a curve fitting for the mid-gain region (where RFBias > 0) of the high-gain region, use power-levels from P2: Position = B2 \* Pout + A2
- 6. Extract A2 and B2
- 7. Do a curve fitting for the high-gain region (where RFBias = 0) of the high-gain region: Position = B1 \* Pout + A1
- 8. Extract A1 and B1
- 9. Save A1, A2, A3, B1, B2, B3, P1 and P2 in GD\_RF\_TX\_GAIN\_PARAM\_ID.

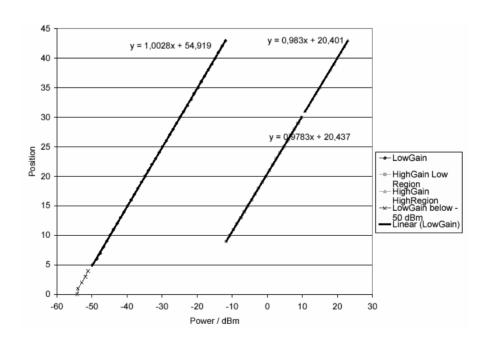


Figure 8-2. Example of Position versus Power and Calculated Equations

#### F. RX LPF Bandwidth Calibration

#### - Purpose

This procedure calibrates the LPF bandwidth. The bandwidth of the channel filters will affect system parameters as reception sensitivity and adjacent channel selectivity. The procedure also verifies that the IF-filter is properly matched.

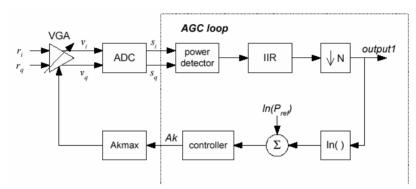


Figure 8-3. AGC Block Diagram (Parameter Ak, Output1, and Pref)

- Procedure Proposal
- 1. Feed a CW carrier at 2140 MHz with a power of -60dBm into the antenna connector.
- 2. Set UE in RX-mode on 10695ch.
- 3. Set the AGC\_UL and AGC\_LL to minimum. GLNA is forced to high gain mode.
- 4. Set RF 2110 LPQ and LPBW to 8, that is, LPQ=LPBW=8.
- 5. Get Ak (output2) from N slots. Calculate Average\_Ak (Ak\_IB) according to the equation below. N should be as large as possible, with respect to time consumption.

Average 
$$Ak = 10 \cdot \log \left( \frac{1}{N} \sum_{n=1}^{N} 10^{\frac{Ak_n}{10}} \right)$$

Equation 1

- 6. Set UE on 10705ch and get Ak (output2). Calculate Average\_Ak (Ak\_LB) according to the Equation 1.
- 7. Calculate IF-filter symmetry using the following equation.

- 8. Set UE on 10685ch and get Ak (output2). Calculate Ak (Ak\_OB) according to the Equation 1.
- 9. Calculate selectivity level using following equation.

$$Ak SE = Ak OB - Ak IB$$

- 10. If the requirement is not met, decrease LPBW and LPQ one step and repeat from 8.
- 11. Store the resulting LPBW and LPQ in GD RF RX CONFIG ID.

## F. RX LNA Gain Switch and AGC Hysteresis Calibration

#### - Purpose

This procedure calibrates the gain correction parameter of Ak in the AGC algorithm between GLNA=0 and GLNA=1; that is, it establishes the gain difference in the LNA between high gain mode and low gain mode. It also calibrates AGC\_UL and AGC\_LL, the upper and lower Ak values where the AGC should switch between high and low LNA gain (AGC hysteresis).

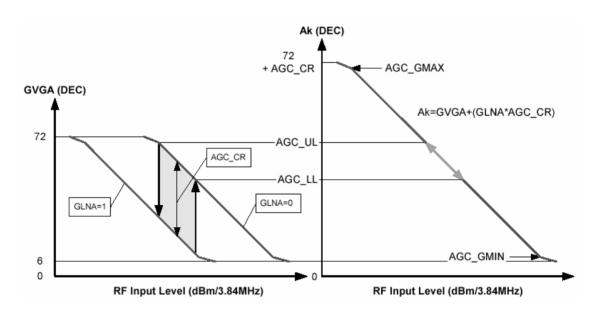


Figure 8-4. LNA Gain Switch and AGC Hysteresis Parameters

- Procedure Proposal
- 1. Set the UE in RX-mode on 10695ch.
- 2. Feed a CW carrier at 2140 MHz with a power level of -65dBm.
- 3. Set the AGC\_UL and AGC\_LL to maximum. GLNA is forced to low gain mode.
- 4. Get average Ak from Equation 1 and save it. (Ak LG)
- 5. Set the AGC\_UL and AGC\_LL to minimum. GLNA is forced to high gain mode.
- 6. Get average Ak. (Ak\_HG)
- 7. (Ak\_LG) (Ak\_HG) = (Correction).
- 8. Round off (Correction) to integer (AGC\_CR) and store it in GDFS (GD\_RF\_RX\_CONFIG\_ID). AGC\_CR is an AGC algorithm parameter and is set to DB 2100 RFIF.
- Calculate AGC\_LL=8+AGC\_CR and AGC\_UL=18+AGC\_CR and store them in GDFS (GD\_RF\_RX\_CONFIG\_ID). AGC\_LL and AGC\_UL are AGC algorithm parameters and are set to DB 2100 RFIF.

## G. RX AGC Gain Max and RX RSSI Calibration

- Purpose

To prevent wind up in AGC algorithm, this procedure calibrates the absolute power levels at the antenna connector against RSSI values and the maximum gain setting for AGC. Reference [6] specifies that the reporting range of the RSSI should be between -100 dBm to -25 dBm. The specified accuracy requirement is applied to the received power from -94 through -50 dBm. This is the last RX calibration.

LPBW, LPQ, AGC\_CR, AGC\_LL and AGC\_UL must be calibrated according to above calibrations respectively and applied to this calibration. Initially, the AGC anti-wind up is turned on using AGC\_GMAX=127. Use the calibrated value after step 2, otherwise the AGC wind up may occur at the beginning of the RSSI calibration.

- Procedure Proposal
- 1. Set the ME in RX-mode on channel 10695.
- 2. Feed a CW carrier at 2140 MHz with a power level of -105 dBm. Get average\_Ak (output2), add 6 to the value and store it in GDFS as AGC\_GMAX (GD\_RF\_RX\_CONFIG\_ID), rounded off to an integer. Set the AGC parameter AGC\_GMAX to the calibrated value.
- 3. Clear Ak .table 0.
- 4. Change the CW carrier power level to -95 dBm.
- 5. Read Ak value (output2) and calculate Average\_Ak (Equation 1). Store Pin\_Corrected (Equation 2) at Ak=round(Average\_Ak). N in Equation 1 should be as large as possible.

Pin Corrected = Pin-round(Average Ak)+Average Ak Equation 2

- 6. Then increase the output level of the signal generator to -80, -60, -40 and -25 dBm and store the corrected RF input level and Ak to the memory respectively.
- 7. Use the average Ak values and Pin\_Corrected from the two lowest power levels (-95 and -80 dBm) to extrapolate Ak and Pin\_Corrected for -110 dBm according to:

Average\_Ak\_110 = 2\*Average\_Ak\_95 - Average\_Ak\_80 Pin Corrected 110 = Pin Corrected 95 - Pin Corrected 80

- 8. Store Average Ak 110 and Pin Corrected 110 according to step 4.
- 9. Perform the interpolation. AK\_BANK\_SEL in DB 2100 shall be set to 0.
- 10. Measure the ME temperature (T) and save for offline calculations.
- 11. Store the result to GDFS. (GD\_RF\_RX\_AK\_TB0\_ID). When stored in GDFS, the first position in the table (Ak=0) should be replaced with the table number (0-23) in bcd format and the second position (Ak=1) set to 0xffff to flag that the table is calibrated. Position 2 to 5 should be set to zero.
- 12. Perform the offline calculations and check the requirements.

## 8.3.6 Baseband Calibration Item

# A. Battery Voltage Calibration

#### - Purpose

Calibrates the voltage table for the power management functionality. Some voltage measurements in the remaining test will be done with calculated voltage levels from this test.

- Procedure Proposal
- 1. Send the command LVBA=0 to reset local values in Test Program.
- 2. Set voltage on VBATT to 3.20 V.
- 3. Send the command LVBA=5,0x140 to read the low voltage level from ADC.
- 4. Set voltage on VBATT to 4.10 V.
- 5. Send the command LVBA=5,0x19A to read the high voltage level from ADC.
- 6. Send the command LVBA=1 to store local values into global data.
- 7. Send the command LVBA=3 to view and record values stored in global data.

| Voltage Level on VBATT (V) | Min. | Тур. | Max. | Unit |
|----------------------------|------|------|------|------|
| 3.2                        | 19   | 2E   | 3C   | HEX  |
|                            | 25   | 42   | 60   | DEC  |
| 4.1                        | 64   | 7E   | 96   | HEX  |
|                            | 100  | 125  | 150  | DEC  |

**Table 8-7. Battery Voltage Calibration Limits** 

# 8.4 Program Operation

## 8.4.1 XCALMON Program Overview

When you try to calibrate the U8100 mobile phone, you should make a configuration of calibration environment like Figure7-1. And if you finish making configuration, please execute the XCALMON program. Running the XCALMON program, you should show XCALMON program window like Figure7-5.

If XCALMON program would be executed, it checks the connection of instruments and initializes them automatically. The result of checking and initializing instruments was shown like Figure 7-6.

XCALMON supports three functions.

- Calibration of EGSM 900, DCS 1800, and WCDMA band
- Instrument (Agilent8960, Tektronix PS2521G) control
- UART communication with U8100 mobile phone

XCALMON has three windows and each window support different function.

- ITP(Integrated Test Program) starting window using production loader
- Calibration tree window
- Command window which supports interactive ITP commands like Hyper terminal

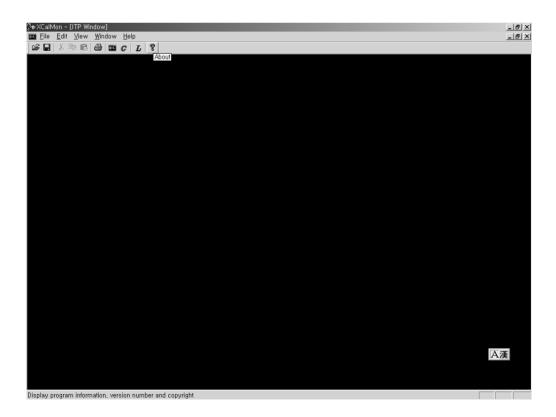


Figure 8-5. XCALMON Window

## 8.4.2 XCALMON Icon Description

#### A. DOS Window Icon

When you click the DOS window icon, then you should see the ITP command window like DOS window of DOS-operating system. In ITP command window, you should communicate with U8100 mobile phone which is running in ITP mode.

For example, if you will enter command "VERS" and enter the return key, you should get the response of the present running ITP version information from U8100 mobile phone.

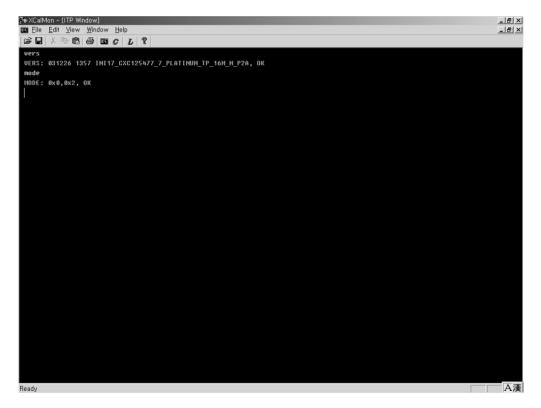


Figure 8-6. XCALMON ITP Command Window

## **B. Calibration Tree Window Icon**

When you click the calibration window icon "C", then you should see the calibration tree window. That will be shown all calibration items. If you want to calibrate U8100 mobile phone for all calibration items, you should select "Calibration" and push "F4" button in your keyboard.

Also there are four tap view in calibration window.

- OUTPUT : All results of calibration
- STATUS: Summary of calibration result
- INSTRUMENT : Control and view instrument connection status
- UART : Control and view UART connection status

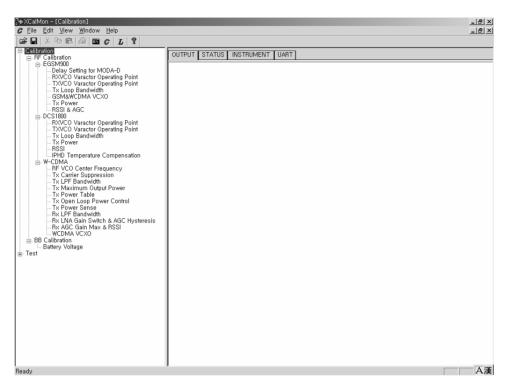


Figure 8-7. XCALMON Calibration Tree Window (OUTPUT Tab)

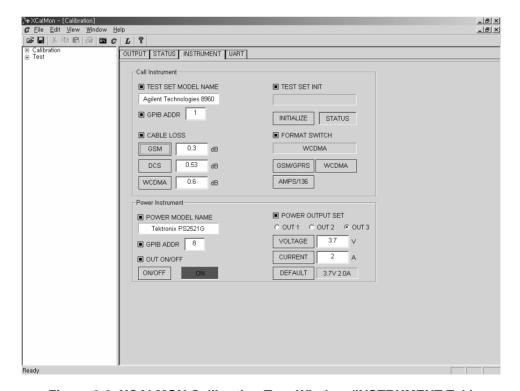


Figure 8-8. XCALMON Calibration Tree Window (INSTRUMENT Tab)

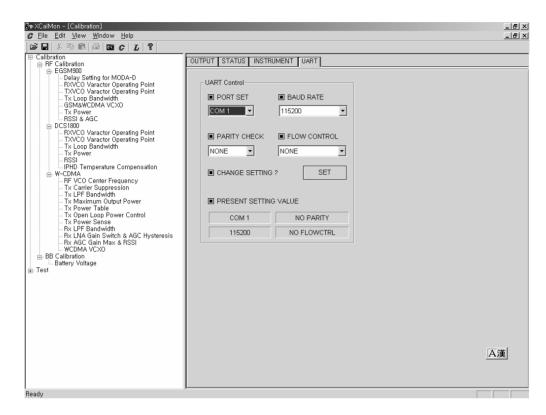


Figure 8-9. XCALMON Calibration Tree Window (UART Tab)

# C. ITP Starting Window Using Production Loader

When you click the ITP starting window icon"L", then you should see the ITP starting window. That dialog window just wait for power-on of U8100 mobile phone. When it will occur power-on, it automatically start ITP running.

If you want to change the start address of ITP, you could change that address directly.

To change ITP start address is possible when we download "Production loader" previously.

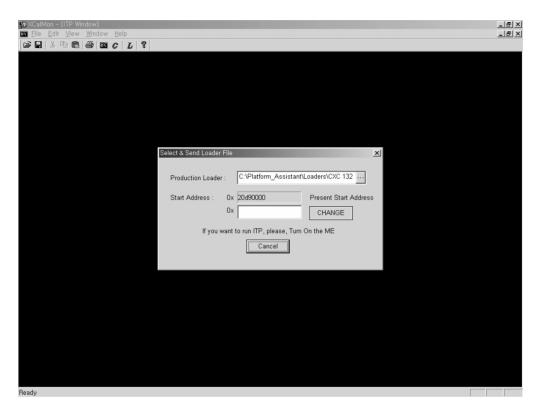


Figure 8-10. XCALMON ITP Starting Window (Using Production Loader)

### 8.4.3 Calibration Procedure

Calibration procedure of XCALMON was the same as below procedure.

- Configuration of calibration
- Running ITP using production loader
- Calibration start using XCALMON
- Verification of calibration result

## A. Configuration of Calibration

Configure to calibrated U8100 mobile phone like Figure 7-1. If configuration will be accomplished, start XCALMON program.

# **B. Running ITP Using Production Loader**

If XCALMON will be executed, you should run ITP using "L" ITP starting icon at first.

Click the "L" icon, then you will see the ITP start window like Figure7-10.

When you will turn on the U8100 mobile phone, the production loader will be downloaded automatically like Figure 7-11 and then it will execute the ITP at once.

If the ITP will operate normally, you should see the characters "TP, OK" in ITP command window like Figure 7-12.

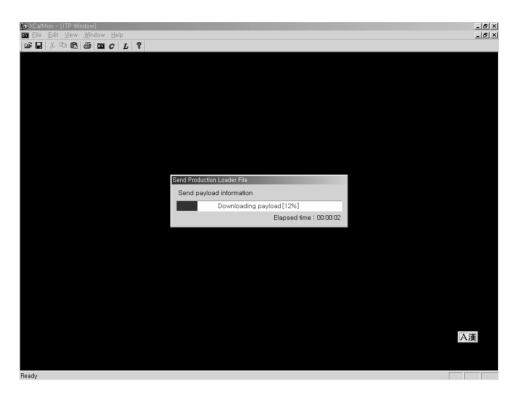


Figure 8-11. Production Loader Downloading



Figure 8-12. ITP Start Complete Window

## C. Calibration Start Using XCALMON

If you want to calibrate U8100 mobile phone, click the calibration icon "C".

And then you will see the calibration tree window like Figure 7-6.

To start calibration, you should select "Calibration" item and push "F4" button in your keyboard.

## D. Verification of calibration result

If the calibration will be ended, you will see several message window and the result of calibration through OUTPUT & STATUS tab view.

The detail explanation of those will be described in chapter 7.4.4

## 8.4.4 Calibration Result Message

If the calibration is over without error, "PASS" message window will show up like Figure 7-13. On the contrary, if the calibration is over with some error, "FAIL" message window will show up like Figure 7-14. Additionally, in all of the cases, it is possible to check the calibration result with OUTPUT & STATUS tab view.

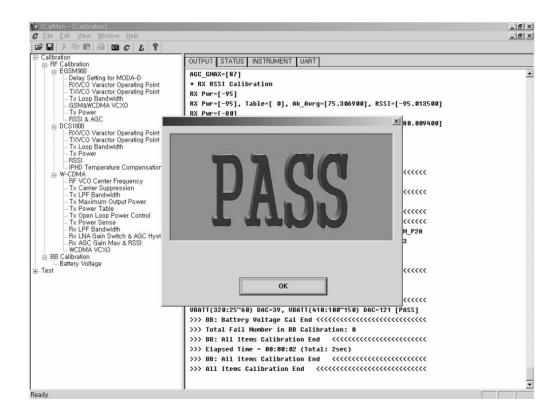


Figure 8-13. Calibration PASS Message Window



Figure 8-14. Calibration FAIL Message Window

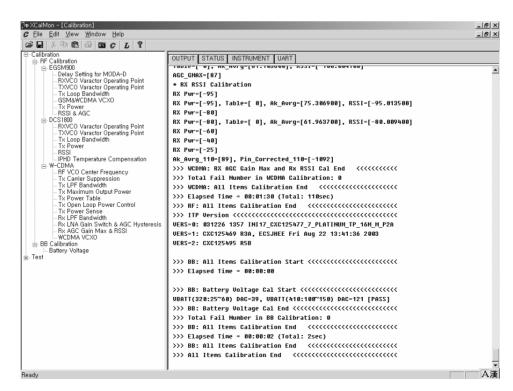
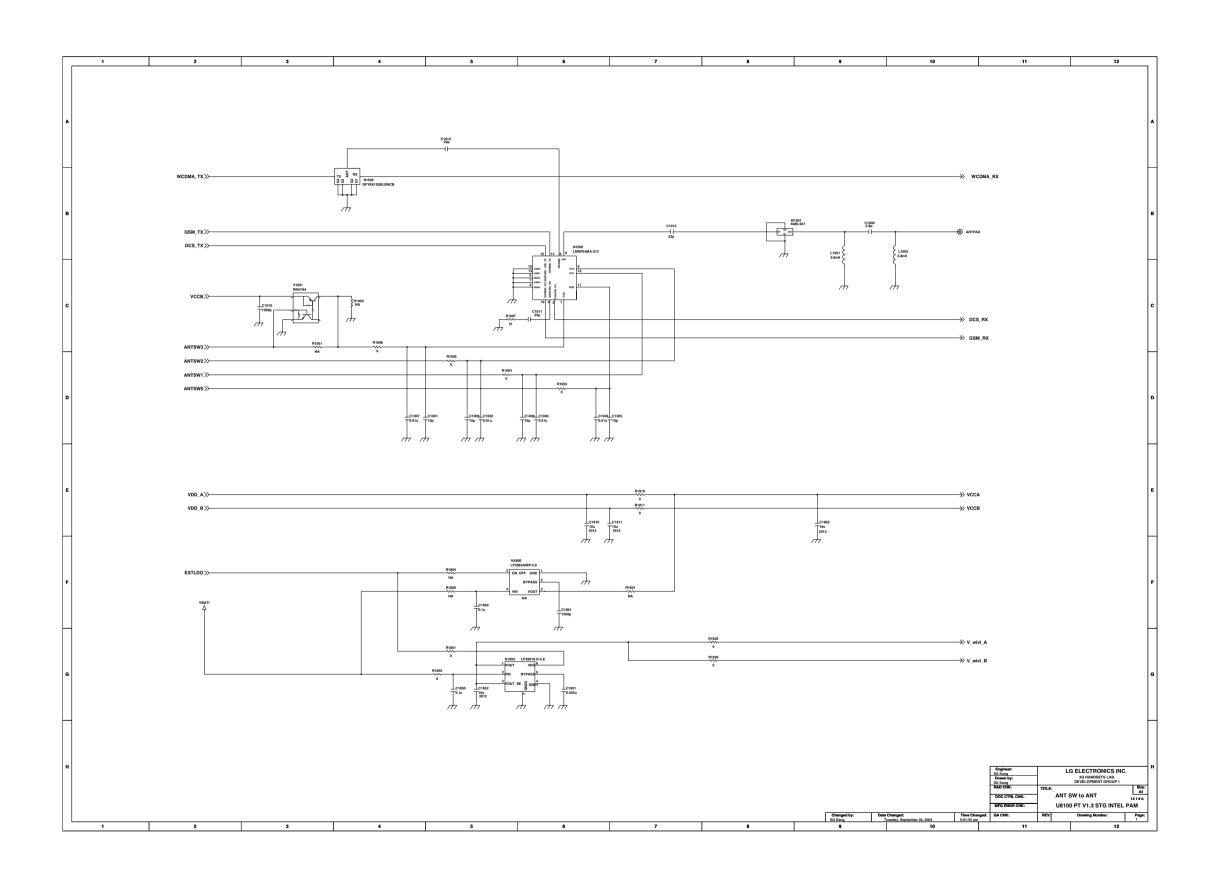
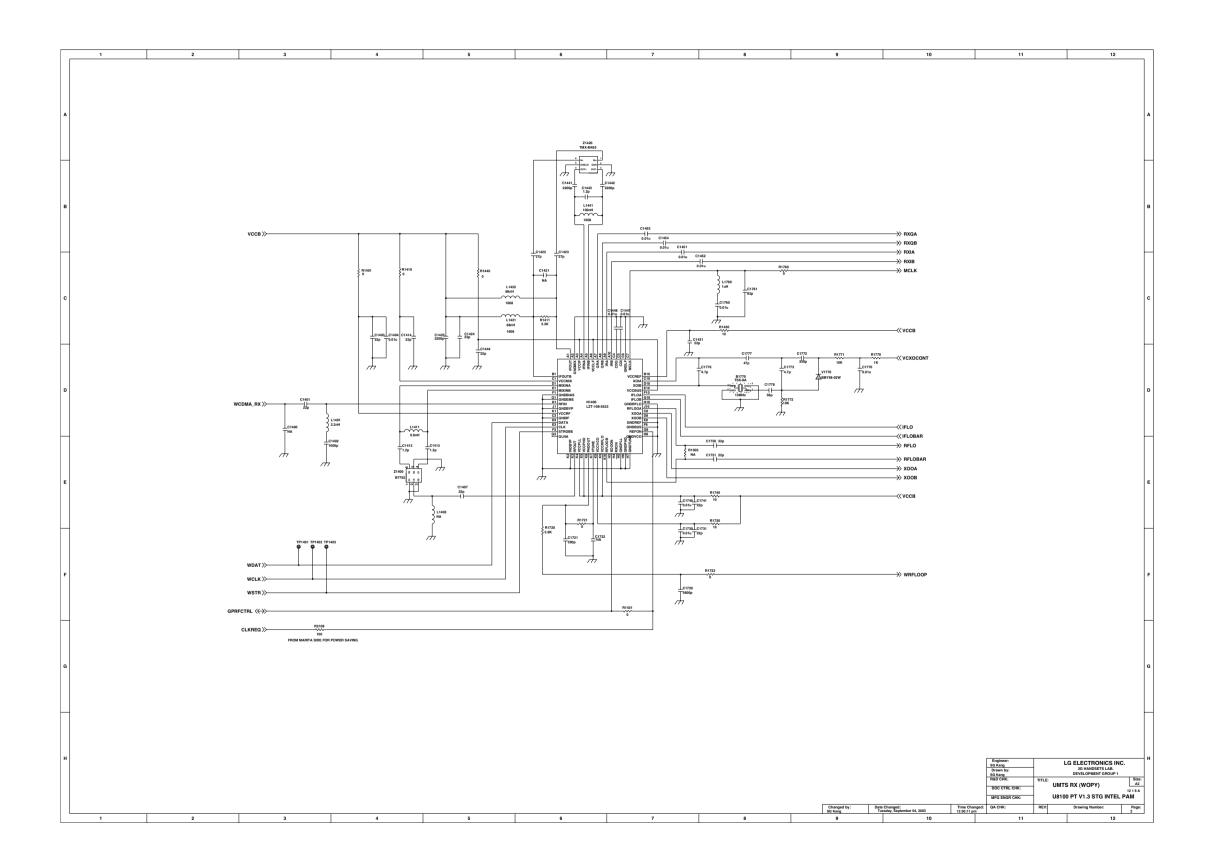


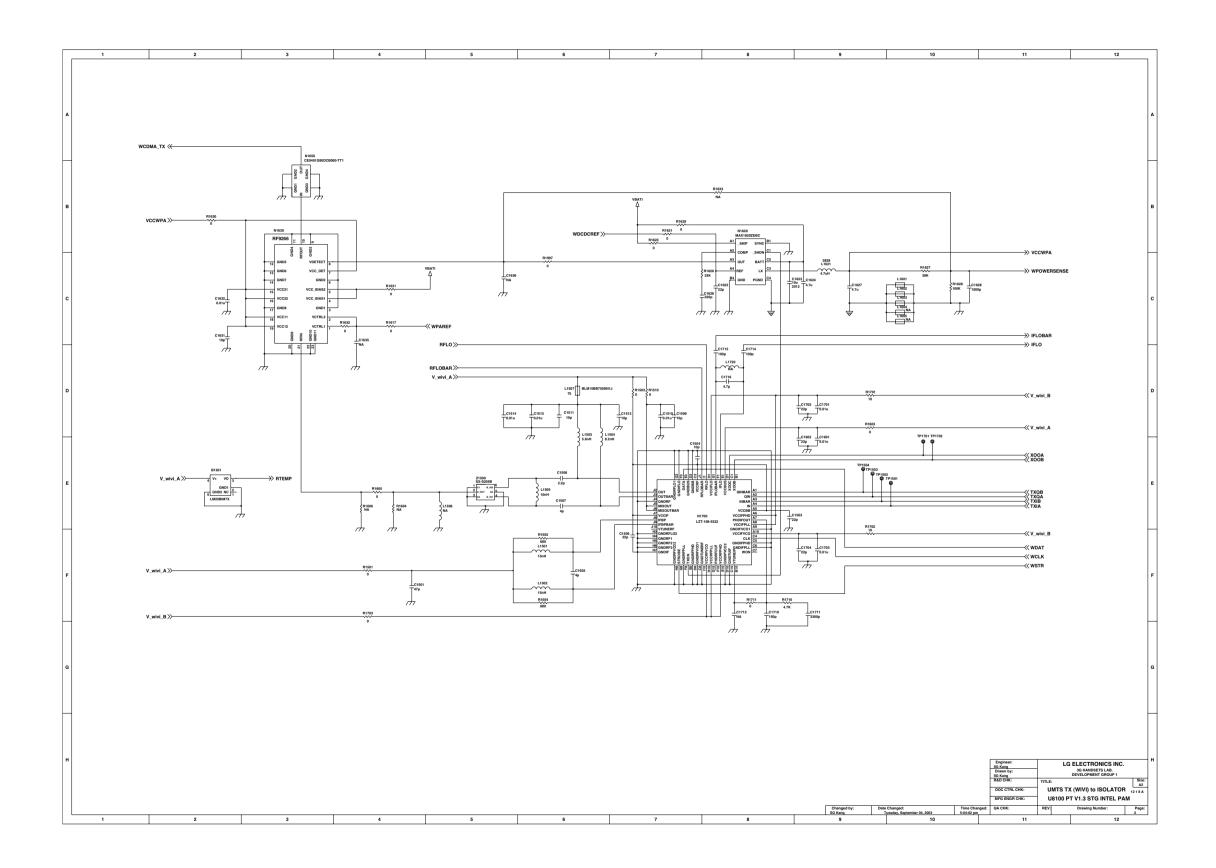
Figure 8-15. Calibration Result from OUTPUT Tab View

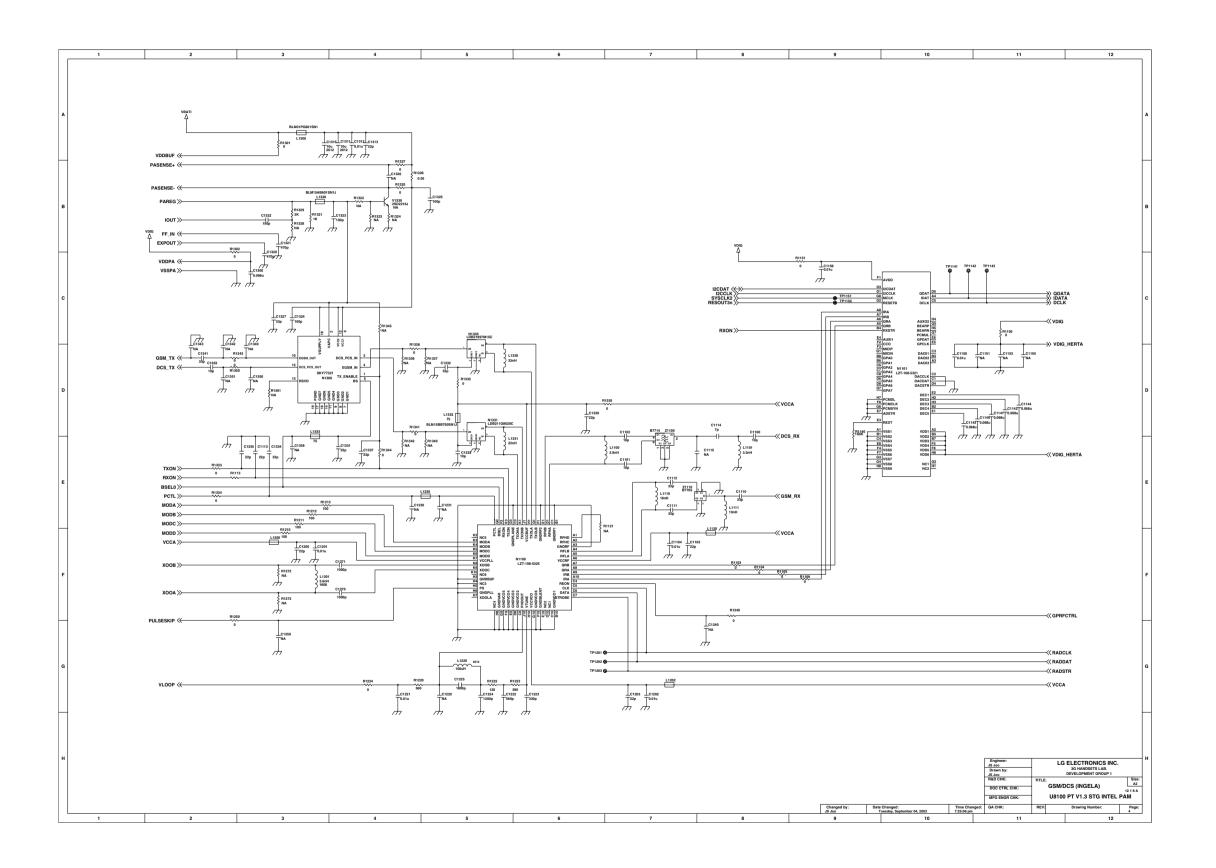


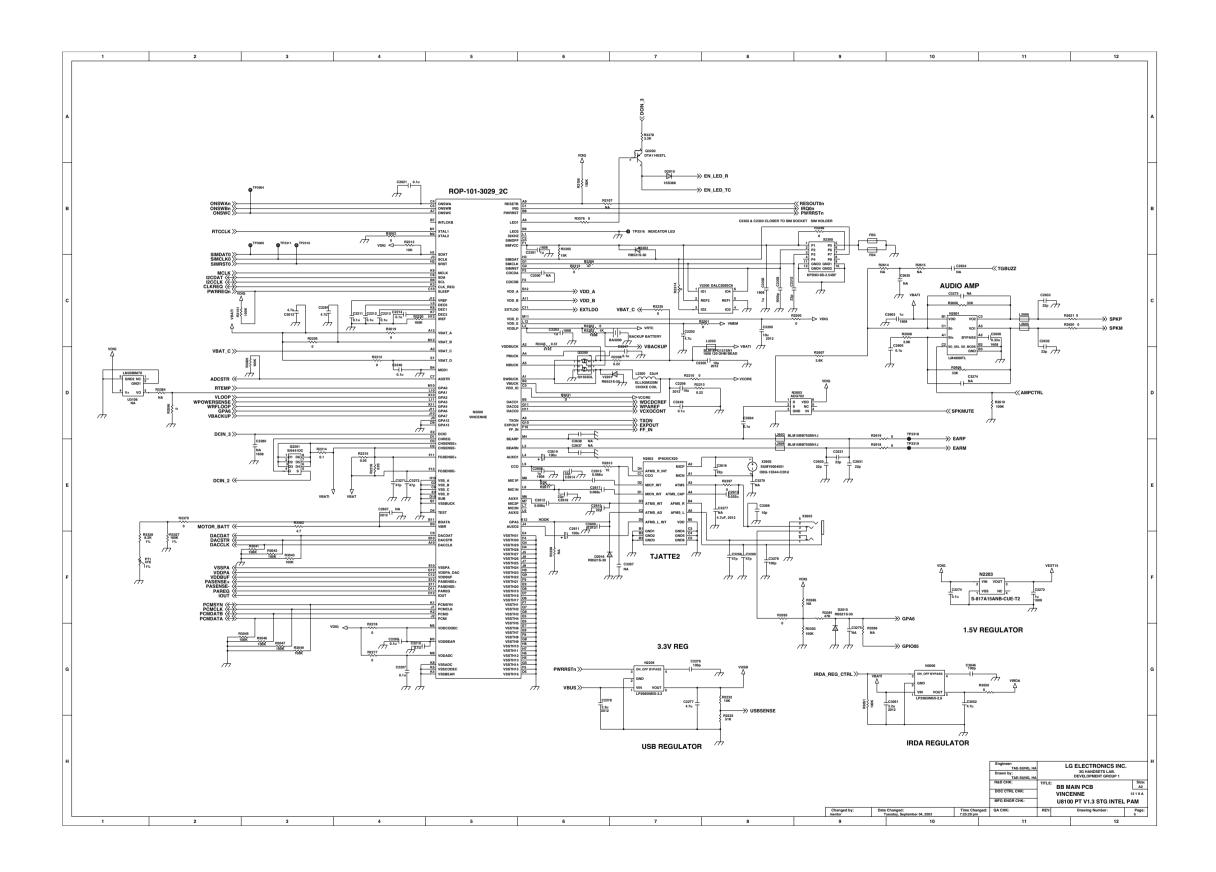
Figure 8-16. Calibration Result from STATUS Tab View

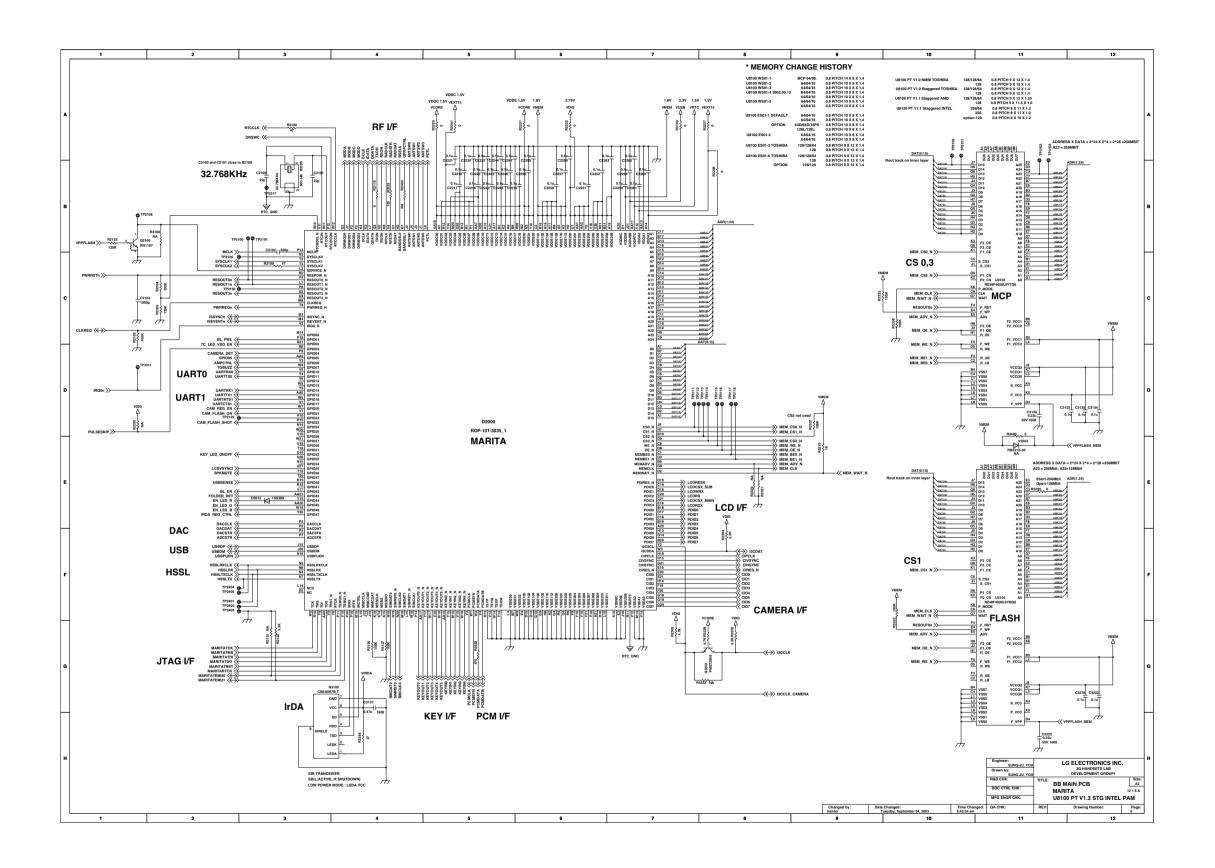


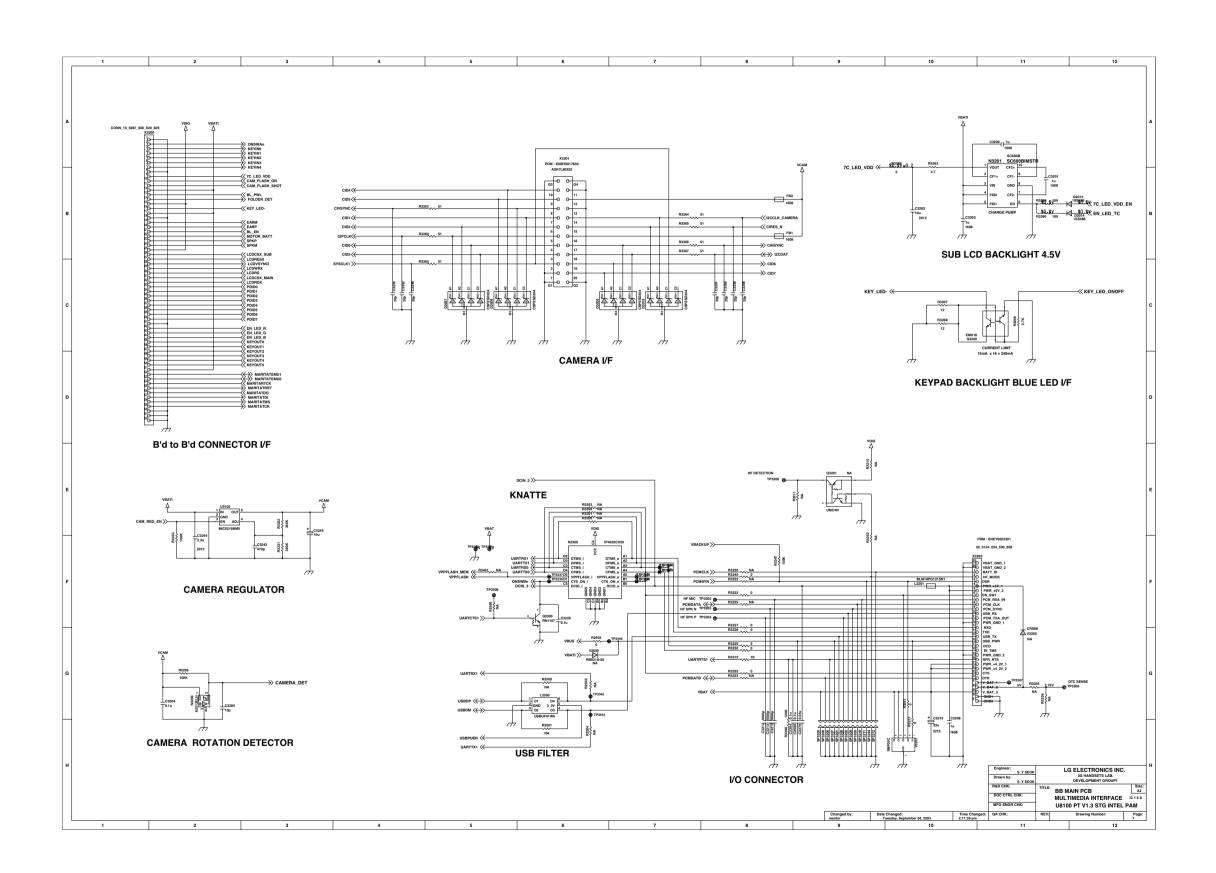


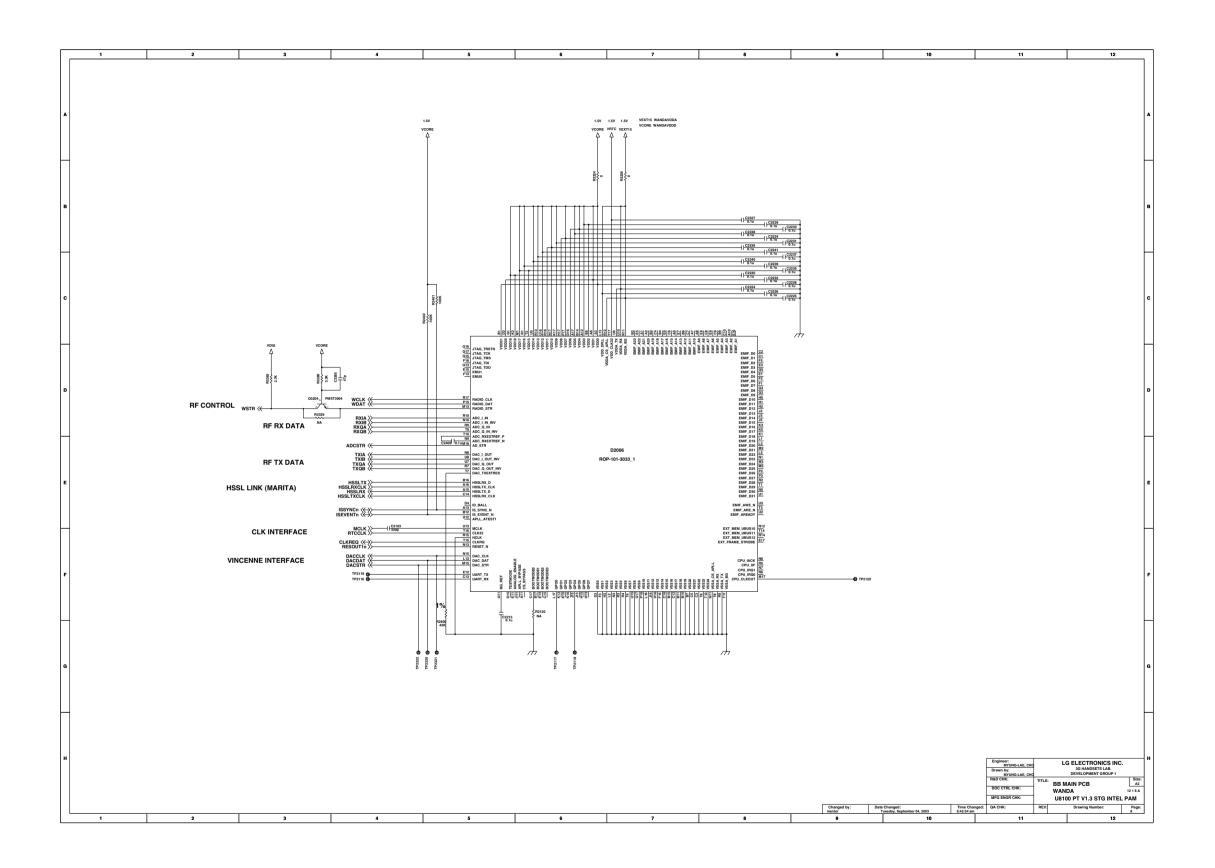


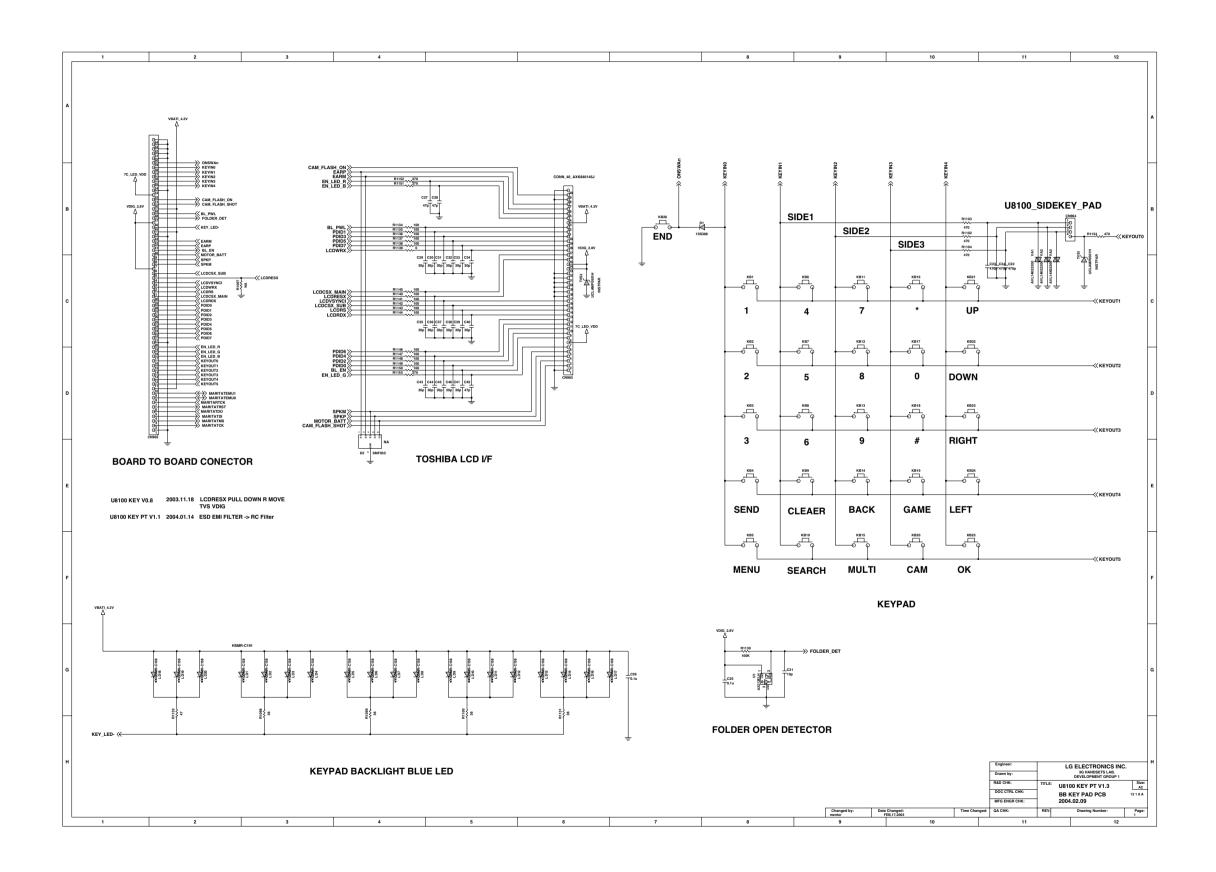


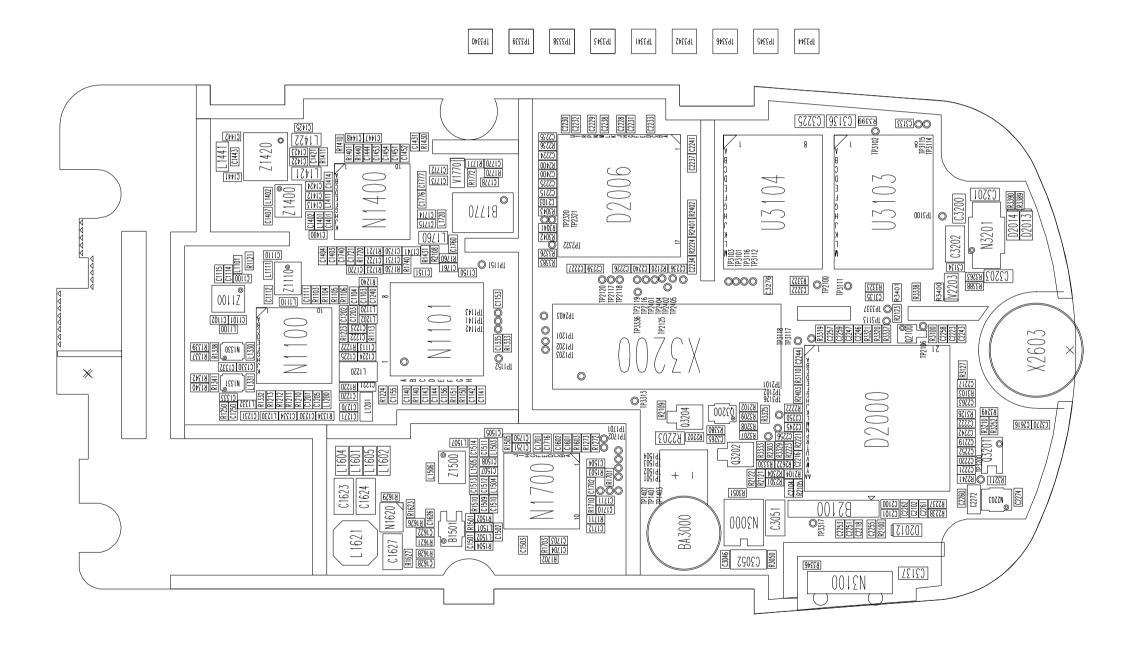




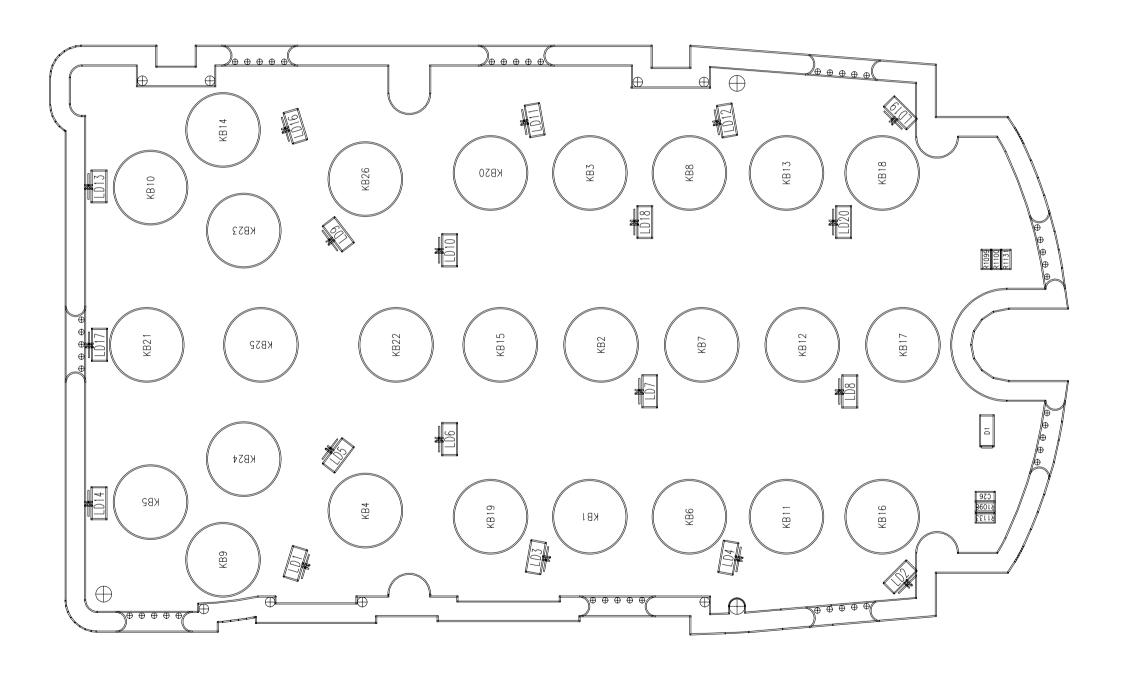


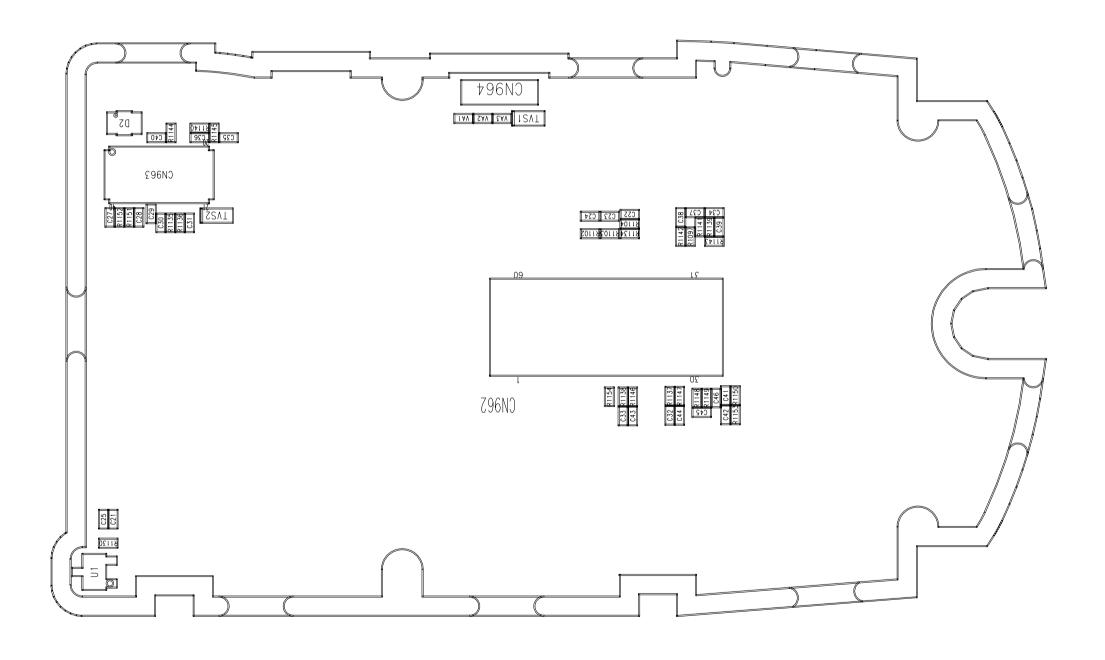






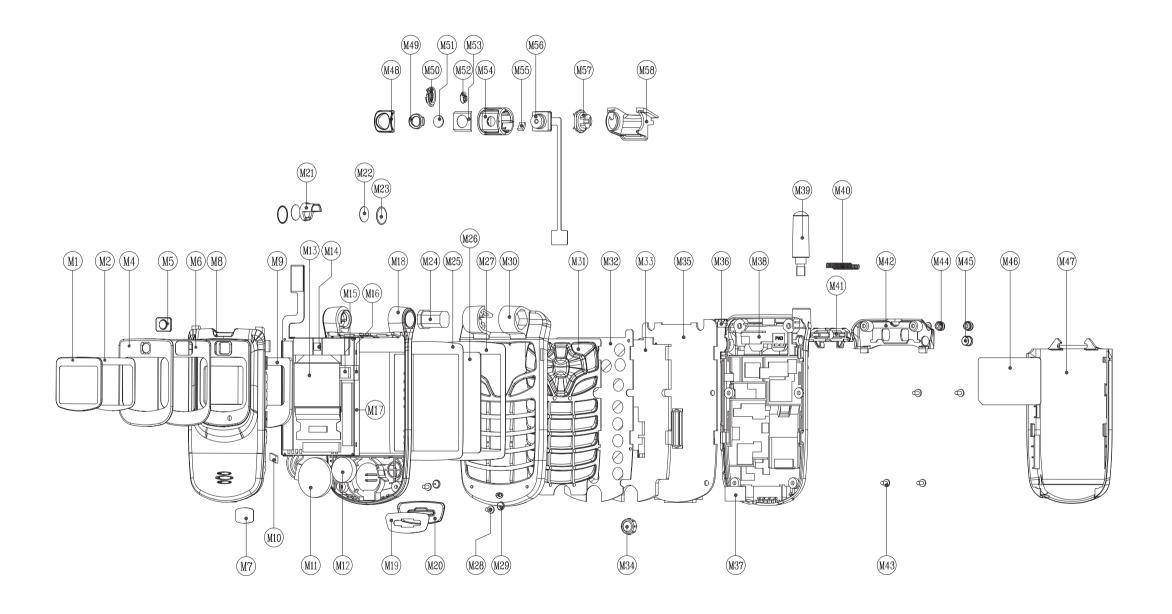






# 11. EXPLODED VIEW & REPLACEMENT PART LIST

# 11.1 EXPLODED VIEW



# 11.2 Replacement Parts <a href="Mechanic component">Mechanic component</a>>

**Note:** This Chapter is used for reference, Part order is ordered by SBOM standard on GCSC

| Level | Location<br>No. | Description                  | Part Number | Specification                                | Color             | Remark |
|-------|-----------------|------------------------------|-------------|--|-------------------|--------|
| 1     | -               | IMT,FOLDER                   | TIFF0002601 |  | Silver            |        |
| 2     | ACGA00          | COVER ASSY,BATTERY           | ACGA0007801 |  | Dark<br>Blue      | M47    |
| 3     | MCJA00          | COVER,BATTERY                | MCJA0004202 |  | Silver            |        |
| 3     | MTAB00          | TAPE,PROTECTION              | MTAB0046801 | Cover,Battery                                | Dark<br>Blue      |        |
| 2     | APEY00          | PHONE                        | APEY0164401 |  | Silver            |        |
| 3     | ABGA00          | BUTTON ASSY,DIAL             | ABGA0001501 |  | Silver            | M31    |
| 3     | ACGG00          | COVER ASSY,FOLDER            | ACGG0049201 |  | Silver            |        |
| 4     | ACGH00          | COVER ASSY,<br>FOLDER(LOWER) | ACGH0012002 |  | Silver            |        |
| 5     | MCCZ00          | CAP                          | MCCZ0005402 |  |                   | M21    |
| 5     | MCJH00          | COVER,FOLDER(LOWER)          | MCJH0009603 |  | Silver            | M18    |
| 5     | MDAC00          | DECO,SIDE                    | MDAC0006301 | 0.2t   | Silver            | M23    |
| 5     | MDAH00          | DECO,RECEIVER                | MDAH0007401 |  | Dark<br>Blue      | M20    |
| 5     | MGAD00          | GASKET,SHIELD FORM           | MGAD0035201 | 5.0x4.5x3.0 KW2000 FOLDER LOWER              | Gold              |        |
| 5     | MMAZ00          | MAGNET                       | MMAZ0000101 | D3*1.5t                                      |                   |        |
| 5     | MTAA            | TAPE,DECO                    | MTAA0023301 | DECO SIDE                                    |                   | M22    |
| 5     | MTAA00          | TAPE,DECO                    | MTAA0023101 | DECO RECEIVER OUTER                          |                   | M19    |
| 4     | ACGJ00          | COVER ASSY,<br>FOLDER(UPPER) | ACGJ0025901 |  | Silver            |        |
| 5     | MCJJ00          | COVER,FOLDER(UPPER)          | MCJJ0018801 |  | Silver            | M8     |
| 5     | MDAM00          | DECO,WINDOW(SUB)             | MDAM0004101 |  | Metalic<br>Silver | M4     |
| 5     | MFBC00          | FILTER,SPEAKER               | MFBC0004001 | FOLDER UPPER SPEAKER HOLE                    | Black             | M7     |
| 5     | MICA00          | INSERT,FRONT                 | MICA0001201 | LG-G510,511,512 common use, DIA = 1.7mm+2.3t |                   |        |
| 5     | MLAC00          | LABEL,BARCODE                | MLAC0003401 | EZ LOOKS(user for mechanical)                |                   |        |
| 5     | MPBG00          | PAD,LCD                      | MPBG0018201 | 2.2t   | Silver            | M10    |
| 5     | MPBQ00          | PAD,LCD(SUB)                 | MPBQ0011201 | SRS 40 1.7t                                  | Silver            | M9     |
| 5     | MTAA00          | TAPE,DECO                    | MTAA0035801 |  | Silver            | M6     |
| 5     | MTAE00          | TAPE,WINDOW(SUB)             | MTAE0011601 |  | Silver            | M2     |
| 5     | MWAD00          | WINDOW,LED                   | MWAD0002601 |  | Silver            | M5     |
| 4     | ACGK00          | COVER ASSY,FRONT             | ACGK0020902 |  | Silver            |        |
| 5     | MBJL00          | BUTTON,SIDE                  | MBJL0008102 |  |                   |        |
| 5     | MCJK00          | COVER,FRONT                  | MCJK0014602 |  | Silver            | M30    |

# 11. EXPLODED VIEW & REPLACEMENT PART LIST

| Level | Location<br>No. | Description          | Part Number | Specification   | Color             | Remark |
|-------|-----------------|----------------------|-------------|---|-------------------|--------|
| 5     | MICB00          | INSERT,FRONT(LOWER)  | MICB0000601 |   |                   |        |
| 5     | MWAG00          | WINDOW,IRDA          | MWAG0002301 |   | Brown             |        |
| 4     | ALAY00          | LCD ASSY             | ALAY0005301 |   |                   |        |
| 5     | AFBZ00          | FRAME ASSY           | AFBZ0004402 |   |                   | M17    |
| 6     | MFEZ00          | FRAME                | MFEZ0002302 |   |                   |        |
| 6     | MPBG00          | PAD,LCD              | MPBG0010602 | 0.3t  | Gray              |        |
| 6     | MPBS00          | PAD,FOLDER           | MPBS0002301 | 55.80*41.80 t0.3  | Silver            |        |
| 5     | MGAD0           | GASKET,SHIELD FORM   | MGAD0044101 | 0.2t_LCD  | Silver            | M16    |
| 5     | MGAD00          | GASKET,SHIELD FORM   | MGAD0035201 | 5.0x4.5x3.0 KW2000 FOLDER LOWER                                   | Gold              | M15    |
| 4     | GMZZ00          | SCREW MACHINE        | GMZZ0003201 | 3.5 mm,3.5 mm,MSWR3(FN) ,N ,STR ,- , M1.7X3.5 DIA3.5              | Silver            | M43    |
| 4     | MCCH00          | CAP,SCREW            | MCCH0012101 | FOLDER  | Gray              | M29    |
| 4     | MDAF00          | DECO,FOLDER(LOWER)   | MDAF0003203 |   | Metalic<br>Silver | M27    |
| 4     | MHFD00          | HINGE,FOLDER         | MHFD0006901 |   | Metalic<br>Silver | M24    |
| 4     | MTAA00          | TAPE,DECO            | MTAA0023401 | DECO FOLDER LOWER   |                   | M25    |
| 4     | MTAB            | TAPE,PROTECTION      | MTAB0020101 | KW2000,FOLDER LOWER   |                   |        |
| 4     | MTAB00          | TAPE,PROTECTION      | MTAB0036801 | KW2000, U8100, U8110, U8120                                       |                   |        |
| 4     | MWAC00          | WINDOW,LCD           | MWAC0025801 |   |                   | M26    |
| 4     | MWAF00          | WINDOW,LCD(SUB)      | MWAF0008801 |   | Metalic<br>Silver | M1     |
| 4     | SJMY00          | VIBRATOR,MOTOR       | SJMY0004201 | 3 V,0.12 A,12*3.4 ,G8000 VIBRATOR                                 |                   | M12    |
| 4     | SUVT00          | TWO-WAY MODE SPEAKER | SUVT0002701 | 8 ohm,32 ohm,90 dB,108 dB,19 mm,2-WAY MODE<br>SPEAKER for KW-2000 |                   | M11    |
| 4     | SVLM00          | LCD MODULE           | SVLM0005401 | , ,   |                   | M13    |
| 3     | ACGM00          | COVER ASSY,REAR      | ACGM0017802 |   | Silver            |        |
| 4     | ACFY00          | CONTACT ASSY,ANTENNA | ACFY0000501 | LG-G510,511,512 common use, MAIN REAR                             |                   | M36    |
| 4     | MCJN00          | COVER,REAR           | MCJN0011802 |   | Silver            | M38    |
| 4     | MDAK00          | DECO,REAR            | MDAK0001102 |   | Silver            | M42    |
| 4     | MGAD00          | GASKET,SHIELD FORM   | MGAD0044101 | 0.2t_LCD  | Silver            | M37    |
| 4     | MIDZ            | INSULATOR            | MIDZ0039401 |   | Dark<br>Blue      |        |
| 4     | MIDZ00          | INSULATOR            | MIDZ0036101 |   | Silver            |        |
| 4     | MLEA            | LOCKER,BATTERY       | MLEA0008901 | RIGHT   | Silver            | M41    |
| 4     | MLEA00          | LOCKER,BATTERY       | MLEA0008801 | LEFT  | Silver            | M41    |
| 4     | MPBT00          | PAD,CAMERA           | MPBT0004601 | 2.2t  | Silver            |        |
| 4     | MSDC00          | SPRING,LOCKER        | MSDC0003901 |   |                   | M40    |
| 3     | ACGN00          | COVER ASSY,CAMERA    | ACGN0001101 |   | Silver            |        |

# 11. EXPLODED VIEW & REPLACEMENT PART LIST

| Level | Location<br>No. | Description                  | Part Number | Specification  | Color             | Remark |
|-------|-----------------|------------------------------|-------------|--|-------------------|--------|
| 4     | ACGP00          | COVER ASSY,<br>CAMERA(FRONT) | ACGP0000301 |  | Silver            |        |
| 5     | MCJP00          | COVER,CAMERA(FRONT)          | MCJP0000901 |  | Silver            | M54    |
| 5     | MMAZ00          | MAGNET                       | MMAZ0000301 | 2500 Gauss (+-500)                                   | Metalic<br>Silver | M55    |
| 5     | MTAA00          | TAPE,DECO                    | MTAA0035901 |  | Silver            | M53    |
| 4     | MBIC00          | BUSHING,CAMERA(LEFT)         | MBIC0000201 |  | White             | M50    |
| 4     | MBIZ00          | BUSHING                      | MBIZ0001301 |  | Silver            | M58    |
| 4     | MCCK00          | CAP,CAMERA                   | MCCK0000301 |  |                   | M57    |
| 4     | MDAD00          | DECO,CAMERA                  | MDAD0002501 |  | Black             | M49    |
| 4     | MDAD01          | DECO,CAMERA                  | MDAD0002601 | Cr   | Metalic<br>Silver | M48    |
| 4     | MSDZ00          | SPRING                       | MSDZ0000801 | 0.15t  | Gold              | M52    |
| 4     | MWAE00          | WINDOW,CAMERA                | MWAE0000301 | 0.5t   |                   | M51    |
| 4     | SMZY00          | MODULE,ETC                   | SMZY0006501 | VGA CMOS CAMERA MODULE                               |                   | M56    |
| 3     | GMZZ00          | SCREW MACHINE                | GMZZ0003201 | 3.5 mm,3.5 mm,MSWR3(FN) ,N ,STR ,- , M1.7X3.5 DIA3.5 | Silver            | M28    |
| 3     | MCCC00          | CAP,EARPHONE JACK            | MCCC0007801 |  | Silver            |        |
| 3     | MCCF00          | CAP,MOBILE SWITCH            | MCCF0008501 |  | Silver            | M45    |
| 3     | MCCH00          | CAP,SCREW                    | MCCH0012201 | REAR   | Silver            | M44    |
| 3     | MFEA00          | FRAME,SHIELD                 | MFEA0003501 |  |                   | M33    |
| 3     | MLAK00          | LABEL,MODEL                  | MLAK0007203 |  | Silver            | M46    |
| 3     | MTAB00          | TAPE,PROTECTION              | MTAB0048001 |  | Dark<br>Blue      |        |

# 11.2 Replacement Parts <a href="Main component">Main component</a>>

**Note:** This Chapter is used for reference, Part order is ordered by SBOM standard on GCSC

| Level | Location<br>No. | Description          | Part Number | Specification                                  | Color | Remark |
|-------|-----------------|----------------------|-------------|--|-------|--------|
| 5     | SACY00          | PCB ASSY,FLEXIBLE    | SACY0016001 |  |       | M14    |
| 6     | EDLM00          | DIODE,LED,MODULE     | EDLM0004301 | WHITE ,3 LED,3.5*3.5*1.0 ,R/TP ,MINI FLASH LED |       |        |
| 6     | R1              | RES,CHIP             | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP                       |       |        |
| 6     | R2              | RES,CHIP             | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP                       |       |        |
| 6     | R3              | RES,CHIP             | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP                       |       |        |
| 6     | SPCY00          | PCB,FLEXIBLE         | SPCY0026701 | POLYI , mm,DOUBLE ,                            |       |        |
| 3     | SAEY00          | PCB ASSY,KEYPAD      | SAEY0025801 |  |       |        |
| 4     | ADCA00          | DOME ASSY,METAL      | ADCA0010901 |  |       |        |
| 4     | SAEA00          | PCB ASSY,KEYPAD,AUTO | SAEA0010301 |  |       |        |
| 5     | C21             | CAP,CERAMIC,CHIP     | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP                   |       |        |
| 5     | C22             | CAP,CERAMIC,CHIP     | ECCH0000139 | 470 pF,50V,K,X7R,HD,1005,R/TP                  |       |        |
| 5     | C23             | CAP,CERAMIC,CHIP     | ECCH0000139 | 470 pF,50V,K,X7R,HD,1005,R/TP                  |       |        |
| 5     | C24             | CAP,CERAMIC,CHIP     | ECCH0000139 | 470 pF,50V,K,X7R,HD,1005,R/TP                  |       |        |
| 5     | C25             | CAP,CERAMIC,CHIP     | ECCH0000182 | 0.1 uF,10V ,K ,X5R ,HD ,1005 ,R/TP             |       |        |
| 5     | C26             | CAP,CERAMIC,CHIP     | ECCH0000182 | 0.1 uF,10V ,K ,X5R ,HD ,1005 ,R/TP             |       |        |
| 5     | C27             | CAP,CERAMIC,CHIP     | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C28             | CAP,CERAMIC,CHIP     | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C29             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C30             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C31             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C32             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C33             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C34             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C35             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C36             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C37             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C38             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C39             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C40             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C41             | RES,CHIP             | ERHY0000160 | 180K ohm,1/16W,F,1005,R/TP                     |       |        |
| 5     | C42             | CAP,CERAMIC,CHIP     | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C43             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |
| 5     | C44             | CAP,CERAMIC,CHIP     | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP                   |       |        |

# 11. EXPLODED VIEW & REPLACEMENT PART LIST

| Level | Location<br>No. | Description                 | Part Number | Specification  | Color | Remark |
|-------|-----------------|-----------------------------|-------------|--|-------|--------|
| 5     | C45             | CAP,CERAMIC,CHIP            | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP   |       |        |
| 5     | C46             | CAP,CERAMIC,CHIP            | ECCH0000118 | 30 pF,50V,J,NP0,TC,1005,R/TP   |       |        |
| 5     | CN962           | CONNECTOR,BOARD TO<br>BOARD | ENBY0004302 | 60 PIN,0.5 mm,STRAIGHT ,Au ,B to B CNT(Socket)                         |       |        |
| 5     | CN963           | CONNECTOR,BOARD TO<br>BOARD | ENBY0013004 | 40 PIN,0.4 mm,ETC ,Au over Ni ,  |       |        |
| 5     | D1              | DIODE,SWITCHING             | EDSY0010401 | 1-1G1A ,40 V,300 A,R/TP ,Silicon Epitaxial Schottky Barrier Type Diode |       |        |
| 5     | LD1             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD10            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD11            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD12            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD13            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD14            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD16            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD17            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD18            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD19            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD2             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD20            | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD3             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD4             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD5             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD6             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD7             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD8             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | LD9             | DIODE,LED,CHIP              | EDLH0004502 | BLUE ,1608 ,R/TP ,0.35T  |       |        |
| 5     | R1098           | RES,CHIP                    | ERHY0006603 | 36 ohm,1/16W ,J ,1005 ,R/TP  |       |        |
| 5     | R1099           | RES,CHIP                    | ERHY0006603 | 36 ohm,1/16W ,J ,1005 ,R/TP  |       |        |
| 5     | R1100           | RES,CHIP                    | ERHY0006603 | 36 ohm,1/16W ,J ,1005 ,R/TP  |       |        |
| 5     | R1102           | RES,CHIP                    | ERHY0000233 | 470 ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R1103           | RES,CHIP                    | ERHY0000233 | 470 ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R1104           | RES,CHIP                    | ERHY0000233 | 470 ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R1130           | RES,CHIP                    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1131           | RES,CHIP                    | ERHY0006603 | 36 ohm,1/16W ,J ,1005 ,R/TP  |       |        |
| 5     | R1133           | RES,CHIP                    | ERHY0000213 | 47 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1134           | RES,CHIP                    | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R1135           | RES,CHIP                    | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP  |       |        |

| Level | Location<br>No. | Description        | Part Number | Specification  | Color | Remark |
|-------|-----------------|--------------------|-------------|--|-------|--------|
| 5     | R1136           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1137           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1138           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1139           | RES,CHIP           | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP                                    |       |        |
| 5     | R1140           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1141           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1142           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1143           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1144           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1145           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1146           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1147           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1148           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1149           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1150           | RES,CHIP           | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1151           | RES,CHIP           | ERHY0000228 | 270 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1152           | RES,CHIP           | ERHY0000228 | 270 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1153           | RES,CHIP           | ERHY0000228 | 270 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | R1154           | RES,CHIP           | ERHY0000233 | 470 ohm,1/16W,J,1005,R/TP                                  |       |        |
| 5     | SPEY00          | PCB,KEYPAD         | SPEY0019204 | FR-4 ,.4 mm,DOUBLE ,                                       |       |        |
| 5     | TVS1            | DIODE,TVS          | EDTY0007301 | SOD-523 ,5 V,240 W,R/TP ,SINGLE LINE TVS DIODE FOR ESD     |       |        |
| 5     | TVS2            | DIODE,TVS          | EDTY0007301 | SOD-523 ,5 V,240 W,R/TP ,SINGLE LINE TVS DIODE FOR ESD     |       |        |
| 5     | U1              | IC                 | EUSY0129501 | SC-74A ,3 PIN,R/TP ,HALL-EFFECT SWITCH                     |       |        |
| 5     | VA1             | VARISTOR           | SEVY0000702 | 14 V,10% ,SMD ,  |       |        |
| 5     | VA2             | VARISTOR           | SEVY0000702 | 14 V,10% ,SMD ,  |       |        |
| 5     | VA3             | VARISTOR           | SEVY0000702 | 14 V,10% ,SMD ,  |       |        |
| 4     | SAKY00          | PCB ASSY,SIDEKEY   | SAKY0002602 |  |       |        |
| 3     | SAFY00          | PCB ASSY,MAIN      | SAFY0093501 |  |       |        |
| 4     | SAFA00          | PCB ASSY,MAIN,AUTO | SAFA0032901 |  |       |        |
| 5     | B1501           | IC                 | EUSY0170601 | SC70 ,5 PIN,R/TP ,TEMPERATURE SENSOR                       |       |        |
| 5     | B1770           | X-TAL              | EXXY0016801 | 13 MHz,19 PPM,10 pF,40 ohm,SMD ,5*3.20*0.7 ,               |       |        |
| 5     | B2100           | X-TAL              | EXXY0004602 | .032768 MHz,20 PPM,12.5 pF,65000 ohm,SMD<br>,6.9*1.4*1.3 , |       |        |
| 5     | C1000           | CAP,CERAMIC,CHIP   | ECCH0000195 | 3.9 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP                         |       |        |
| 5     | C1001           | CAP,CERAMIC,CHIP   | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP                               |       |        |
| 5     | C1002           | CAP,CERAMIC,CHIP   | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP                               |       |        |

| Level | Location<br>No. | Description      | Part Number | Specification                      | Color | Remark |
|-------|-----------------|------------------|-------------|------------------------------------|-------|--------|
| 5     | C1003           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1004           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1005           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1007           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1008           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1009           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1010           | CAP,CERAMIC,CHIP | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |
| 5     | C1011           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1012           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1013           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1100           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1101           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1102           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1103           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1104           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1110           | CAP,CERAMIC,CHIP | ECCH0000186 | 33 pF,50V ,J ,NP0 ,TC ,1005 ,R/TP  |       |        |
| 5     | C1111           | CAP,CERAMIC,CHIP | ECCH0000186 | 33 pF,50V ,J ,NP0 ,TC ,1005 ,R/TP  |       |        |
| 5     | C1112           | CAP,CERAMIC,CHIP | ECCH0000186 | 33 pF,50V ,J ,NP0 ,TC ,1005 ,R/TP  |       |        |
| 5     | C1113           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1114           | CAP,CERAMIC,CHIP | ECCH0000108 | 7 pF,50V,D,NP0,TC,1005,R/TP        |       |        |
| 5     | C1140           | CAP,CERAMIC,CHIP | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP      |       |        |
| 5     | C1141           | CAP,CERAMIC,CHIP | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP      |       |        |
| 5     | C1142           | CAP,CERAMIC,CHIP | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP      |       |        |
| 5     | C1143           | CAP,CERAMIC,CHIP | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP      |       |        |
| 5     | C1144           | CAP,CERAMIC,CHIP | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP      |       |        |
| 5     | C1150           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1156           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1201           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1202           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1203           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1205           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1221           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1222           | CAP,CERAMIC,CHIP | ECCH0000140 | 560 pF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1223           | CAP,CERAMIC,CHIP | ECCH0000137 | 330 pF,50V ,K ,X7R ,HD ,1005 ,R/TP |       |        |
| 5     | C1224           | CAP,CERAMIC,CHIP | ECCH0000144 | 1.2 nF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1225           | CAP,CERAMIC,CHIP | ECCH0000146 | 1.8 nF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1270           | CAP,CERAMIC,CHIP | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |

| Level | Location<br>No. | Description      | Part Number | Specification                      | Color | Remark |
|-------|-----------------|------------------|-------------|------------------------------------|-------|--------|
| 5     | C1271           | CAP,CERAMIC,CHIP | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |
| 5     | C1300           | CAP,CERAMIC,CHIP | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP      |       |        |
| 5     | C1311           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C1312           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1313           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1315           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C1320           | CAP,CERAMIC,CHIP | ECCH0000139 | 470 pF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1321           | CAP,CERAMIC,CHIP | ECCH0000139 | 470 pF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1322           | CAP,CERAMIC,CHIP | ECCH0000130 | 150 pF,50V,J,SL,TC,1005,R/TP       |       |        |
| 5     | C1323           | CAP,CERAMIC,CHIP | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP      |       |        |
| 5     | C1324           | CAP,CERAMIC,CHIP | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP      |       |        |
| 5     | C1325           | CAP,CERAMIC,CHIP | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP      |       |        |
| 5     | C1327           | CAP,CERAMIC,CHIP | ECCH0000186 | 33 pF,50V ,J ,NP0 ,TC ,1005 ,R/TP  |       |        |
| 5     | C1330           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1331           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1332           | CAP,CERAMIC,CHIP | ECCH0000186 | 33 pF,50V ,J ,NP0 ,TC ,1005 ,R/TP  |       |        |
| 5     | C1333           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1334           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1335           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1337           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1341           | CAP,CERAMIC,CHIP | ECCH0000186 | 33 pF,50V ,J ,NP0 ,TC ,1005 ,R/TP  |       |        |
| 5     | C1352           | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5     | C1401           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1402           | CAP,CERAMIC,CHIP | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |
| 5     | C1403           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1404           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1407           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1412           | CAP,CERAMIC,CHIP | ECCH0000701 | 1.2 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5     | C1413           | CAP,CERAMIC,CHIP | ECCH0000701 | 1.2 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5     | C1414           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1422           | CAP,CERAMIC,CHIP | ECCH0000117 | 27 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1423           | CAP,CERAMIC,CHIP | ECCH0000117 | 27 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1424           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1425           | CAP,CERAMIC,CHIP | ECCH0000147 | 2.2 nF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1431           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1441           | CAP,CERAMIC,CHIP | ECCH0000147 | 2.2 nF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1442           | CAP,CERAMIC,CHIP | ECCH0000147 | 2.2 nF,50V,K,X7R,HD,1005,R/TP      |       |        |

|   | No.   | Description      | Part Number | Specification                      | Color | Remark |
|---|-------|------------------|-------------|------------------------------------|-------|--------|
| 5 | C1443 | CAP,CERAMIC,CHIP | ECCH0000701 | 1.2 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5 | C1444 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1447 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1448 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1451 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1452 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1453 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1454 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1501 | CAP,CERAMIC,CHIP | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1502 | CAP,CERAMIC,CHIP | ECCH0000105 | 4 pF,50V,C,NP0,TC,1005,R/TP        |       |        |
| 5 | C1503 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1504 | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5 | C1505 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1507 | CAP,CERAMIC,CHIP | ECCH0000105 | 4 pF,50V,C,NP0,TC,1005,R/TP        |       |        |
| 5 | C1508 | CAP,CERAMIC,CHIP | ECCH0000901 | 2.2 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5 | C1509 | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5 | C1510 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1511 | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5 | C1512 | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5 | C1513 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1514 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1601 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1602 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1622 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1623 | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5 | C1624 | CAP,CERAMIC,CHIP | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP |       |        |
| 5 | C1626 | CAP,CERAMIC,CHIP | ECCH0000137 | 330 pF,50V ,K ,X7R ,HD ,1005 ,R/TP |       |        |
| 5 | C1627 | CAP,CERAMIC,CHIP | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP |       |        |
| 5 | C1628 | CAP,CERAMIC,CHIP | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |
| 5 | C1631 | CAP,CERAMIC,CHIP | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP       |       |        |
| 5 | C1632 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1701 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1702 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1703 | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5 | C1704 | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5 | C1710 | CAP,CERAMIC,CHIP | ECCH0000130 | 150 pF,50V,J,SL,TC,1005,R/TP       |       |        |
| 5 | C1711 | CAP,CERAMIC,CHIP | ECCH0000149 | 3.3 nF,50V,K,X7R,HD,1005,R/TP      |       |        |

| Level | Location<br>No. | Description      | Part Number | Specification                      | Color | Remark |
|-------|-----------------|------------------|-------------|------------------------------------|-------|--------|
| 5     | C1714           | CAP,CERAMIC,CHIP | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP      |       |        |
| 5     | C1715           | CAP,CERAMIC,CHIP | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP      |       |        |
| 5     | C1716           | CAP,CERAMIC,CHIP | ECCH0000181 | 4.7 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5     | C1720           | CAP,CERAMIC,CHIP | ECCH0000152 | 5.6 nF,25V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1721           | CAP,CERAMIC,CHIP | ECCH0000138 | 390 pF,50V,K,X7R,HD,1005,R/TP      |       |        |
| 5     | C1730           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1731           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1740           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1741           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1750           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1751           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1760           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1761           | CAP,CERAMIC,CHIP | ECCH0000127 | 82 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1770           | CAP,CERAMIC,CHIP | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1772           | CAP,CERAMIC,CHIP | ECCH0000137 | 330 pF,50V ,K ,X7R ,HD ,1005 ,R/TP |       |        |
| 5     | C1773           | CAP,CERAMIC,CHIP | ECCH0000181 | 4.7 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5     | C1776           | CAP,CERAMIC,CHIP | ECCH0000181 | 4.7 pF,50V ,C ,NP0 ,TC ,1005 ,R/TP |       |        |
| 5     | C1777           | CAP,CERAMIC,CHIP | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1778           | CAP,CERAMIC,CHIP | ECCH0000124 | 56 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C1802           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C1810           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C1811           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C1850           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C1851           | CAP,CERAMIC,CHIP | ECCH0000161 | 33 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C1852           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C2100           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C2101           | CAP,CERAMIC,CHIP | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C2102           | CAP,CERAMIC,CHIP | ECCH0000137 | 330 pF,50V ,K ,X7R ,HD ,1005 ,R/TP |       |        |
| 5     | C2103           | CAP,CERAMIC,CHIP | ECCH0000137 | 330 pF,50V ,K ,X7R ,HD ,1005 ,R/TP |       |        |
| 5     | C2104           | CAP,CERAMIC,CHIP | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |
| 5     | C2200           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C2202           | CAP,CERAMIC,CHIP | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP |       |        |
| 5     | C2203           | CAP,CERAMIC,CHIP | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |
| 5     | C2205           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C2206           | CAP,CERAMIC,CHIP | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP |       |        |
| 5     | C2207           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2208           | CAP,CERAMIC,CHIP | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |

| Level | Location<br>No. | Description      | Part Number | Specification                 | Color | Remark |
|-------|-----------------|------------------|-------------|-------------------------------|-------|--------|
| 5     | C2209           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2210           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2211           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2212           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2213           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2214           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2215           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2216           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2217           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2218           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2219           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2220           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2221           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2222           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2223           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2224           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2225           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2226           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2227           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2228           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2229           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2230           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2231           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2232           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2233           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2234           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2235           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2236           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2237           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2238           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2239           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2240           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2241           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2242           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2243           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2244           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |
| 5     | C2245           | CAP,CERAMIC,CHIP | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP |       |        |

| Level | Location<br>No. | Description           | Part Number | Specification                      | Color | Remark |
|-------|-----------------|-----------------------|-------------|------------------------------------|-------|--------|
| 5     | C2246           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2247           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2250           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2251           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2252           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2253           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2255           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2256           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2257           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2258           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2259           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2260           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2261           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2262           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2263           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2272           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |
| 5     | C2274           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2276           | CAP,CERAMIC,CHIP      | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP      |       |        |
| 5     | C2277           | CAP,CERAMIC,CHIP      | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP |       |        |
| 5     | C2278           | CAP,CERAMIC,CHIP      | ECCH0000380 | 2.2 uF,16V ,Z ,Y5V ,HD ,2012 ,R/TP |       |        |
| 5     | C2279           | CAP,CERAMIC,CHIP      | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C2281           | CAP,CERAMIC,CHIP      | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP |       |        |
| 5     | C2301           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |
| 5     | C2302           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |
| 5     | C2303           | CAP,CERAMIC,CHIP      | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP        |       |        |
| 5     | C2304           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2312           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C2400           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2500           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2603           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |
| 5     | C2604           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2605           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP      |       |        |
| 5     | C2606           | CAP,CERAMIC,CHIP      | ECCH0000275 | 0.33 uF,16V,Z,Y5V,HD,1608,R/TP     |       |        |
| 5     | C2608           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP        |       |        |
| 5     | C2609           | CAP,CERAMIC,CHIP      | ECCH0000155 | 10 nF,16V,K,X7R,HD,1005,R/TP       |       |        |
| 5     | C2610           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C2611           | CAP,TANTAL,CHIP,MAKER | ECTZ0002802 | 100 uF,6.3V ,M ,L_ESR ,ETC ,R/TP   |       |        |

| Level | Location<br>No. | Description           | Part Number | Specification                       | Color | Remark |
|-------|-----------------|-----------------------|-------------|-------------------------------------|-------|--------|
| 5     | C2612           | CAP,CERAMIC,CHIP      | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP       |       |        |
| 5     | C2613           | CAP,CERAMIC,CHIP      | ECCH0000161 | 33 nF,16V,K,X7R,HD,1005,R/TP        |       |        |
| 5     | C2614           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C2615           | CAP,CERAMIC,CHIP      | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP       |       |        |
| 5     | C2616           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C2617           | CAP,CERAMIC,CHIP      | ECCH0000165 | 68 nF,6.3V,K,X5R,HD,1005,R/TP       |       |        |
| 5     | C2618           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C2619           | CAP,TANTAL,CHIP,MAKER | ECTZ0002802 | 100 uF,6.3V ,M ,L_ESR ,ETC ,R/TP    |       |        |
| 5     | C2621           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C2630           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C2631           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C2632           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C2633           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C3013           | CAP,CERAMIC,CHIP      | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP  |       |        |
| 5     | C3046           | CAP,CERAMIC,CHIP      | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP       |       |        |
| 5     | C3051           | CAP,CERAMIC,CHIP      | ECCH0000380 | 2.2 uF,16V ,Z ,Y5V ,HD ,2012 ,R/TP  |       |        |
| 5     | C3052           | CAP,CERAMIC,CHIP      | ECCH0003803 | 4.7 uF,10V ,Z ,Y5V ,HD ,2012 ,R/TP  |       |        |
| 5     | C3133           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C3134           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C3135           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C3136           | CAP,CERAMIC,CHIP      | ECCH0000274 | 0.22 uF,16V,Z,Y5V,HD,1608,R/TP      |       |        |
| 5     | C3137           | CAP,CERAMIC,CHIP      | ECCH0000279 | 0.47 uF,10V ,Z ,Y5V ,HD ,1608 ,R/TP |       |        |
| 5     | C3200           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP         |       |        |
| 5     | C3201           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP         |       |        |
| 5     | C3202           | CAP,CERAMIC,CHIP      | ECCH0006501 | 10 uF,6.3V ,K ,X5R ,TC ,2012 ,R/TP  |       |        |
| 5     | C3203           | CAP,CERAMIC,CHIP      | ECCH0000276 | 1 uF,10V,Z,Y5V,HD,1608,R/TP         |       |        |
| 5     | C3204           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C3205           | CAP,CERAMIC,CHIP      | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP        |       |        |
| 5     | C3212           | CAP,CERAMIC,CHIP      | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP         |       |        |
| 5     | C3213           | CAP,CERAMIC,CHIP      | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP         |       |        |
| 5     | C3215           | CAP,TANTAL,CHIP,MAKER | ECTZ0000318 | 33 uF,10V ,M ,STD ,3216 ,R/TP       |       |        |
| 5     | C3219           | CAP,CERAMIC,CHIP      | ECCH0000143 | 1 nF,50V,K,X7R,HD,1005,R/TP         |       |        |
| 5     | C3220           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C3221           | CAP,CERAMIC,CHIP      | ECCH0000115 | 22 pF,50V,J,NP0,TC,1005,R/TP        |       |        |
| 5     | C3222           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP       |       |        |
| 5     | C3225           | CAP,CERAMIC,CHIP      | ECCH0000274 | 0.22 uF,16V,Z,Y5V,HD,1608,R/TP      |       |        |
| 5     | C3243           | CAP,CERAMIC,CHIP      | ECCH0000139 | 470 pF,50V,K,X7R,HD,1005,R/TP       |       |        |

| Level | Location<br>No. | Description           | Part Number | Specification   | Color | Remark |
|-------|-----------------|-----------------------|-------------|---|-------|--------|
| 5     | C3244           | CAP,CERAMIC,CHIP      | ECCH0000380 | 2.2 uF,16V ,Z ,Y5V ,HD ,2012 ,R/TP  |       |        |
| 5     | C3245           | CAP,TANTAL,CHIP,MAKER | ECTZ0002601 | 10 uF,10V ,M ,STD ,2125 ,R/TP   |       |        |
| 5     | C3246           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP   |       |        |
| 5     | C3247           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP   |       |        |
| 5     | C3248           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP   |       |        |
| 5     | C3249           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3252           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3255           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3258           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3259           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3260           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3261           | CAP,CERAMIC,CHIP      | ECCH0000114 | 20 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3265           | CAP,CERAMIC,CHIP      | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3266           | CAP,CERAMIC,CHIP      | ECCH0000110 | 10 pF,50V,D,NP0,TC,1005,R/TP  |       |        |
| 5     | C3268           | CAP,CERAMIC,CHIP      | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3269           | CAP,CERAMIC,CHIP      | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3271           | CAP,CERAMIC,CHIP      | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3272           | CAP,CERAMIC,CHIP      | ECCH0000122 | 47 pF,50V,J,NP0,TC,1005,R/TP  |       |        |
| 5     | C3276           | CAP,CERAMIC,CHIP      | ECCH0000168 | 0.1 uF,16V,Z,Y5V,HD,1005,R/TP   |       |        |
| 5     | C3278           | CAP,CERAMIC,CHIP      | ECCH0000128 | 100 pF,50V,J,NP0,TC,1005,R/TP   |       |        |
| 5     | D2000           | IC                    | EUSY0135001 | u289 BGA ,289 PIN,R/TP ,ASIC / BASEBAND<br>CONTROLLER / MARITA            |       |        |
| 5     | D2006           | IC                    | EUSY0135201 | u181 BGA ,181 PIN,R/TP ,ASIC / WCDMA AIR<br>INTERFACE / WANDA             |       |        |
| 5     | D2007           | DIODE,TVS             | EDTY0006701 | CSP ,15 KV,200 mW,R/TP ,4 CHANNEL ESD ARRAY                               |       |        |
| 5     | D2008           | DIODE,TVS             | EDTY0006701 | CSP ,15 KV,200 mW,R/TP ,4 CHANNEL ESD ARRAY                               |       |        |
| 5     | D2009           | DIODE,TVS             | EDTY0006701 | CSP ,15 KV,200 mW,R/TP ,4 CHANNEL ESD ARRAY                               |       |        |
| 5     | D2010           | DIODE,SWITCHING       | EDSY0010401 | 1-1G1A ,40 V,300 A,R/TP ,Silicon Epitaxial Schottky<br>Barrier Type Diode |       |        |
| 5     | D2012           | DIODE,SWITCHING       | EDSY0010401 | 1-1G1A ,40 V,300 A,R/TP ,Silicon Epitaxial Schottky<br>Barrier Type Diode |       |        |
| 5     | D2013           | DIODE,SWITCHING       | EDSY0010401 | 1-1G1A ,40 V,300 A,R/TP ,Silicon Epitaxial Schottky<br>Barrier Type Diode |       |        |
| 5     | D2014           | DIODE,SWITCHING       | EDSY0010401 | 1-1G1A ,40 V,300 A,R/TP ,Silicon Epitaxial Schottky<br>Barrier Type Diode |       |        |
| 5     | D2015           | DIODE,SWITCHING       | EDSY0011901 | EMD2 ,30 V,1 A,R/TP ,VF=1.5V(IF=200mA) ,<br>IR=30uA(VR=10V)               |       |        |
| 5     | D2016           | DIODE,SWITCHING       | EDSY0011901 | EMD2 ,30 V,1 A,R/TP ,VF=1.5V(IF=200mA) ,<br>IR=30uA(VR=10V)               |       |        |
| 5     | D2018           | DIODE,TVS             | EDTY0006701 | CSP ,15 KV,200 mW,R/TP ,4 CHANNEL ESD ARRAY                               |       |        |
| 5     | FB1             | FILTER,BEAD,CHIP      | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA   |       |        |

| Level | Location<br>No. | Description        | Part Number | Specification                               | Color | Remark |
|-------|-----------------|--------------------|-------------|---|-------|--------|
| 5     | FB2             | FILTER,BEAD,CHIP   | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA             |       |        |
| 5     | FB3             | FILTER,BEAD,CHIP   | SFBH0008901 | 30 ohm,2012 ,3000mA, BEAD for LARGE CURRENT |       |        |
| 5     | FB4             | FILTER,BEAD,CHIP   | SFBH0008901 | 30 ohm,2012 ,3000mA, BEAD for LARGE CURRENT |       |        |
| 5     | L1001           | INDUCTOR,CHIP      | ELCH0001408 | 6.8 nH,S,1005,R/TP                          |       |        |
| 5     | L1002           | INDUCTOR,CHIP      | ELCH0001408 | 6.8 nH,S,1005,R/TP                          |       |        |
| 5     | L1100           | INDUCTOR,CHIP      | ELCH0001420 | 3.9 nH,S ,1005 ,R/TP ,                      |       |        |
| 5     | L1101           | INDUCTOR,CHIP      | ELCH0001405 | 3.3 nH,S ,1005 ,R/TP ,                      |       |        |
| 5     | L1110           | INDUCTOR,CHIP      | ELCH0001402 | 18 nH,J,1005,R/TP                           |       |        |
| 5     | L1111           | INDUCTOR,CHIP      | ELCH0001001 | 10 nH,J,1005,R/TP                           |       |        |
| 5     | L1120           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1200           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1201           | INDUCTOR,CHIP      | ELCH0007404 | 5.6 uH,K ,1608 ,R/TP ,                      |       |        |
| 5     | L1202           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1220           | INDUCTOR,CHIP      | ELCH0007403 | 100 uH,K ,2012 ,R/TP ,                      |       |        |
| 5     | L1230           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1300           | FILTER,BEAD,CHIP   | SFBH0007802 | 600 ohm,3216 ,CHIP FERRITE BEAD             |       |        |
| 5     | L1320           | FILTER,BEAD,CHIP   | SFBH0008101 | 600 ohm,1005 ,                              |       |        |
| 5     | L1330           | INDUCTOR,CHIP      | ELCH0005006 | 33 nH,J ,1005 ,R/TP ,                       |       |        |
| 5     | L1331           | INDUCTOR,CHIP      | ELCH0001413 | 22 nH,J ,1005 ,R/TP ,                       |       |        |
| 5     | L1332           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1333           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1401           | INDUCTOR,CHIP      | ELCH0001427 | 2.2 nH,S ,1005 ,R/TP ,                      |       |        |
| 5     | L1411           | INDUCTOR,CHIP      | ELCH0001408 | 6.8 nH,S,1005,R/TP                          |       |        |
| 5     | L1421           | INDUCTOR,CHIP      | ELCH0000716 | 68 nH,J ,1608 ,R/TP ,                       |       |        |
| 5     | L1422           | INDUCTOR,CHIP      | ELCH0000716 | 68 nH,J ,1608 ,R/TP ,                       |       |        |
| 5     | L1441           | INDUCTOR,CHIP      | ELCH0001511 | 100 nH,J ,1608 ,R/TP ,                      |       |        |
| 5     | L1501           | INDUCTOR,CHIP      | ELCH0001401 | 15 nH,J,1005,R/TP                           |       |        |
| 5     | L1502           | INDUCTOR,CHIP      | ELCH0001401 | 15 nH,J,1005,R/TP                           |       |        |
| 5     | L1503           | INDUCTOR,CHIP      | ELCH0001407 | 5.6 nH,S ,1005 ,R/TP ,                      |       |        |
| 5     | L1504           | INDUCTOR,CHIP      | ELCH0001004 | 8.2 nH,J,1005,R/TP                          |       |        |
| 5     | L1505           | INDUCTOR,CHIP      | ELCH0001001 | 10 nH,J,1005,R/TP                           |       |        |
| 5     | L1507           | FILTER,BEAD,CHIP   | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA               |       |        |
| 5     | L1601           | FILTER,BEAD,CHIP   | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA             |       |        |
| 5     | L1602           | FILTER,BEAD,CHIP   | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA             |       |        |
| 5     | L1603           | FILTER,BEAD,CHIP   | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA             |       |        |
| 5     | L1621           | INDUCTOR,SMD,POWER | ELCP0005101 | 4.7 uH,M ,3.8*3.8*1.8 ,R/TP ,               |       |        |
| 5     | L1760           | INDUCTOR,CHIP      | ELCH0003811 | 1000 nH,K ,1608 ,R/TP ,COIL TYPE            |       |        |

| Level | Location<br>No. | Description          | Part Number | Specification  | Color | Remark |
|-------|-----------------|----------------------|-------------|--|-------|--------|
| 5     | L2200           | INDUCTOR,SMD,POWER   | ELCP0004701 | 22 uH,M ,5.2*5.2*1.5 ,R/TP ,   |       |        |
| 5     | L2201           | FILTER,BEAD,CHIP     | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA  |       |        |
| 5     | L2202           | FILTER,BEAD,CHIP     | SFBH0002302 | 120 ohm,1608 ,CHIP BEAD, 2000mA  |       |        |
| 5     | L2500           | IC                   | EUSY0163501 | SOT323-6L ,6 PIN,R/TP ,EMI FILTER & LINE<br>TERMINATION for USB                |       |        |
| 5     | L2603           | FILTER,BEAD,CHIP     | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA  |       |        |
| 5     | L2605           | FILTER,BEAD,CHIP     | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA  |       |        |
| 5     | L2606           | FILTER,BEAD,CHIP     | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA  |       |        |
| 5     | L2608           | FILTER,BEAD,CHIP     | SFBH0007103 | 75 ohm,1005 ,CHIP BEAD, 300mA  |       |        |
| 5     | MLAB00          | LABEL,A/S            | MLAB0000601 | HUMIDITY STICKER   |       |        |
| 5     | MLAC00          | LABEL,BARCODE        | MLAC0003301 | EZ LOOKS(use for PCB ASSY MAIN(hardware))                                      |       |        |
| 5     | N1000           | FILTER,SEPERATOR     | SFAY0003101 | 900 ,2100 ,1.0 dB,1.4 dB,40 dB,40 dB,ETC ,5.2*4.0*1.8<br>ANTENNA SWITCH MODULE |       |        |
| 5     | N1002           | DUPLEXER,IMT         | SDMY0000301 | 1950 MHz,2140 MHz,1.25 dB,2.0 dB,25 dB,15 dB,10*5.3*1.94 ,SMD ,                |       |        |
| 5     | N1100           | IC                   | EUSY0132801 | 56 ball ,56 PIN,R/TP ,RFIC   |       |        |
| 5     | N1101           | IC                   | EUSY0133101 | BGA64 ,64 PIN,R/TP ,U8000 RF IC  |       |        |
| 5     | N1300           | PAM                  | SMPY0007101 | dBm, %, mA, dBc, dB,6*6*1.25 ,SMD ,PAM for TRI-BAND(EGSM/GPRS)                 |       |        |
| 5     | N1330           | TRANSFORMER,MATCHING | STMY0018402 | 6 PIN,SMD ,GSM Tx Balun  |       |        |
| 5     | N1331           | TRANSFORMER,MATCHING | STMY0018401 | 6 PIN,SMD ,DCS TX BALUN  |       |        |
| 5     | N1400           | IC                   | EUSY0133001 | uBGA ,56 PIN,R/TP ,U8000 RF IC   |       |        |
| 5     | N1620           | IC                   | EUSY0136001 | 3 X 4 UCSP ,10 PIN,R/TP ,600 mA BUCK<br>REGULATORS / DYNAMIC OUTPUT VOLTAGE    |       |        |
| 5     | N1630           | PAM                  | SMPY0002801 | 26 dBm,40 %,83 A,-58 dBc,23.5 dB,8.0*6.0*1.4 , SMD                             |       |        |
| 5     | N1650           | ISOLATOR,IMT         | SQMY0000201 | 1950 MHz,4.0*4.0*1.9 ,SMD ,1920~1980MHz  |       |        |
| 5     | N1700           | IC                   | EUSY0132901 | 56 ,56 PIN,R/TP ,WCDMA TXIC Wivi   |       |        |
| 5     | N1850           | IC                   | EUSY0122502 | LLP-6 ,6 PIN,R/TP ,300mA CMOS LDO / 2.8V                                       |       |        |
| 5     | N2000           | IC                   | EUSY0132701 | u143 BGA ,143 PIN,R/TP ,ASIC / POWER<br>MANAGEMENT IC / VINCENNE               |       |        |
| 5     | N2203           | IC                   | EUSY0122402 | SC-82AB ,4 PIN,R/TP ,CMOS LDO 1.5V OUTPUT/ 2.0 X 2.1                           |       |        |
| 5     | N2204           | IC                   | EUSY0171302 | SOT-23 ,5 PIN,R/TP ,150mA 3.3V LDO   |       |        |
| 5     | N2300           | IC                   | EUSY0171401 | CSP ,20 PIN,R/TP ,7 CHANNEL ESD FILTER ARRAY,<br>KNATTE                        |       |        |
| 5     | N2601           | IC                   | EUSY0196101 | BUMP MICRO SMD ,9 PIN,R/TP ,1W AUDIO AMP                                       |       | _      |
| 5     | N2602           | IC                   | EUSY0171201 | CSP ,25 PIN,R/TP ,6 CHANNEL ESD FILTER, EMP<br>SOLUTION                        |       |        |
| 5     | N2603           | IC                   | EUSY0148801 | SOT23-6 ,6 PIN,R/TP ,SPST SWITCH / 2 OHM                                       |       |        |
| 5     | N3000           | IC                   | EUSY0171301 | SOT-23 ,5 PIN,R/TP ,150mA 2.8V LDO   |       |        |

| 5<br>5<br>5<br>5<br>5<br>5<br>5<br>5<br>5<br>5 | No.   | Description      | Part Number | Specification   | Color | Remark |
|--|-------|------------------|-------------|---|-------|--------|
| 5<br>5<br>5<br>5<br>5<br>5<br>5<br>5<br>5      | N3100 | IC               | EUSY0122301 | SURFACE MOUNT ,7 PIN,R/TP ,IRDA DATA 1.3 LOW<br>POWER TRANSCEIVER / 115.2kb/s |       |        |
| 5<br>5<br>5<br>5<br>5<br>5<br>5<br>5<br>5      | N3200 | IC               | EUSY0129501 | SC-74A ,3 PIN,R/TP ,HALL-EFFECT SWITCH  |       |        |
| 5 5 5 5 5 5 5 5 5 5 5 6 6 6 6 6 6 6 6 6        | N3201 | IC               | EUSY0088502 | MSOP-10 ,10 PIN,R/TP ,Charge Pump Regulator with 4.5V output                  |       |        |
| 5 5 5 5 5 5 5 5 5 5 5 6 6 6 6 6 6 6 6 6        | PT1   | THERMISTOR       | SETY0005701 | NTC ,47 Kohm,SMD ,F GRADE   |       |        |
| 5 5 5 5  | Q2100 | TR,BJT,NPN       | EQBN0013301 | 2-2H1A ,100 mW,R/TP ,VEBO=6V  |       |        |
| 5 5 5  | Q2200 | TR,FET,P-CHANNEL | EQFP0003601 | SOT-363 ,0.27 W,20 V,0.66 A,R/TP ,Dual(P-channel:PD=0.27W,VDS=-8V,ID=0.57     |       |        |
| 5 5  | Q2201 | TR,FET,P-CHANNEL | EQFP0004401 | 1206-8 chipFET ,2.5 W,-20 V,20 A,R/TP ,3.10*1.975*1.1(t)                      |       |        |
| 5  | Q2300 | TR,BJT,NPN       | EQBN0013301 | 2-2H1A ,100 mW,R/TP ,VEBO=6V  |       |        |
| 5  | Q3200 | TR,BJT,NPN       | EQBN0013701 | EMT6 ,150 mW,R/TP ,DUAL TRANSISTORS   |       |        |
|  | Q3202 | TR,BJT,NPN       | EQBN0014901 | SOT323 ,200 mW,R/TP ,NPN SWITCHING TR   |       |        |
| 5  | Q3203 | TR,BJT,PNP       | EQBP0002401 | EMT3 ,.201 W,R/TP ,   |       |        |
|  | Q3204 | TR,BJT,NPN       | EQBN0014901 | SOT323 ,200 mW,R/TP ,NPN SWITCHING TR   |       |        |
| 5  | R1003 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1004 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1005 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1006 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1007 | RES,CHIP         | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP  |       |        |
| 5  | R1103 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1104 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1105 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1106 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1113 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1140 | RES,CHIP         | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP  |       |        |
| 5  | R1150 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1151 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1210 | RES,CHIP         | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1211 | RES,CHIP         | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1212 | RES,CHIP         | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1213 | RES,CHIP         | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1220 | RES,CHIP         | ERHY0000235 | 560 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1222 | RES,CHIP         | ERHY0000222 | 120 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1223 | RES,CHIP         | ERHY0000231 | 390 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1224 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1240 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |
| 5  | R1250 | RES,CHIP         | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP   |       |        |

| Level | Location<br>No. | Description | Part Number | Specification                | Color | Remark |
|-------|-----------------|-------------|-------------|------------------------------|-------|--------|
| 5     | R1301           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1302           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1321           | RES,CHIP    | ERHY0000241 | 1K ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R1325           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1326           | RES,CHIP    | ERHY0008601 | 0.05 ohm,1/4W ,J ,2012 ,R/TP |       |        |
| 5     | R1327           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1329           | RES,CHIP    | ERHY0008203 | 3 Kohm,1/16W ,J ,1005 ,R/TP  |       |        |
| 5     | R1332           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1333           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1334           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1335           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1338           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1341           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1343           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1344           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1350           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1401           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1410           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1411           | RES,CHIP    | ERHY0000250 | 3.3K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1430           | RES,CHIP    | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R1431           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1440           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1501           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1502           | RES,CHIP    | ERHY0000111 | 680 ohm,1/16W,F,1005,R/TP    |       |        |
| 5     | R1503           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1504           | RES,CHIP    | ERHY0000111 | 680 ohm,1/16W,F,1005,R/TP    |       |        |
| 5     | R1510           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1603           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1605           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1617           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1621           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1623           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1626           | RES,CHIP    | ERHY0000138 | 33K ohm,1/16W,F,1005,R/TP    |       |        |
| 5     | R1627           | RES,CHIP    | ERHY0000271 | 39K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1628           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1629           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R1630           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |

| Level | Location<br>No. | Description | Part Number | Specification              | Color | Remark |
|-------|-----------------|-------------|-------------|----------------------------|-------|--------|
| 5     | R1631           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1632           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1701           | RES,CHIP    | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1702           | RES,CHIP    | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1703           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1710           | RES,CHIP    | ERHY0000254 | 4.7K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R1711           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1720           | RES,CHIP    | ERHY0000255 | 5.6K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R1721           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1723           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1730           | RES,CHIP    | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1740           | RES,CHIP    | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1760           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1770           | RES,CHIP    | ERHY0000241 | 1K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R1771           | RES,CHIP    | ERHY0000261 | 10K ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R1772           | RES,CHIP    | ERHY0000261 | 10K ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R1810           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1811           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1825           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1826           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1850           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1851           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R1997           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2100           | RES,CHIP    | ERHY0000213 | 47 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2101           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2102           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2104           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2105           | RES,CHIP    | ERHY0000283 | 130K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2106           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2108           | RES,CHIP    | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R2109           | RES,CHIP    | ERHY0000213 | 47 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2122           | RES,CHIP    | ERHY0000250 | 3.3K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2123           | RES,CHIP    | ERHY0000282 | 120K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2200           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2201           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2202           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2203           | RES,CHIP    | ERHY0000445 | 1K ohm,1/16W,J,1608,R/TP   |       |        |

| Level | Location<br>No. | Description | Part Number | Specification                | Color | Remark |
|-------|-----------------|-------------|-------------|------------------------------|-------|--------|
| 5     | R2205           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2208           | RES,CHIP    | ERHY0008701 | 0.22 ohm,1/4W ,J ,2012 ,R/TP |       |        |
| 5     | R2210           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2212           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2213           | RES,CHIP    | ERHY0008701 | 0.22 ohm,1/4W ,J ,2012 ,R/TP |       |        |
| 5     | R2214           | RES,CHIP    | ERHY0008602 | 0.1 ohm,1/4W ,J ,2012 ,R/TP  |       |        |
| 5     | R2215           | RES,CHIP    | ERHY0008601 | 0.05 ohm,1/4W ,J ,2012 ,R/TP |       |        |
| 5     | R2216           | RES,CHIP    | ERHY0008601 | 0.05 ohm,1/4W ,J ,2012 ,R/TP |       |        |
| 5     | R2217           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2218           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2220           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2221           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2222           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2223           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2224           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2232           | RES,CHIP    | ERHY0000261 | 10K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2233           | RES,CHIP    | ERHY0000274 | 51K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2235           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2236           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2237           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2238           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2241           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2303           | RES,CHIP    | ERHY0000254 | 4.7K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2304           | RES,CHIP    | ERHY0000250 | 3.3K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2305           | RES,CHIP    | ERHY0000263 | 15K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2306           | RES,CHIP    | ERHY0000213 | 47 ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R2312           | RES,CHIP    | ERHY0000261 | 10K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2313           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2314           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2319           | RES,CHIP    | ERHY0000241 | 1K ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R2400           | RES,CHIP    | ERHY0000143 | 43K ohm,1/16W,F,1005,R/TP    |       |        |
| 5     | R2401           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2402           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2502           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R2606           | RES,CHIP    | ERHY0000138 | 33K ohm,1/16W,F,1005,R/TP    |       |        |
| 5     | R2607           | RES,CHIP    | ERHY0000252 | 3.9K ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2608           | RES,CHIP    | ERHY0000252 | 3.9K ohm,1/16W,J,1005,R/TP   |       |        |

| Level | Location<br>No. | Description | Part Number | Specification              | Color | Remark |
|-------|-----------------|-------------|-------------|----------------------------|-------|--------|
| 5     | R2609           | RES,CHIP    | ERHY0000138 | 33K ohm,1/16W,F,1005,R/TP  |       |        |
| 5     | R2610           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R2613           | RES,CHIP    | ERHY0000203 | 10 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R2617           | RES,CHIP    | ERHY0000266 | 22K ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R2618           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2619           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2620           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2621           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R2622           | RES,CHIP    | ERHY0000233 | 470 ohm,1/16W,J,1005,R/TP  |       |        |
| 5     | R3002           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3019           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3026           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3031           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3041           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3042           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3043           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3045           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3046           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3047           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3049           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3050           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3051           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3103           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3110           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3126           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3127           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3206           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3207           | RES,CHIP    | ERHY0000204 | 12 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R3208           | RES,CHIP    | ERHY0000204 | 12 ohm,1/16W,J,1005,R/TP   |       |        |
| 5     | R3209           | RES,CHIP    | ERHY0000249 | 2.7K ohm,1/16W,J,1005,R/TP |       |        |
| 5     | R3223           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3227           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3228           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3229           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3230           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3232           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3237           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP    |       |        |

| Level | Location<br>No. | Description | Part Number | Specification                 | Color | Remark |
|-------|-----------------|-------------|-------------|-------------------------------|-------|--------|
| 5     | R3248           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP       |       |        |
| 5     | R3249           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP       |       |        |
| 5     | R3263           | RES,CHIP    | ERHY0000202 | 4.7 ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R3303           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3319           | RES,CHIP    | ERHY0000241 | 1K ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3322           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3323           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3325           | RES,CHIP    | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R3327           | RES,CHIP    | ERHY0000160 | 180K ohm,1/16W,F,1005,R/TP    |       |        |
| 5     | R3328           | RES,CHIP    | ERHY0008603 | 8.2 Kohm,1/16W ,F ,1005 ,R/TP |       |        |
| 5     | R3329           | RES,CHIP    | ERHY0000254 | 4.7K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3330           | RES,CHIP    | ERHY0000250 | 3.3K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3331           | RES,CHIP    | ERHY0000290 | 300K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3332           | RES,CHIP    | ERHY0000288 | 240K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3337           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3338           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3341           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP       |       |        |
| 5     | R3344           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3345           | RES,CHIP    | ERHY0000714 | 0.51 ohm,1/8W ,J ,2012 ,R/TP  |       |        |
| 5     | R3346           | RES,CHIP    | ERHY0000209 | 27 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3347           | RES,CHIP    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3357           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3360           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3363           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3364           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3365           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3366           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3367           | RES,CHIP    | ERHY0000214 | 51 ohm,1/16W,J,1005,R/TP      |       |        |
| 5     | R3376           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP       |       |        |
| 5     | R3378           | RES,CHIP    | ERHY0000250 | 3.3K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3379           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP       |       |        |
| 5     | R3380           | RES,CHIP    | ERHY0000250 | 3.3K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3381           | RES,CHIP    | ERHY0000261 | 10K ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R3382           | RES,CHIP    | ERHY0000202 | 4.7 ohm,1/16W,J,1005,R/TP     |       |        |
| 5     | R3383           | RES,CHIP    | ERHY0000249 | 2.7K ohm,1/16W,J,1005,R/TP    |       |        |
| 5     | R3388           | RES,CHIP    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP       |       |        |
| 5     | R3389           | RES,CHIP    | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP     |       |        |

| Level | Location<br>No. | Description                 | Part Number | Specification   | Color    | Remark |
|-------|-----------------|-----------------------------|-------------|---|----------|--------|
| 5     | R3390           | RES,CHIP                    | ERHY0000220 | 100 ohm,1/16W,J,1005,R/TP                                   |          |        |
| 5     | R3395           | RES,CHIP                    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP                                     |          |        |
| 5     | R3396           | RES,CHIP                    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP                                     |          |        |
| 5     | R3397           | RES,CHIP                    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP                                     |          |        |
| 5     | R3398           | RES,CHIP                    | ERHY0000280 | 100K ohm,1/16W,J,1005,R/TP                                  |          |        |
| 5     | R3399           | RES,CHIP                    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP                                     |          |        |
| 5     | R3400           | RES,CHIP                    | ERHY0000201 | 0 ohm,1/16W,J,1005,R/TP                                     |          |        |
| 5     | SPFY00          | PCB,MAIN                    | SPFY0069002 | FR-4 ,0.8 mm,STAGGERED-8,Ver1.2                             | TITANIUM |        |
| 5     | U3102           | IC                          | EUSY0045305 | SOT-23-5 ,5 PIN,R/TP ,ADj. V / 500 mA PEAK LDO REGULATOR    |          |        |
| 5     | U3103           | IC                          | EUSY0187001 | SCSP ,88 PIN,R/TP ,256M FLASH+64M PSRAM, TYAX               |          |        |
| 5     | U3104           | IC                          | EUSY0197901 | SCSP ,88 PIN,R/TP ,256M FLASH, BOTTOM BOOT                  |          |        |
| 5     | V1001           | TR,BJT,ARRAY                | EQBA0002501 | USV ,200 mW,R/TP ,NPN // PNP & R. BUILT-IN TR               |          |        |
| 5     | V1770           | DIODE,VARIABLE CAP          | EDVY0001801 | SCD80 ,0.09 pF,R/TP ,                                       |          |        |
| 5     | V2201           | DIODE,SWITCHING             | EDSY0011901 | EMD2 ,30 V,1 A,R/TP ,VF=1.5V(IF=200mA) ,<br>IR=30uA(VR=10V) |          |        |
| 5     | V2300           | DIODE,TVS                   | EDTY0007001 | SOT23-6 ,9 V, W,R/TP ,TVS DIODE ARRAY                       |          |        |
| 5     | V3201           | DIODE,TVS                   | EDTY0006401 | SC70-6L ,5 V,100 W,R/TP ,                                   |          |        |
| 5     | V3202           | DIODE,SWITCHING             | EDSY0011901 | EMD2 ,30 V,1 A,R/TP ,VF=1.5V(IF=200mA) ,<br>IR=30uA(VR=10V) |          |        |
| 5     | W1001           | CONN,RF SWITCH              | ENWY0003001 | STRAIGHT ,SMD ,0.6 dB,3.8X3.0X3.6T                          |          |        |
| 5     | X2300           | CONN,SOCKET                 | ENSY0009901 | 8 PIN,ETC ,SMD ,2.54 mm,2.2T UIM CONNECTOR WITH BRIDGE      |          |        |
| 5     | X2602           | CONN,JACK/PLUG,EARPHON<br>E | ENJE0003401 | , PIN,  |          |        |
| 5     | X3200           | CONNECTOR,BOARD TO<br>BOARD | ENBY0004202 | 60 PIN,0.5 mm,STRAIGHT ,Au ,B to B CNT(Header)              |          |        |
| 5     | X3201           | CONNECTOR,BOARD TO<br>BOARD | ENBY0017602 | 20 PIN,0.4 mm,STRAIGHT ,AU ,0.9t, SOCKET for CAMERA         |          |        |
| 5     | X3203           | CONN,RECEPTACLE             | ENEY0004101 | 24 PIN,3 , ,25.3*10*(3+1.5)T                                |          |        |
| 5     | Z1100           | FILTER,SAW                  | SFSY0012901 | 1842.5 MHz,2.0*2.5*0.8 ,SMD , DCS RX RF SAW                 |          |        |
| 5     | Z1110           | FILTER,SAW                  | SFSY0013001 | 942.5 MHz,2.0*2.5*0.8 ,SMD ,GSM RX RF SAW                   |          |        |
| 5     | Z1400           | FILTER,SAW                  | SFSY0014201 | 2140 MHz,2.5*2.0*0.8 ,SMD ,WCDMA Rx RF SAW                  |          |        |
| 5     | Z1420           | FILTER,SAW                  | SFSY0012501 | 190 MHz,3.8*3.8*1.2 ,SMD ,WCDMA RX IF SAW                   |          |        |
| 5     | Z1500           | FILTER,SAW                  | SFSY0014301 | 1900 MHz,2.5*2.0*1.0 ,SMD ,UMTS Tx RF SAW                   |          |        |
| 4     | SBEY00          | BATTERY,ETC                 | SBEY0002901 | 1.5 V,1.15 mAh,U8100 BACK-UP BATTERY 1.9T                   |          |        |
| 3     | SNMF00          | ANTENNA,MOBILE,FIXED        | SNMF0007401 | , dB,U8100 TRIPLE(GSM+DCS+WCDMA),EXTERNAL                   |          |        |
| 3     | SUMY00          | MICROPHONE                  | SUMY0005601 | ASSY ,-44 dB,6.0*1.8 ,U8100 MIC                             |          |        |

# 11.3 Accessory

**Note:** This Chapter is used for reference, Part order is ordered by SBOM standard on GCSC

| Level | Location<br>No. | Description            | Part Number | Specification  | Color | Remark |
|-------|-----------------|------------------------|-------------|--|-------|--------|
| 2     | MHBY00          | HANDSTRAP              | MHBY0001101 | Neck Strap 380mm   | Gray  |        |
| 2     | SBPL00          | BATTERY PACK,LI-ION    | SBPL0072201 | 3.7 V,1200 mAh,1 CELL,PRISMATIC ,U8150 STD<br>BATTERY PACK |       |        |
| 2     | SGDY00          | DATA CABLE             | SGDY0005601 | DK-40G ,K8000 24PIN I/O + USB A TYPE                       |       |        |
| 2     | SGEY00          | EAR PHONE/EAR MIKE SET | SGEY0003701 | U8110 ,Cresyn  |       |        |
| 2     | SSAD00          | ADAPTOR,AC-DC          | SSAD0007848 | FREE ,50 Hz,4.6 V,0.8 A,CE ,3G                             |       |        |
| 2     | WSAY00          | SOFTWARE,APPLICATION   | WSAY0002901 | Bundle CD S/W Ver1.0                                       |       |        |
| 2     | WSYY00          | SOFTWARE               | WSYY0185701 | V.100  |       |        |